

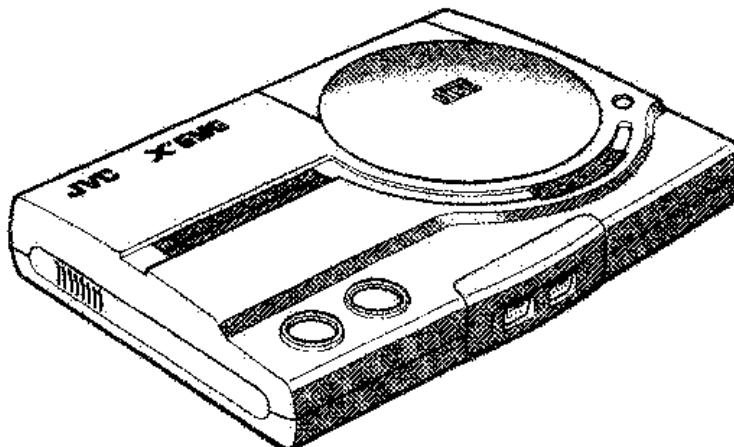
# JVC

## SERVICE MANUAL

MULTI ENTERTAINMENT SYSTEM

### RG-M10BU

Pick up	OPTIMA-6
CD signal processor	CXA1372Q



Area Suffix
J ..... the U.S.A.
C ..... Canada

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## Safety Precautions

1. The design of this product contains special hardware and many circuits and components specially for safety purposes. For continued protection, no changes should be made to the original design unless authorized in writing by the manufacturer. Replacement parts must be identical to those used in the original circuits. Services should be performed by qualified personnel only.
2. Alterations of the design or circuitry of the product should not be made. Any design alterations of the product should not be made. Any design alterations or additions will void the manufacturer's warranty and will further relieve the manufacturer of responsibility for personal injury or property damage resulting therefrom.
3. Many electrical and mechanical parts in the products have special safety-related characteristics. These characteristics are often not evident from visual inspection nor can the protection afforded by them necessarily be obtained by using replacement components rated for higher voltage, wattage, etc. Replacement parts which have these special safety characteristics are identified in the Parts List of Service Manual. Electrical components having such features are identified by shading on the schematics and by ( $\Delta$ ) on the Parts List in the Service Manual. The use of a substitute replacement which does not have the same safety characteristics as the recommended replacement parts shown in the Parts List of Service Manual may create shock, fire, or other hazards.
4. The leads in the products are routed and dressed with ties, clamps, tubings, barriers and the like to be separated from live parts, high temperature parts, moving parts and/or sharp edges for the prevention of electric shock and fire hazard. When service is required, the original lead routing and dress should be observed, and it should be confirmed that they have been returned to normal, after re-assembling.
5. Leakage current check (Electrical shock hazard testing)  
After re-assembling the product, always perform an isolation check on the exposed metal parts of the product (antenna terminals, knobs, metal cabinet, screw heads, headphone jack, control shafts, etc.) to be sure the product is safe to operate without danger of electrical shock.  
Do not use a line isolation transformer during this check.

- Plug the AC line cord directly into the AC outlet. Using a "Leakage Current Tester", measure the leakage current from each exposed metal parts of the cabinet, particularly any exposed metal part having a return path to the chassis, to a known good earth ground. Any leakage current must not exceed 0.5mA AC (r.m.s.).

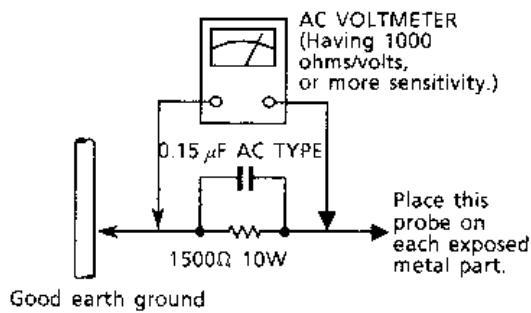
● Alternate check method

Plug the AC line cord directly into the AC outlet. Use an AC voltmeter having, 1,000 ohms per volt or more sensitivity in the following manner. Connect a  $1,500\Omega$  10 W resistor paralleled by a  $0.15 \mu\text{F}$  AC-type capacitor between an exposed metal part and a known good earth ground.

Measure the AC voltage across the resistor with the AC voltmeter.

Move the resistor connection to each exposed metal part, particularly any exposed metal part having a return path to the chassis, and measure the AC voltage across the resistor.

Now, reverse the plug in the AC outlet and repeat each measurement. Any voltage measured must not exceed 0.75 V AC (r.m.s.). This corresponds to 0.5 mA AC (r.m.s.).



## Warning

1. This equipment has been designed and manufactured to meet international safety standards.
2. It is the legal responsibility of the repairer to ensure that these safety standards are maintained.
3. Repairs must be made in accordance with the relevant safety standards.
4. It is essential that safety critical components are replaced by approved parts.
5. If mains voltage selector is provided, check setting for local voltage.

# Important for Laser Products

1. **DANGER** : Invisible laser radiation when open and interlock failed or defeated. Avoid direct exposure to beam.
2. **CAUTION** : There are no serviceable parts inside the Laser Unit. Do not disassemble the Laser Unit. Replace the complete Laser Unit if it malfunctions.
3. **CAUTION** : The compact disc player uses invisible laser radiation and is equipped with safety switches which prevent emission of radiation when the drawer is open and the safety interlocks have failed or are defeated. It is dangerous to defeat the safety switches.
4. **CAUTION** : If safety switches malfunction, the laser is able to function.
5. **CAUTION** : Use of controls, adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.
6. **CAUTION** : The compact disc player provides a laser diode of wavelength 780-790nm and optical output power typical 3mW at the laser diode.

**VARNING** : Osynlig laserstrålning när denna del är öppnad och spärren är urkopplad. Betrakta ej strålen.

**VARO** : Avattaessa ja suojalukitus ohitettaessa olet alttiina näkymättömälle lasersäteilylle. Älä katso sääteeseen.

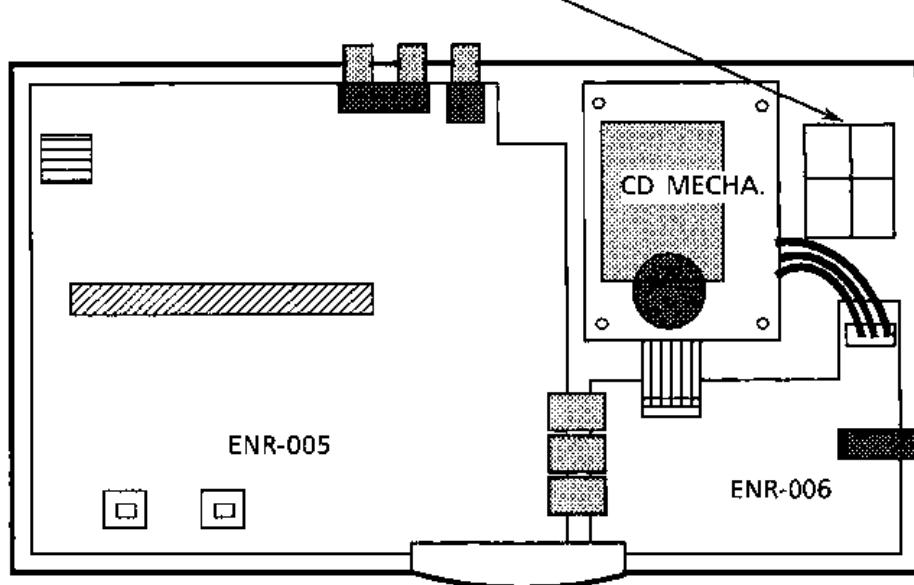
**ADVARSEL** : Usynlig laserstråling ved åbning, når sikkerhedsafbrydere er ude af funktion. Undgå utsættelse for stråling.

**ADVARSEL** : Usynlig laserstråling ved åpning, når sikkerhetsbryteren er avslott. unngå utsettelse for stråling.

## REPRODUCTION AND POSITION OF LABELS

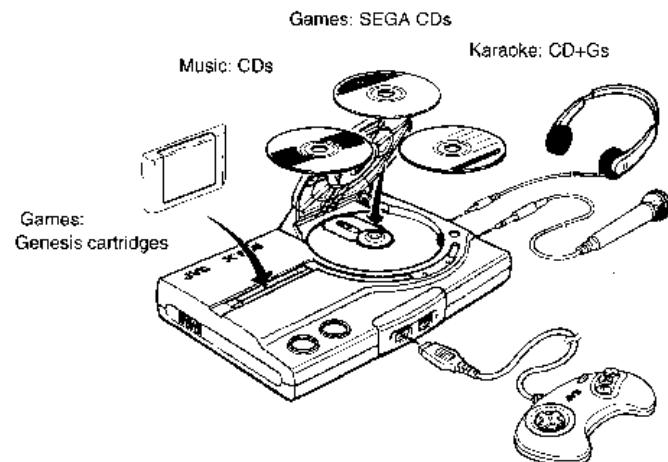
### WARNING LABEL (Only for the canada)

<b>DANGER:</b> invisible laser radiation when open and interlock failed or defeated. AVOID DIRECT EXPOSURE TO BEAM. (e)	<b>WARNING:</b> Osynlig laserstrålning när denna del är öppnad och spärren är urkopplad. Betrakta ej strålen. (s)
<b>ADVARSEL:</b> Usynlig laserstråling ved åbning, når sikkerhedsafbrydere er ude af funktion. Undgå utsættelse for stråling. (d)	<b>VARO:</b> Avattaessa ja suojalukitus ohitettaessa olet alttiina näkymättömälle lasersäteilylle. Älä katso sääteeseen. (f)



## Introduction

Since the JVC X'EYE features CD-ROM playing, it can be used to enjoy games on Sega CDs along with games on Genesis cartridges, music on audio CDs, and karaoke music on CD+Gs.



The JVC X'EYE is compatible with these disc types.\*



- SEGA CD Games (CD-ROM)
- Audio Music (CD)
- Audio + Graphics (CD+G)

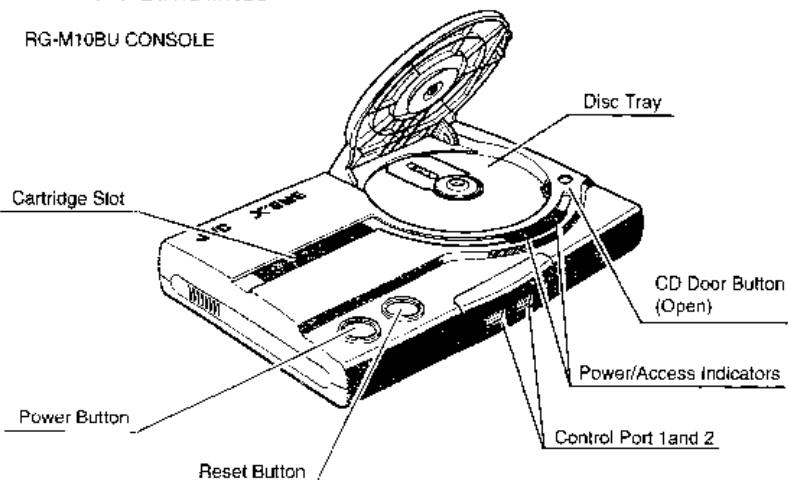
JVC X'EYE can be used to play games on  
SEGA CDs and GENESIS cartridges.

**SEGA CD GENESIS**

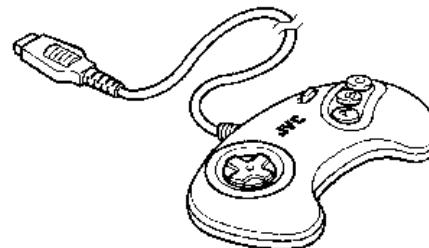
## Identifying Parts

JVC X'EYE SYSTEM RG-M10BU

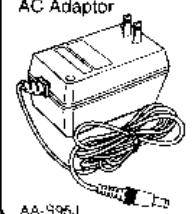
RG-M10BU CONSOLE



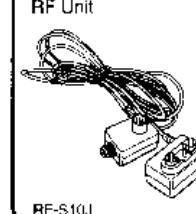
CONTROL PAD



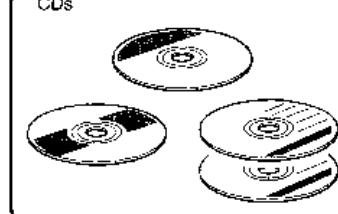
AC Adaptor



RF Unit



CDs

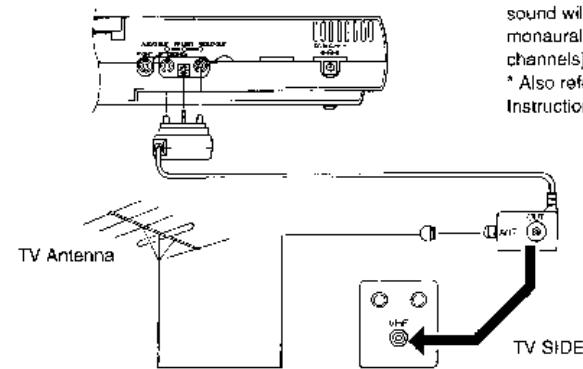


# Connecting

Select A or B according to whether your TV is equipped with an AV input terminal or not.  
Set the POWER switch of X'EYE to OFF before making any connections.

## A. Connections to TV and Antenna

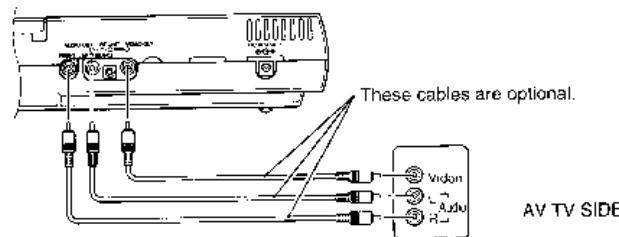
BACK VIEW OF CONSOLE



- \* When using the RF unit, the sound will be played back monaurally (mixture of L and R channels).
- \* Also refer to RF-unit's Instructions.

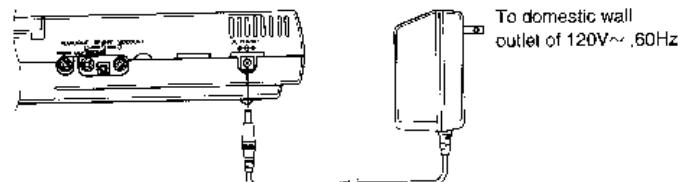
## B. Connections to AV TV

BACK VIEW OF CONSOLE



## Connections to Power

BACK VIEW OF CONSOLE

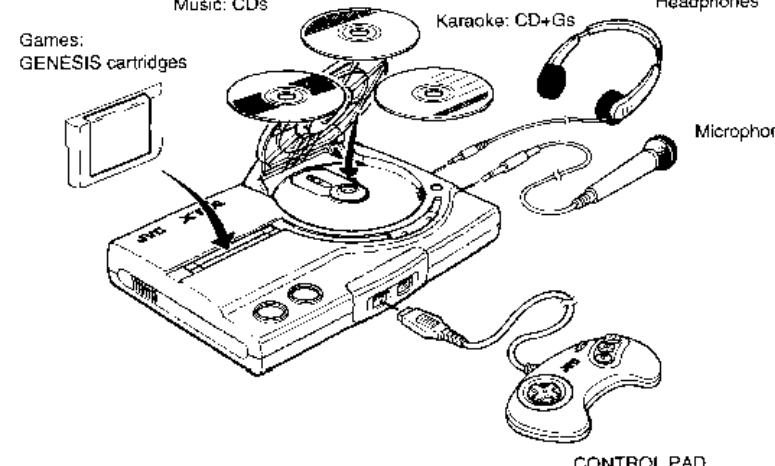


# Operating the System

Games: SEGA CDs

Music: CDs

Games:  
GENESIS cartridges



1. Connect the control pad to control port 1. Two people can play if an optional control pad is connected to control port 2.
  2. Turn ON the TV. (Adjust the TV's input selector, channel or tuning according to the connection method.)
  3. Insert the software you wish to use in the cartridge slot or disc tray.
  4. Turn the power of X'EYE to on. Be sure the power indicator light is on.
  5. If all connections have been properly made, the X'EYE logo and, in some cases, a demonstration of the game appears on the screen.
- \*Use of CD: X'EYE logo  
\*Use of cartridge: Game demonstration  
(When both a cartridge and a CD have been set, the software of the cartridge will operate with priority.)

### Note:

Be sure the power is off when inserting or removing cartridge.

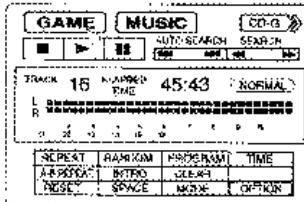
# Playing JVC X' EYE

## PLAYING SEGA CD GAMES (CD-ROMS)

When playing games on SEGA CDs for the first time, be sure to carry out FORMAT of the built-in backup memory before starting. (For more details, please see page 7.) If you do not format the built-in backup memory, you may not be able to save your data in some cases.

1. When inserting a SEGA CD disc, the "GAME" will be selected.
2. Press START on the control pad or press Button C to go to the game screen.

Please refer to the instruction manual of each game for instructions on operation after these two steps.



## ENDING A SESSION

1. Press the reset button on the JVC X' EYE console.  
\* However, please do not press the reset button when data is being saved.
2. The screen first displays the JVC X' EYE title screen before displaying the Control Panel.  
\* There may be slight differences depending on the game. Please refer to the instruction manual of each game for more details.
3. Remove the SEGA CD.

## BACKUP MEMORY

### SAVING YOUR GAMES

Some games allow you to save your current game data at the time you stop playing so you can continue playing later. The JVC X' EYE console has a internal circuit to save your data which is called "built-in backup memory."

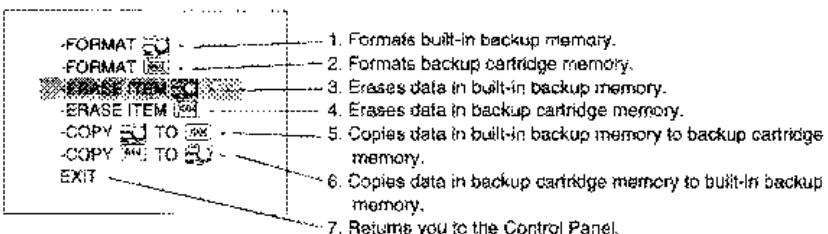
\* Since there is a limit to the data that can be saved, please delete unnecessary items.

- Note:
- Since saved data is erased if the JVC X' EYE is left off for a month or more, turn it on at least once a month even if you do not use it.
- If the data is erased, reformat the built-in backup memory and leave the power on for at least one hour.

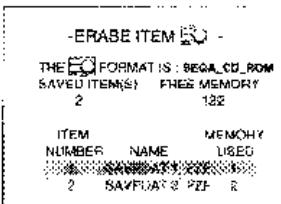
# Playing JVC X' EYE

## READING THE SCREENS

### 1. Menu Screen



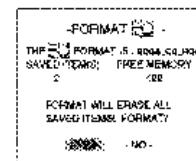
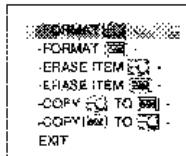
### 2. ERASE Screen



Saved Item(s): Number of items saved.  
Free Memory: Unused space in backup memory. Units are blocks.  
Item Number: Sequential item number.  
Name: The name that a data item is saved under in backup memory.  
It cannot be written by the player. An abbreviation of the game's name or other title is automatically used.  
Memory Used: Size of each item. Units are blocks.

## FORMATTING

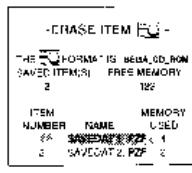
1. Select OPTION on the Control Panel and press Button C.  
\* If the number of saved items and free memory in internal memory is displayed on the DATA STORAGE INFORMATION Screen, it means that it was already formatted at the time of shipment. In that case, use as it is.
2. When "PLEASE FORMAT" appears, press Button C to go to the menu.
3. Select "internal backup format built-in backup memory" and press Button C to go to the FORMAT Screen.
4. Select "Yes" and press Button C. Formatting is carried out and you will return to the menu.  
\* If a "Cannot Format" message appears, it is possible that there is a breakdown or defect again in the JVC X' EYE. In such case, please consult the retail seller from whom you purchased it.



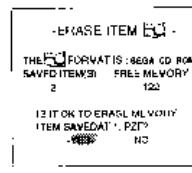
# Playing JVC X' EYE

## ERASING

- Select OPTION on the Control Panel. Press Button C to go to the DATA STORAGE INFORMATION Screen.
- Press Button C to go to the menu
- Select ERASE. Press Button C to go to the ERASE Screen. (Please see page 7 for instructions on reading the menu.)
- The saved items will appear on the screen. Select the item you want to erase and press Button C. You will then go to ERASE Screen 1 to 2. (Please see page 7 for instructions on reading ERASE Screen.)
- Select "Yes" and press Button C. Erasing is carried out and you will return to the menu.



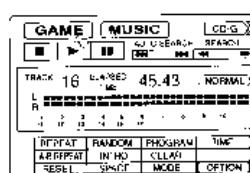
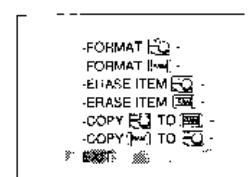
ERASE Screen 1



ERASE Screen 2

## ENDING FORMATTING, ERASING, and COPYING

- Select EXIT on menu. Press Button C to return to the Control Panel.
- Insert the Sega CD you want to use and operate the Control Panel to start the game.

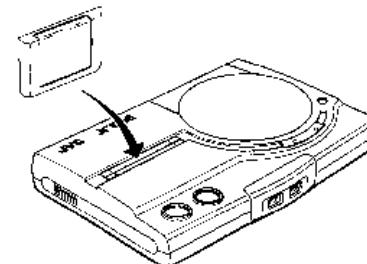


Control Panel

# Playing JVC X' EYE

## PLAYING CARTRIDGES (GAMES)

- Turn the power of X'EYE to OFF.
- Insert the cartridge into the cartridge slot, label side facing forward.



- Press the power button on the JVC X' EYE console to turn it on.

- Use the control pad to start the game.

When playing a long game, it is suggested that you take a 10 to 20 minute rest every hour for your health.

## ENDING GAMES

- Press the power button on the JVC X' EYE console to turn it off.
- Gently pull the cartridge straight out.
- Unplug the AC adaptor.

NOTE:

Never take out the cartridge when the power is on as this will cause malfunctioning or damage.

## PLAYING CDs (MUSIC)

- Turn on the TV.
- When inserting a music CD, the "MUSIC" indication is selected.
- Press START on the control pad or press button C to begin playing the CD.
- When the CD is finished playing, remove the disc from the tray.

# Playing JVC X' EYE

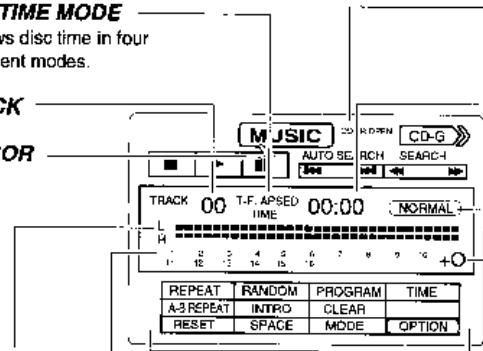
## CONTROL PANEL DISPLAY

### DISC TIME MODE

Shows disc time in four different modes.

### TRACK

### CURSOR



### LEVEL METER

### MUSIC CALENDAR

Normally indicates track numbers in the track order of the inserted disc. During PROGRAM or RANDOM playing, it displays the track order that you have set. Further, when the track order has been set for PROGRAM playing, the LEVEL meter is replaced with the PROGRAM CALENDAR.

### DOOR OPEN

Indicates that the CD door is open.

### TIME

### MODE

Displays in two sound modes

### INTRO PLAYING TIME

Indicates the length of INTRO time when it has been set.

### SPACE

Indicates the space between tracks when it has been set.

## CONTROL PANEL BUTTONS

### STOP

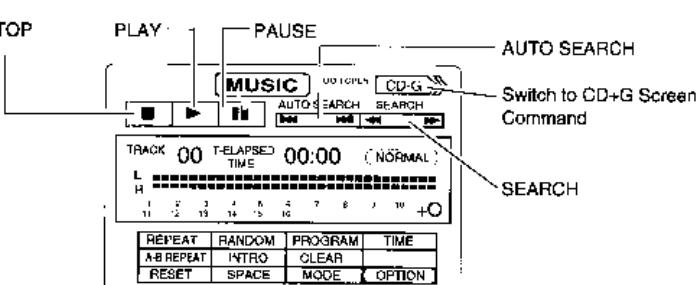
### PLAY

### PAUSE

### AUTO SEARCH

Switch to CD+G Screen Command

### SEARCH



# Playing JVC X' EYE

## CONTROL PANEL BUTTONS

### PLAY

When you select [▶] or [MUSIC] and press Button C, the option turns red and play begins.

### PAUSE

When you select [II] and press Button C, the option turns red and play of the current track is paused. Playing resumes from where the track was stopped if you press it again.

### STOP

When you select [■] and press Button C, play of the current track stops.

### AUTO

(Can be used during PLAY, PAUSE, and STOP and PAUSE)

1. When you select either [▶▶] (right) or [◀◀] (left) and press Button C, this option takes you forward or back by one track.
2. When PAUSE or STOP are highlighted, you can resume play by pressing PLAY again.

### SEARCH

(Can be used only during PLAY)

When you select either [▶▶] (right) or [◀◀] (left) and press Button C, the option turns red and cues forward [▶▶] or back [◀◀] through the current track while you hold down Button C.

### CD-G

When you select CD-G and press Button C, the display changes to the CD-G screen.

## FUNCTION COMMANDS

### REPEAT

(Can be set during PLAY, PAUSE, and STOP)

Repeats play.

When you select REPEAT and press Button C, the option turns red. During PLAY, play starts by itself. During PAUSE or STOP, play is started by selecting PLAY and pressing Button C. All the tracks on the CD or the tracks that you select for PROGRAM playing are repeated. RANDOM and INTRO playing can also be repeated.

### A-B REPEAT

Repeats a section of track. (Can only be used during PLAY.)

1. When you select A-B REPEAT and press Button C, the option turns blue and the starting point of section to be repeated (A) is marked.
2. The end of the section to be repeated (B) is marked by pressing Button C again. AB-REPEAT turns red and repeat playing of section A to B begins.

### RANDOM

Plays automatically selected tracks. (Can only be set during STOP.)

1. When you select RANDOM and press Button C, the option turns red.

2. When you select [▶] and press Button C, random playing begins. This option can also be combined with INTRO, PROGRAM, and REPEAT playing.

### PROGRAM

Enables you to listen to tracks in the order you choose. (Can only be set during STOP.)

1. When you select PROGRAM and press Button C, the option turns blue.

# Playing JVC X' EYE

2. When you select the track you want to hear with the cursor and press Button C, its number is displayed on the MUSIC CALENDAR.  
(Up to 99 tracks can be programmed.)
3. After selecting a track, when you select EXIT and press Button C, the cursor moves to the PROGRAM option. (The PROGRAM option turns red.)
4. When you select [▶] and press Button C, PROGRAM playing begins.

## CLEAR

Clears the PROGRAM option. (Can be used during PLAY, PAUSE, and STOP). When you select CLEAR and press Button C, everything in PROGRAM is erased. To execute PROGRAM again, stop play by selecting [■] and then carry out PROGRAM steps 1 to 4. To clear when in PROGRAM, select EXIT and press Button C (the cursor will move to PROGRAM) before carrying out steps for CLEAR given above.

## INTRO

- Plays the beginning of each track in order (Can be used during PLAY, PAUSE, and STOP).  
The beginning section (intro) to be played can be from 1 to 59 seconds.
1. When you select INTRO and press Button C, the option turns red and INTRO time is displayed on the screen.
  2. INTRO time is changed with the direction buttons. The right and left buttons are to select either the ones or tens digit and the up and down buttons are to increase or decrease the number.
  3. When Button C is pressed to end time setting, the INTRO time display disappears. During PLAY, play starts by itself. During PAUSE or STOP, play is started by selecting PLAY and pressing Button C.

## SPACE

- Pauses for a number of seconds between tracks. (Can be used during PLAY, PAUSE, and STOP).  
The pause between tracks (space) can be from 1 to 59 seconds. This feature can be combined with INTRO, PROGRAM, and REPEAT playing.
1. When you select SPACE and press Button C, the option turns red and SPACE time is displayed on the screen.
  2. SPACE time is changed with the direction buttons. The right and left buttons are to select either the ones or tens digit and the up and down buttons are to increase or decrease the number.
  3. When you press Button C to end time setting, the SPACE time display disappears. During PLAY, play starts by itself.

## MODE

Is used for the karaoke function  
When you select MODE and press Button C, the following sound modes are displayed. The mode changes each time you press Button C.  
NORMAL is for normal stereo sound.  
V-MASKING is for lowering the voice of a vocalist on a normal music CD and to enjoy Karaoke by singing along.  
When you use Karaoke Disc, please set to NORMAL position.

# Playing JVC X' EYE

## TIME

If you select TIME and press the Button C during playback, the modes below will be displayed. The mode changes each time you press the button.

ELAPSED: Time that has passed since the current track started playing.

T-ELAPSED: Total time that has passed since the disc started playing.

REMAIN: Time remaining in the current track.

T-REMAIN: Total time remaining on the disc.

## RESET

Turns all function commands off.

When you select RESET and press Button C, all the function commands that are on (those highlighted in red) are turned off.

## OPTION

Is selected when you want to back up your data or use optional functions that will be available later.

When you select OPTION, the optional function screen appears.

## BLIND CONTROL

It is possible to control audio CD playing without turning on your TV. Control functions can be executed while holding down the START button.

START + Button A: STOP

START + Button B: PLAY

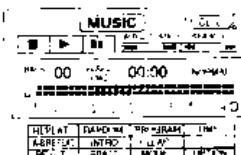
START + Button C: PAUSE

START + direction button (right/left): AUTO SEARCH (forward or reverse)

## PLAYING CD+Gs

1. Insert a CD+G the disc tray and close the CD door.

2. Press START on the control pad or press button C. The CD+G begins playing and the screen goes automatically to the CD+G display.



3. Control during Play is carried out with the CD+G Control Panel.

Press Button B on the control pad to hide or restore the CD+G Control Panel. (With every other toggle, a status line appears on the CD+G screen.)



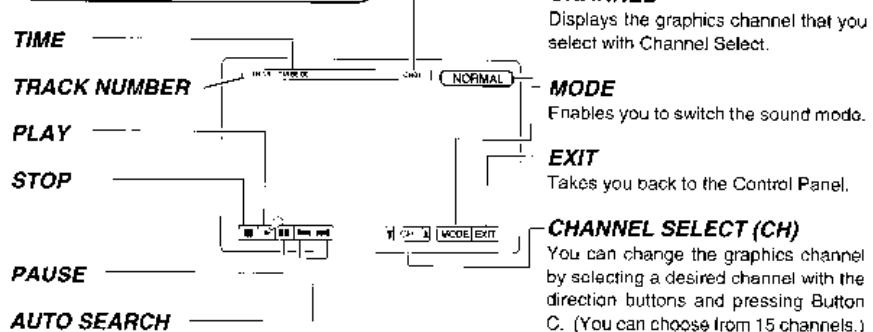
# Playing JVC X' EYE

## What is a CD+G?

Since a CD+G contains not only signals for sound, but also signals for graphics, you can play still pictures and characters along with the music.

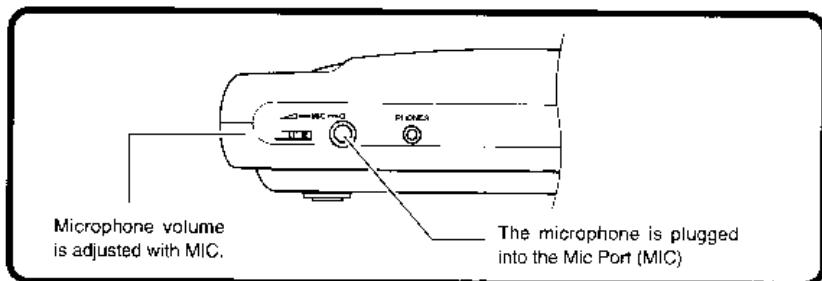
- A disc may contain up to 16 graphics channels and by switching channels, you can choose different languages (e.g. Japanese or French) for a song's lyrics. Whether possible or not depends on the disc, so please read the instructions of the disc.
- As with audio CDs, you can control CD+G playing with the Control Panel. (CD+G graphics are hidden when the Control Panel is being displayed.)
- You may see distortion in the picture after you cue forward or back with the Control Panel during PLAY and return to the CD+G graphics.

## FUNCTION COMMANDS



## Mic Mixing (Singing along with the music.)

1. Connect the microphone to the console.
2. Adjust microphone volume.

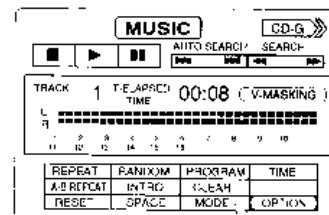


# Playing JVC X' EYE

## The vocal masking (V-MASKING)

Lowers the volume of the singer's voice on audio CDs

Select MODE and press Button C, then select the V-MASKING Control Panel.



- What is vocal masking?

By lowering the sound in the central position of music recorded in stereo, you can reduce the volume of the singer's voice. However, the vocal masking does not mute the singer's voice.

Please play music recorded in stereo when using the vocal masking. If it is used with monaural recordings, the volume of both the singer's voice and the music will be reduced.

However, the vocal masking may not work even with stereo recordings of classical pieces, songs with few instruments, duets, songs with strong echoing (such as chorus performances), songs where the singer's voice is not in the central position, etc.

## SOME ADVICE:

- \* You may experience howling (a sharp screeching noise) when you turn the microphone volume all the way up. To prevent this:
  1. Do not face the microphone toward the speakers or keep the microphone a distance from the speakers.
  2. Turn down MIC volume.
 Turn the volume down when not using the microphone.

## JVC X' EYE Hardware information

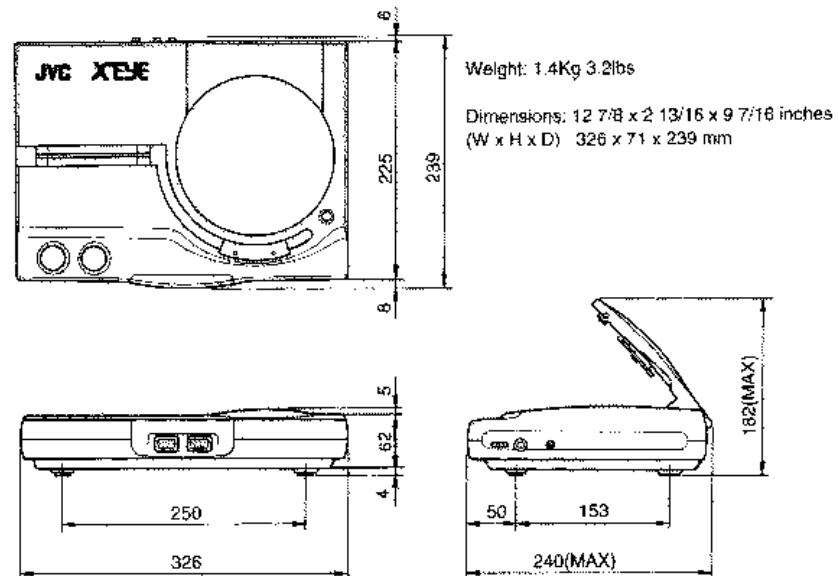
CPU:	68000 (12.5MHz) 68000 (8MHz) 280A (4MHz)
Memory:	RAM: 6Mbit (CD-ROM buffer memory) 512kbit (PCM waveform memory) 128kbit (CD-ROM data cache memory) 64kbit (backup memory) 576kbit (program memory) 512kbit (video memory)
Sound circuitry	Boot ROM: 1Mbit CD game BIOS CD player software CD+G compatible
	sound source: PCM sound source (Stereo 8 channels Monaural 1 channel) FM sound source (Stereo 8 channels) PSG sound source (3 sounds + 1 noise)
	D/A converter: PEM 1Bit D/A converter 8 x internal over-sampling digital filter
Graphics:	Maximum no. color display: 64 colors from a 512 palette Maximum resolution: 320 x 244 dots Sprites: 80 Backgrounds: 2 Special display functions: Rotation, enlargement, and reduction
Input/Output Ports:	Audio input: Mic. connection standard jack (Input impedance : 10 kohms) Audio output: RCA pin jack (L/R) Headphone connection mini-jack (L/R) Video output: composite video output (1.0Vp-p 75 ohms; imbalance) RF adaptor connection output Control port: Control pad connection 9-pin D-SUB connector x 2
CD drive unit:	CD diameter: 12cm and 8cm Access time: Average 0.8 sec.
Battery back-up:	secondary duration: Approx. 1 month
Usage environment:	Temperature: 0°C- 40°C Humidity: 10% - 80% RH
Custom AC Adaptor:	Input: AC120V ~, 60Hz Output: DC9.5V, 1.5A Elec. consumption: 20W max

## JVC X' EYE Hardware information

Accessories:  
AC adaptor (AA-S95J) x 1  
Control Pad x 1  
RF adaptor (RF-S10J) x 1  
Supplied software x 4 (3 types)

Design & specifications subject to change without notice.

### Measurements(unit: mm)



## Description of ICs

### ■ MC68HC000 (IC101, 171) : CPU

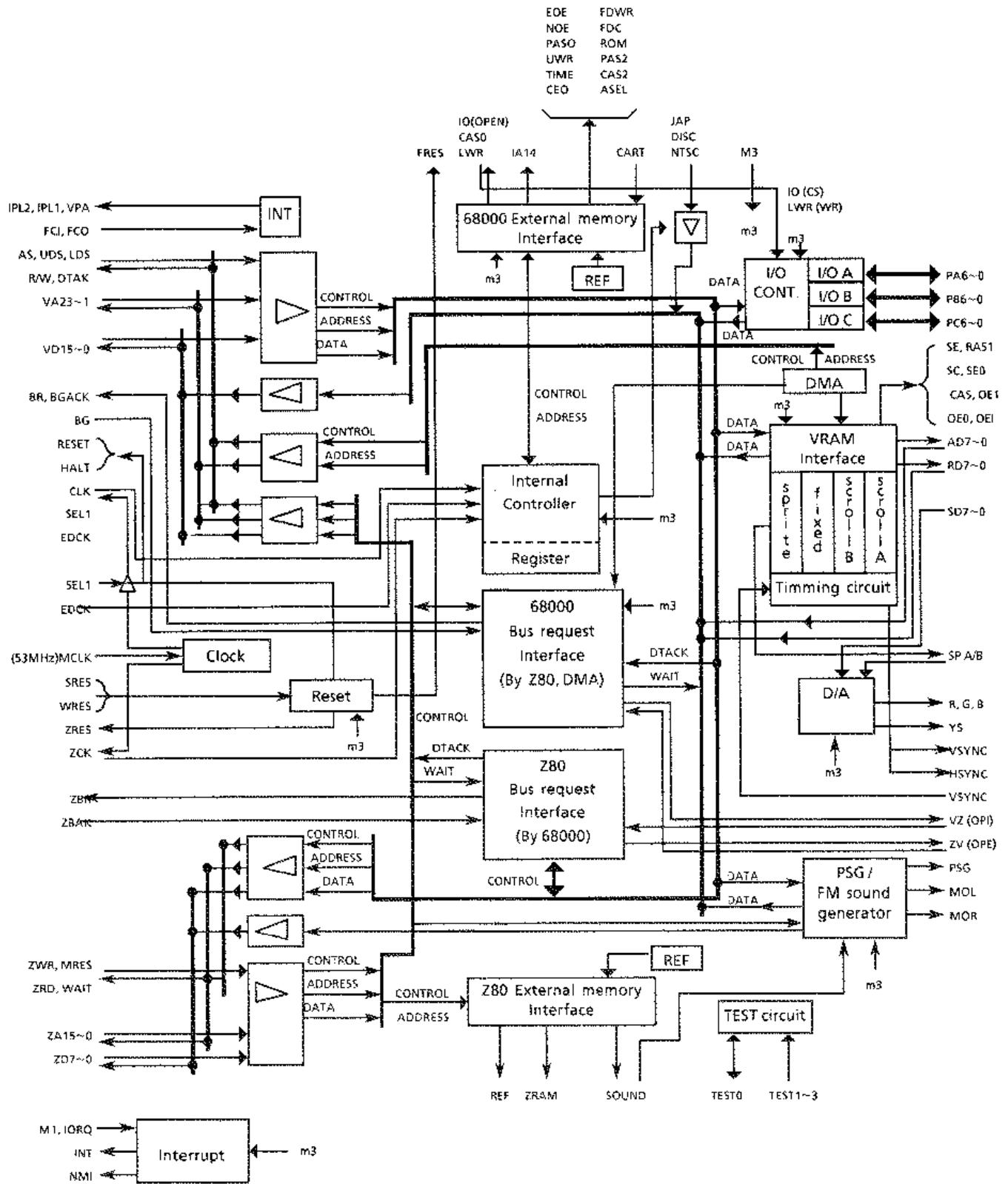
#### Pin Functions

Pin No.	Name	Symbol	I/O	Function
32~51 53~55	ADDRESS BUS	A1~A23	O	It can specifies 16M Bytes memory directly.
5~1 68~58	DATA BUS	D0~D15	I/O	Data lines D0~D15 are bidirectional and used for data transfer. Interrupt vector is inputted at a acknowledge cycle of interrupt from I/O.
6	ADDRESS STROBE	AS	O	This output strobe is used to indicate the presence of an address on the 24-bit multiplexed bus.
9	READ/WRITE	R/W	O	This output pin is used to indicate the direction of data transfer.
7 8	DATA STROBE	UDS LDS	O O	This outputs are used to transfer data to or from a peripheral or memory. UDS indicates upper byte. One of them is active when accessing by byte, and the both are active when accessing by word.
10	DATA TRANSFER ACKNOWLEDGE	DTACK	I	This signal is inputted after transferring data with peripheral devices.
13	BUS REQUEST	BR	I	The signal which requests to make data and address bus free is inputted from one of the other peripheral controllers. The address and data bus and control terminals become high impedance state after receiving this signal.
11	BUS GRANT	BG	O	When bus request is inputted, this pin lets the peripheral controllers know that the data and address bus and control terminals are free.
12	BUSS GRANT ACKNOWLEDGE	BGACK	I	The signal from the peripheral controller is inputted which means that the controller become bus master, after bus grant is outputted.
27~25	INTERRUPT CONTROL	IPL0~2	I	Interrupt request which has seven levels is inputted. IPL2 is most significant bit.
24	BUS ERROR	BERR	O	When a trouble occurs on the bus cycle in execution, bus error is asserted.
20	RESET	RESET	I/O	This terminal is used as an input to initialize the CPU by pulling RESET low. When the reset command is executed, this terminal is used as an output to the peripheral devices.
19	HALT	HALT	I/O	A low level on this terminal will cause the CPU to stop running at the end of the present instruction. As an output, HALT indicates that a bus error has occurred two times successively. In the halt state, address and data bus and control terminal are in high impedance states.
22	ENABLE	E	O	This is used to communicate with the peripheral device for 6800.
23	VALID PERIPHERAL ADDRESS	VPA	I	This is used to access the peripheral devices for 6800. The access signals for the peripheral devices are outputted by asserting this pin. When VPA is asserted on the interrupt acknowledge cycle, MPU executes the interrupt acknowledge cycle specified by automatic vector.
21	VALID MEMORY ADDRESS	VMA	O	This signal is outputted when the peripheral devices like I/O assert this terminal to request an access timing for the peripheral LSIs for 6800. The active of this terminal means that the address bus are valid.
30~28	PROCESSOR STATUS SIGNAL	FC0~FC2	O	These 3 bits indicates the state of the CPU: fetching instructions, accessing data and interrupt acknowledge.
15	CLOCK	CLK	I	Operational clock input
14, 52	POWER SUPPLY	VCC	--	+5V
16, 17,56,57	GROUND	GND	--	GND

## ■ 315-5660(IC191) : Game processor

### 1. Outline

Game processor only controlled by the main-CPU performs all of the screen controls. The controlled screen consists of five layers: sprite, scroll A, scroll B, window and background. Monaural PCM sound generator, programmable sound generator and FM sound generator controlled by Z80 are also included



## 3. Pin Functions

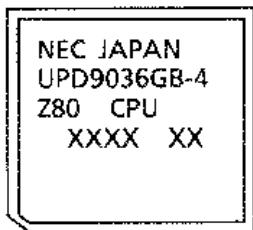
Pin No.	Symbol	I/O	Function	Pin No.	Symbol	I/O	Function
154~176 137~152	VA1~VA23 VD0~VD15	I/O I/O	68000 ADDRESS BUS 68000 DATA BUS	12 13 16 15 10 14 9 11 26~33 1~8 17~20, 22~25	RAS1 CAS1 OE1 WE0 SE0 WE1 SE1 SC AD0~AD7 SD0~SD7 RD0~RD7	O O O O O O O O I/O	DUAL PORT RAM INTERFACE SIGNALS
191 192 193 194 195 182 183 184 185~186 47 48 49 50~51 130	AS UDS LDS R/W DTAK BR BGACK BG IPL1~IPL2 VPA HALT RESET FC0~FC1 CLK	I/O I/O I/O I/O I/O O I/O I/O O O O I I/O	68000 INTERFACE SIGNALS	56 55 57 54	MOL MOR SOUND VDD SOUND VSS	O O — —	FM
112~127 200~207 187 188 189 190 52 59 60 61 62 63 181 132	ZA0~ZA15 ZD0~ZD7 IORQ ZRD ZWR M1 MREQ ZRES ZBAK NMI ZBR WAIT INT ZCLK	I/O I/O I I/O I/O I I/O I/O I I/O I/O I/O I/O	Z80 ADDRESS BUS Z80 DATA BUS	131 38 34 35 36 37 42 178 177 179	SBCR VIDEO AVDD VIDEO AVSS R G B CSYNC PSG SOUND VDD SOUND VSS	O — — O O O I/O O — —	VIDEO + PSG
199 64 196 65 197	RAS0 BOE UWR NOE LWR	O O O O I/O	P-SRAM INTERFACE	100~106 93~99 85~91	PA0~PA6 PB0~PB6 PC0~PC6	I/O I/O I/O	JOY PAD INTERFACE
66 67	ZRAM REF	O O	SRAM INTERFACE	81 82~84	TEST 0 TEST 1-3	I/O I	TEST SIGNAL TEST SIGNALS
39 41 43 135 198	YS VSYNC HSYNC EDCLK CAS0	O O I/O I/O I/O		111 110 109 58	IO VZ ZV SOUND	I/O I/O I/O I/O	NOT USED
68 69 70 71 72 108 73	CAS2 RAS2 ASEL ROM FDC FRES FDWR	O O O O O I/O O		44, 80, 136, 208 21, 53, 92, 133, 153, 180	VDD VSS	— —	POWER SUPPLY GND
74 45 75 76 79	CEO M3 TIME CART DISK	O I O I I/O					
77 40 129 134	IA14 SPA/B SEL1 MCLK	O I/O I I					
46 78 128 107	NTSC WRES SRES JAP	I I I I/O					

■ Z80(IC181) : CPU for FM sound generator

This IC is central processing unit which fetches instructions to execute a program.

Pin Functions

Pin No.	Symbol	I/O	Function
27~44	ZAO~ZA15	O	Address select lines. These lines are normally used to select the port and/or control registers.
9,10,7,3,2 4,5,8	ZZD0~ZD7	I/O	Data bus, bidirectional, 3-state. This bus is used to transfer data between the cpu and the peripheral device.
23	ZRES	I	A low on this line resets the CPU.
13	NMI	I	This is interrupt request signal which is prior to ZINT.
22	ZBR	I	This is inputted when peripheral controllers wants to control data and address bus, memory request, I/O request, read and write. ZBR is prior to NMI.
21	ZWAIT	I	A low on this line indicates that the responding device needs more time to complete a transaction. The CPU can wait process of the devices.
12	ZINT	I	This signal can be driven by any peripheral capable of generating an interrupt. A low on INT indicates that an interrupt request is being made.
18	ZRD	O	The CPU asserts this terminal to read data.
19	ZWR	O	The CPU asserts this terminal to write data.
24	M1	O	The state of the CPU is presented.
15	MREQ	O	The CPU output this memory request signal to read and write data.
16	TREQ	O	The CPU outputs this I/O request signal to read and write data.
20	ZBAK	O	A low on this line indicates that the Z-BUS CPU has relinquished control of the bus in response to a bus request.
6	VCC	--	Power supply
26	GND	--	GND
11,17,33,39	NC	--	Non connection
25	RFSH	--	Non connection
14	HALT	--	Non connection



■ TC511632FL-10 (IC172) : Psevdo static RAM (Program-RAM for main-CPU)

These RAM are used to store the programs that main-CPU executes.

Terminal Layout (Top view)

GND	1
A9	2
A8	3
A7	4
A6	5
A5	6
A4	7
A3	8
A2	9
A1	10
A0	11
D1	12
D2	13
D3	14
D4	15
D5	16
D6	17
D7	18
D8	19
GND	20
	21 VCC

Pin Functions

Pin No.	Symbol	I/O	Function
2~11, 33~37	A0~A14	I	Address bus. These are used to selected the specified memory.
12~19, 22~29	D1~D16	I/O	Data bus. These are bidirectional ports and used to transfer data between main-CPU and RAM.
39	UWR	I	This signal is inputted when writing upper bits of data.
38	LWR	I	This signal is inputted when writing lower bits of data.
32	UOE	I	Data (upper bits) can be outputted when this terminal is low level.
31	LOE	I	Data(lower bits) can be outputted when this terminal is low level.
30	CE	I	Chip enable. This signal is inputeed, when this ic is used.
40, 21 1, 20	VDD, VCC GND, GND	I	Power supply

■ LC3564QM-10 (IC102) : Static RAM ( Backup-RAM for sub-CPU )

BR65265AF-10LL (IC182) : Static RAM ( Program-RAM for Z80 )

Terminal Layout

NC	1
A12	2
A7	3
A6	4
A5	5
A4	6
A3	7
A2	8
A1	9
A0	10
I/O 1	11
I/O 2	12
I/O 3	13
GND	14
	15 I/O 8
	16 I/O 7
	17 I/O 6
	18 I/O 5
	19 I/O 4

Pin Functions

Pin No.	Symbol	I/O	Function
2~10, 21, 23~25	A0~A12	I	Address bus. These are used to be selected the specified memory.
27	WE	I	When this is low, data can be written.
22	OE	I	When this is low, data can be read.
20	CE1	I	The CE input signal is inputted when data is read or written.
11~13, 15~19	I/O1~I/O8	I/O	Data bus. These are bidirectional ports.
28	VDD	-	Power supply
14	GND	-	Gnd

## ■ MSM54C864 (IC192) : Dual Port RAM (Video-RAM)

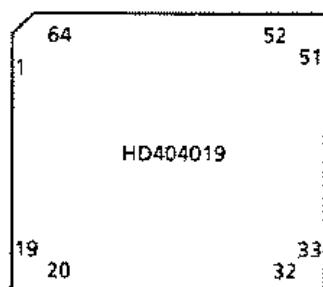
SC	1	40	VSS1
SIO1	2	39	SIO8
SIO2	3	38	SIO7
SIO3	4	37	SIO6
SIO4	5	36	SIO5
DT/OE	6	35	SE
WIO1	7	34	WIO8
WIO2	8	33	WIO7
WIO3	9	32	WIO6
WIO4	10	31	WIO5
VCC1	11	30	VSS2
WB/WE	12	29	NC
NC	13	28	NC
RAS	14	27	CAS
NC	15	26	NC
NC	16	25	A0
A6	17	24	A1
A5	18	23	A2
A4	19	22	A3
VCC2	20	21	A7

## Pin Functions

Pin No.	Symbol	I/O	Function
7~10, 31~34	WIO1~ WIO8	I/O	Write mask data is inputted at the falling edge of RAS when WB/WE is low level. The ports specified by the data can not be written picture data. The picture data is written at falling edge of the latest signal among CAS and WE.
12	WB/WE	I	This signal is used to determine the writing mode at the falling edge of RAS on the read/write cycle. (L : Write per bit mode) On data transform cycle, when WB/WE is high level at the fallijng edge of RAS, picture data is transformed from RAM to SAM, and from SAM to RAM when WB/WE is low.
21~25 17~19	A0~A7	I	Address bus. These are used to address the memory.
14	RAS	I	The address on the address bus are latched as raw address of the memory at the falling edge of RAS.
27	CAS	I	The address on the address bus are latched as column address of the memory at the falling edge of CAS.
1	SC	I	The serial data transfer is controlled by SC(Serial clock). The valid data are outputted from SIO0~SIO8 after the rising edge of SC on read cycle. And the data on SIO0~SIO8 are latched at the rising edge of SC on write cycle.
6	DT/OE	O	This signal is used as output enable during the read cycle when DT/OE is high at the falling edge of RAS. When DT/OE is low at the same timming, the operation cycle of this ic becomes data transfer cycle.
35	SE	I	Serial enable. This is used as output enable signal during serial read mode, and as input enable during serial write mode.
2~5,36~39	SIO0~SIO8	I/O	Serial port for SAM
11,20	VCC	-	POWER SUPPLY
30,40	VSS	-	GND

## ■ HD404019RC23FS (IC691) : CD controller

## 1. Terminal Layout



## 2. Pin Functions

Pin No.	Symbol	I/O	Function	Pin No.	Symbol	I/O	Function
1	PCD	O		33	—	—	Not used (Non connection)
2	DSPM	O	Muting signal for audio signal	34	—	—	Not used (Non connection)
3	MONO	O	'Voice changer', 'L-ch', 'R-ch' : High	35	—	—	Not used (Non connection)
4	VCAN	O	'Vocal masking' : High	36	—	—	Not used (Non connection)
5	VCHN	O	'Voice changer' : High	37	—	—	Not used (Non connection)
6	L	O	'Normal', 'Vocal masking', 'L-ch' : High	38	LIVE	—	Not used (Non connection)
7	R	O	'Normal', 'Vocal masking', 'R-ch' : High	39	PANOSW	—	Not used (Non connection)
8	—	—	Non connection	40	—	—	Not used (Connected to GND)
9	—	—	Non connection	41	—	—	Not used (Connected to GND)
10	—	—	Non connection	42	—	—	Not used (Connected to GND)
11	—	—	Non connection	43	RST	I	Reset signal inputted
12	—	—	Non connection	44	VCC	—	Power supply
13	GND	--	Ground	45	OSC	—	Oscillation terminal
14	ERES	I	Reset signal for IC141	46	OSC	—	Oscillation terminal
15	HOCK	O		47	GND	--	Ground
16	SCOR	I	Detect the appearance of sync. of subcode	48	LASER	O	H : Laser on / L : off
17	WFCK	I	Not used	49	XCX	O	H : Tracking off
18	DB0	I/O	Communication data with sub-CPU	50	XLAT	O	Latch signal for CXD2500BQ
19	DB1	I/O	Communication data with sub-CPU	51	DFCT	O	Defect signal out
20	DB2	I/O	Communication data with sub-CPU	52	LOCK	I	Lock signal input
21	DB3	I/O	Communication data with sub-CPU	53	FOK	I	Focus ok signal input
22	CDCK	O	Clock out to communicate with sub-CPU	54	SENS	I	Sense signal out
23	IRQ	O	Interrupt request signal to sub-CPU	55	TEST	I	Test mode terminal
24	DMUTE	O	Muting signal for 'Search' and 'Pause'	56	EMP	O	Emphasis control signal
25	D/M	O	CD-ROM : H, Audio disc : L	57	—	—	Not used (Non connection)
26	VCC	—	Power supply	58	—	—	Not used (Non connection)
27	SQCK	O	Clock out to read SQSO	59	—	—	Not used (Non connection)
28	SQSO	I	Q data of subcode is inputted	60	—	—	Not used (Non connection)
29	DATA	O	Control data for CXD2500BQ	61	PANO	—	Not used (Non connection)
30	CLOCK	O	Clock for transforming DATA	62	—	—	Not used (Non connection)
31	CLOSE SW	I	Detect the disc door closing	63	—	—	Not used (Non connection)
32	—	—	Not used (Non connection)	64	—	—	Not used (Non connection)

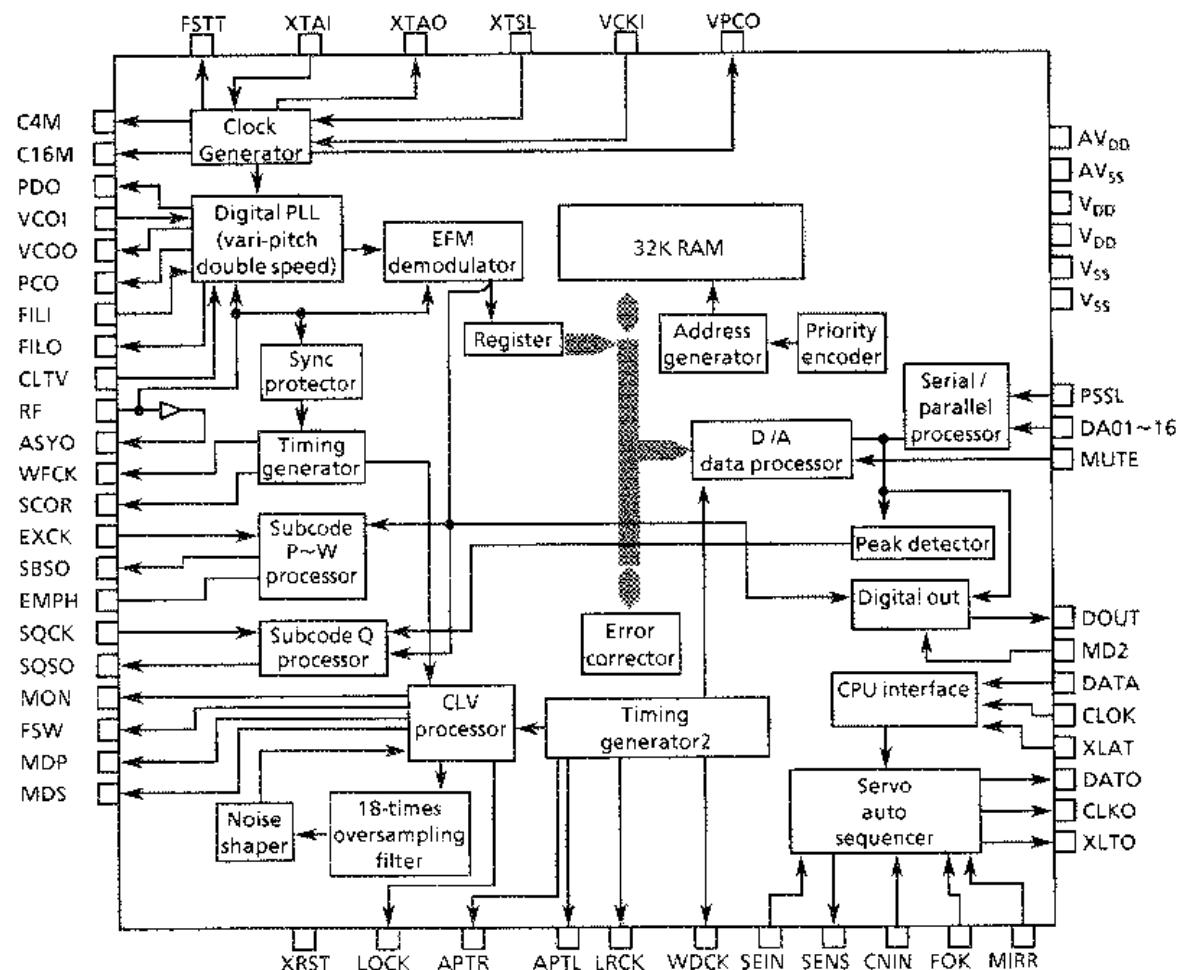
## ■ CXD2500BQ(IC601) : Digital Signal Processor

### 1. Outline

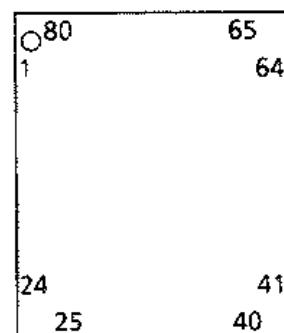
The CXD2500BQ is a digital signal processing LSI designed for use in compact disc players. It has the following functions:

- All digital signals for regeneration are processed using one chip.
- The built-in RAM enables high-integration mounting.
- Generation by the use of a digital PLL of bit clock pulses for strobing the EFM signal.
- EFM data demodulation
- Subcode demodulation and subcode Q data error detection
- Digital spindle servo system (incorporating an oversampling filter)

### 3. Block Diagram



### 2. Terminal Layout



### Notes:

- The data at the 64-bit slot is output in 2's complements on an LSB-first basis. The data at the 48-bit slot is output in 2's complements on an MSB-first basis.
- GTOP monitors the state of Frame Sync protection. ("H" : Sync protection window released)
- XUFG is a negative Frame Sync pulse obtained from the EFM signal before Frame Sync protection is effected.
- XPLCK is an inversion of the EFM PLL clock. The PLL is designed so that the falling edge of XPLCK coincides with a change point of the EFM signal.
- The GFS signal turns "H" upon coincidence between Frame Sync and the timing of interpolation protection.
- RFCK is a signal generated at 136- $\mu$ s periods using a crystal oscillator.
- C2PO is a signal to indicate a data error.
- XRAOF is a signal issued when a jitter margin of  $\pm 28F$  is exceeded by the 32K RAM.

## 4. Pin Functions

Pin No.	Symbol	I/O	Function
1	FOK	I	Focus OK input pin. Used for SENS output and servo auto sequencer.
2	FSW	O	Non connection
3	MON	O	Output for spindle motor ON / OFF control.
4	MDP	O	Output for spindle servo control.
5	MDS	O	Output for spindle servo control (Non connection).
6	LOCK	O	This terminal is "H" when the GFS signal sampled at 460Hz is "H". It turns "L" when the GFS signal turns out "L" 8 or more times in succession.
7~9	—	--	Non connection
10	TEST	I	Test pin (Normally at 0V)
11	PDO	O	Output of charge pump for analog EFM PLL (Non connection).
12	Vss	--	GND
13~16	—	--	Non connection
17	VCKI	I	Clock input from external VCO for vari-pitch control. $f_c = 16.9344\text{MHz}$ .
18	FILO	O	Output of filter for masterPLL (Slave = Digital PLL)
19	FILI	I	Input to filter for master PLL.
20	PCO	O	Output of charge pump for master PLL.
21	AVss	—	Analog GND
22	CLTV	I	VCO control voltage input for master PLL.
23	AV <sub>DD</sub>	—	Analog power supply
24	RF	I	EFM signal input
25	TEST2	I	TEST pin (Connected to GND)
26	TEST3	I	TEST pin (Connected to GND)
27	ASYO	O	EFM full-swing output
28	TEST4	I	TEST pin (Connected to GND)
29	NC	--	Non connection
30	PSSL	I	Input used to switch the audio data output mode. "L" for serial output, "H" for parallel output.
31	WDCK	O	D/A interface for 48-bit slot. Word clock $f = 2Fs$ .
32	LRCK	O	D/A interface for 48-bit slot. LR clock $f = Fs$ .
33	V <sub>DD</sub>	—	Power supply
34	DA16	O	Output DA16(MSB) when PSSL = 1 or serial data from 48-bit slot(2's complements,MSB first) when PSSL = 0.
35	DDA15	O	Output DA15 when PSSL = 1 or bit clock from 48-bit slot when PSSL = 0.
36~51	—	--	Non connection
52	VSS	--	GND
53	XTAI	I	Input to 16.9344MHz Xtal oscillation circuit or 33.8688MHz input.
54	XTAO	O	Output of 16.9344 MHz Xtal oscillation circuit.
55	XTSL	I	Xtal selection input pin. "L" for 16.9344MHz Xtal, "H" for 33.8688 MHz Xtal.
56~58	—	--	Non connection
59	MD2	I	Digital-Out ON/OFF control. "H" for ON, "L" for OFF.
60	DOUT	O	Digital-Out output pin.
61	EMPH	O	H : emphasis on L : emphasis off
62	—	--	Non connection
63	SCOR	O	Turns "H" when subcode Sync S0 or S1 is detected.
64	SBSO	O	Serial output of Sub P to W.
65	EXCK	I	Clock input for reading SBSO.
66	SQSO	O	Outputs 80-bit Sub Q and 16-bit PCM peak-level data.
67	SOCK	I	Clock input for reading SQSO.
68	MUTE	I	"H" for muting, "L" for release.
69	SENS	O	SENS output to CPU.
70	XRST	I	System reset. "L" for resetting.
71	DATA	I	Inputs serial data from CPU.
72	XLAT	I	Latches serial data input from CPU at falling edge.
73	V <sub>DD</sub>	--	Power supply(+5V)
74	CLOK	I	Inputs serial data transfer clock from CPU.
75	SEIN	I	Inputs SENSE from SSP.
76	CNIN	I	Inputs track jump count signal.
77	DATO	O	Outputs serial data to SSP.
78	XLTO	O	Latches serial data output to SSP at falling edge.
79	CLKO	O	Outputs serial data transfer clock to SSP.
80	MIRR	I	Inputs mirror signal to be used by auto sequencer when jumping 128 or more tracks.

## ■ CXA1372Q (IC502) : RF Signal Processing Servo Amplifier

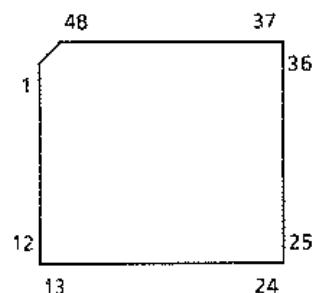
### 1. Outline

The CXA1372Q is a bipolar IC developed for RF signal processing (focus OK, mirror, defect detection, EFM comparator) and servo control.

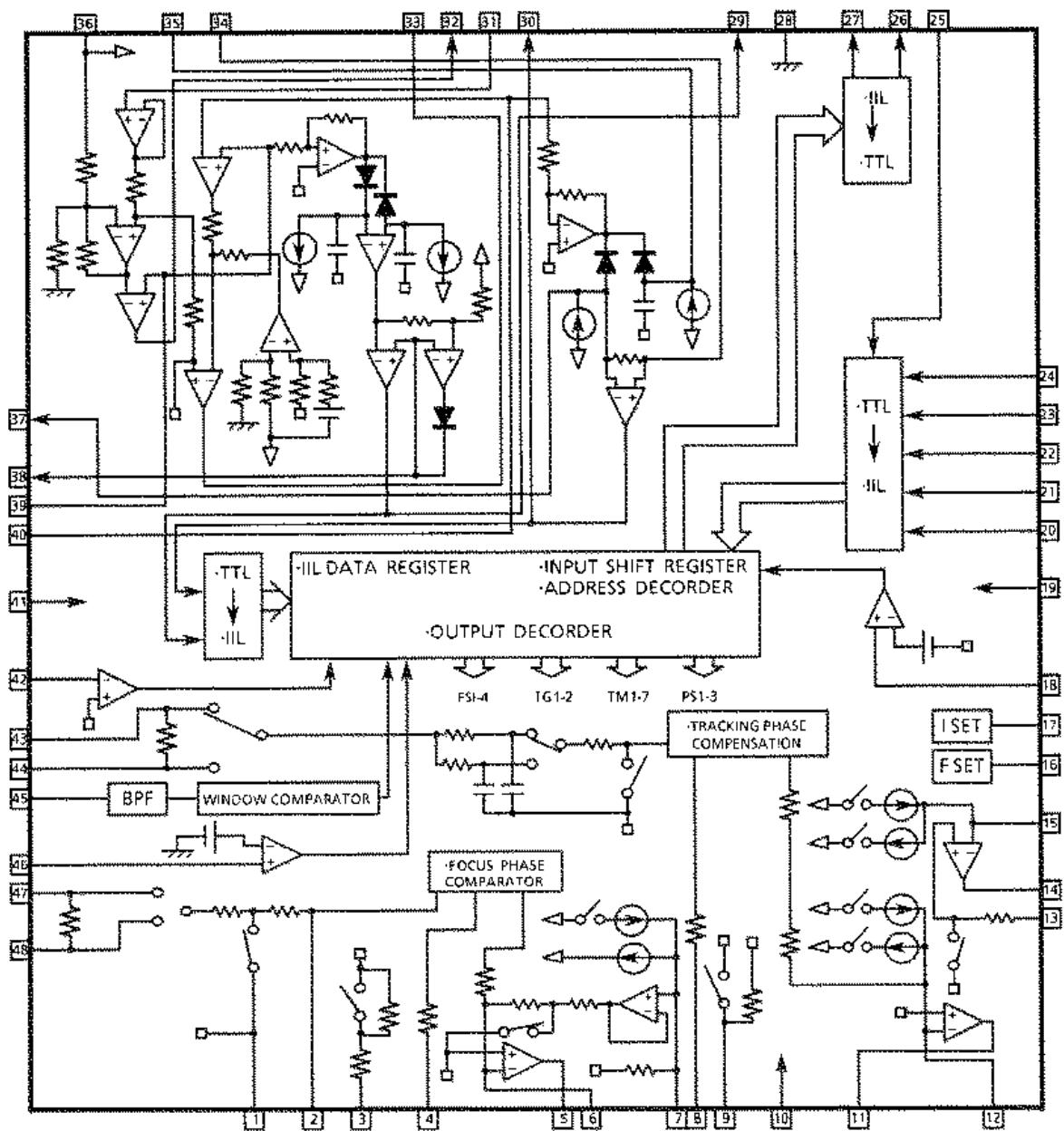
### 2. Functions

- Auto asymmetry control
- Focus OK detection circuit
- Mirror detection circuit
- Defects detection, counter measures circuit
- EFM comparator
- Focus servo control
- Tracking servo control
- Feed servo control

### 3. Terminal Layout



### 4. Block Diagram



## 5. Pin Functions

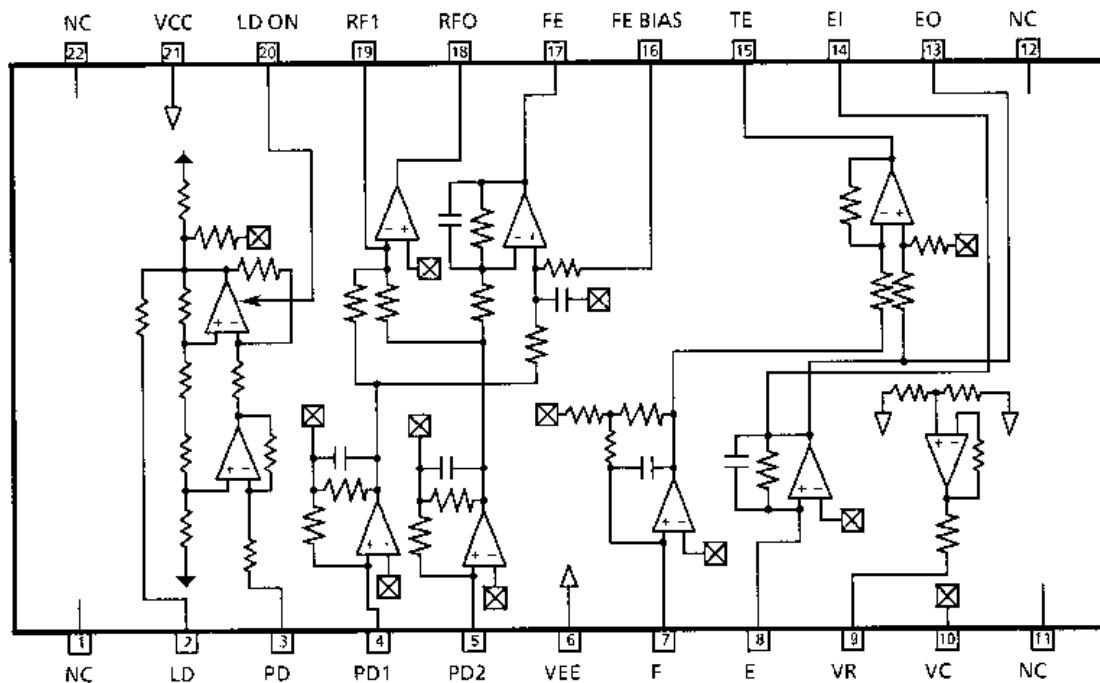
Pin No.	Symbol	I/O	Function
1	TE	I	Input pin of tracking error amplifier.
2	TDFCT	I	Capacitor connecting pin for time constant during defects.
3	ATSC	I	Window comparator input pin for ATSC detection.
4	FZC	I	Pin for focus zero-cross comparator input.
5	FE	I	Input pin of focus error.
6	FDFCT	I	Capacitor connecting pin for time constant during defect functions.
7	VC	I	Center voltage input pin. For dual power: GND For single power supply: (VCC + GND)/2
8	FGD	I	Connect a capacitor between this pin and pin3 to reduce high-frequency gain.
9	FS3	I	The high-frequency gain of the focus servo is switched through FS3 ON and OFF.
10	FLB	I	Time constant external pin to raise the low bandwidth of the focus servo.
11	FEO	O	Focus drive output.
12	FE-	I	Inverse input for focus amplifier.
13	SRCH	I	Time constant external pin for formation of focus search waveform.
14	TGU	I	Time constant external pin for the selection of tracking high band gain.
15	TG2	I	Time constant external pin for the selection of tracking high band gain.
16	AVCC	--	Power supply
17	TAO	O	Tracking drive output.
18	TA-	I	Inverse input pin for tracking amplifier.
19	SL+	I	Non-inverse input pin for feed amplifier.
20	SLO	O	Feed drive output.
21	SL-	I	Inverse input pin for feed amplifier.
22	FSET	I	Pin to set peak frequency of focus tracking phase compensation and fo of CLV LPF.
23	ISET	I	Current is input to determine focus search, track jump, and feed kick height.
24	S STOP	I	Limit SW ON/OFF signal detection pin for disc inner periphery detection.
25	AVEE	--	-5V
26	DIRC	I	Pin for one-track jump. Contains 47kΩ pull-up resistor.
27	LOCK	I	At "L" feed runaway prevention circuit operate. Contains a 47kΩ pull-up resistor.
28	CLK	I	Serial data transfer clock input from CPU.
29	XLT	I	Latch input from CPU.
30	DATA	I	Serial data input from CPU.
31	XRST	I	Reset input pin, reset at "L".
32	C.OUT	O	Track number count signal output.
33	SENS	O	Outputs FZC, AS, TZC and S STOP through command from CPU.
34	DGND	--	GND
35	MIRR	O	MIRR comparator output pin.
36	DFCT	O	Output pin of DEFECT comparator.
37	ASY	I	Input pin of auto asymmetry control.
38	EFM	O	Output pin of EFM comparator.
39	FOK	O	Output pin of FOK comparator.
40	CC1	I	Output pin of DEFECT bottom hold.
41	CC2	O	Input pin for the capacitance coupled output of DEFECT bottom hold.
42	DVCC	--	-5V
43	CB	I	Connection pin of DEFECT bottom hold capacitor.
44	CP	I	Connecting pin of MIRR hold condenser. Non-inverted input pin of MIRR comparator.
45	RF1	I	Input pin with coupling capacitor where RF summing amplifier output is connected.
46	RFO	O	Output pin of RF summing amplifier and check point of eye pattern.
47	DVEE	--	-5V
48	TZC	I	Input pin of tracking zero-cross comparator.

## ■ CXA1571M(IC501) : RF AMP for compact disc

### 1. Outline

The CXA1571M IC for compact disc 3-point method optical pickup output has following functions.  
 ·RF amplifier      ·Focus error amp      ·Tracking error      ·APC circuit

### 2. Block Diagram

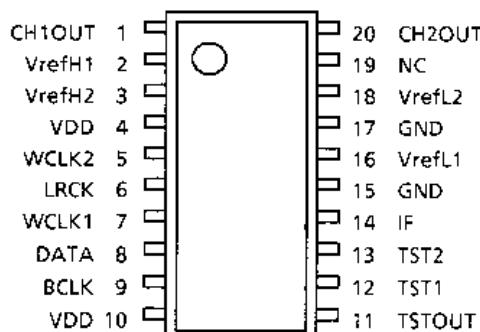


### 3. Pin Functions

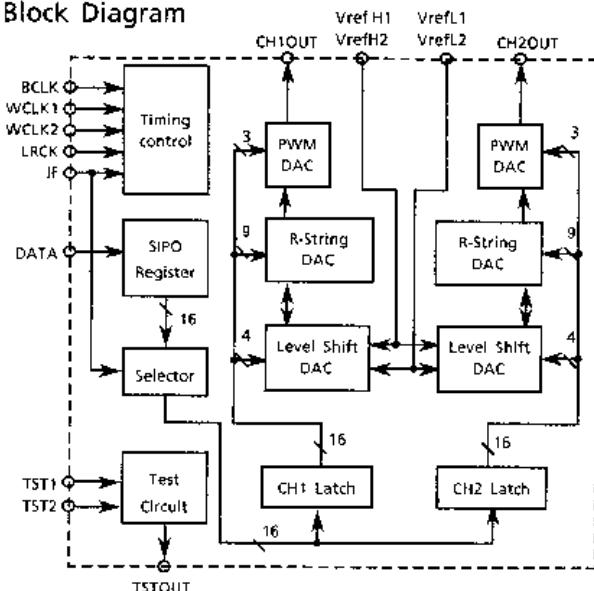
Pin No.	Symbol	I/O	Function
1	LD	O	APC amp output pin.
3	PD	I	APC amp input pin.
4	PD1	I	RF I-V amp inverted input pins; they are connected to the A + C and B + D pins of the photodiode and receive current input.
5	PD2	I	
7	F-IN	I	F and E I-V amp inverted input pin; they are connected to Photodiodes F and E and receive current input.
8	E-IN	I	
9	VR	O	(VCC + VEE) / 2 DC voltage output pin.
10	VC	I	VC intermediate voltage input pin; when dual $\pm 5V$ power supplies are used, this pin is connected to GND; for a single +5V power supply, it is connected to the VR pin.
13	EO	O	Monitor output pin for I-V amp E.
14	EI	I	Gain adjustment pin for I-V amp E.
15	TE	O	Tracking error amp output pin.
16	FE-BIAS	I	Bias adjustment pin for the mon-inverted side of the focus error amp.
17	FE	O	Focus error amp output pin.
18	RFO	O	RF amp output pin.
19	RF1	I	RF inverted side input pin; the resistor connected between this pin and the RFO pin determines the gain of the RF amp.
20	LD-ON	I	This pin switches the APC amp on / off: on for VCC, off for ground.

## ■ LC7881M (IC711) : D/A converter

## 1. Terminal Layout



## 2. Block Diagram



## 3. Pin Functions

Pin No.	Symbol	I/O	Functions
1	CH1 OUT	O	Channel 1 Output terminal (Left channel).
2	VrefH1	I	Reference voltage "High" input terminal 1.
3	VrefH2	I	Reference voltage "High" input terminal 2.
4	V <sub>DD</sub>	-	Power supply, +5V.
5	WCLK2	I	Word clock 2 input terminal. When IF is "High", it is necessary to adjust WCLK2 = "Low". When IF is "Low", it makes the CH1 data of the audio digital data by using the standing fall of WCLK2 and an internal signal which does the latch is made.
6	LRCK	I	LR clock input terminal. This terminal shows CH1 and CH2 of the input digital audio data. High : CH1 data, Low : CH2 data
7	WCLK1	I	Word clock 1 input terminal. When IF is "High", it makes the data of both CH1 and CH2 channels by using the WCLK1 standing fall and an internal signal which does the latch is made. When IF is "Low", it makes the CH2 data of the audio digital data by using the standing fall of WCLK1 and an internal signal which does the latch is made.
8	DATA	I	Digital audio data input terminal. When IF is "High", it inputs the data from the MSB side with the bit serially. When IF is "Low", it inputs the data from the LSB side with the bit serially.
9	BCLK	I	Bit clock terminal. This clock signal is used when reading the digital audio data by each bit serially, and for the PWM DAC.
10	V <sub>DD</sub>	--	Power supply, +5V.
11	TST OUT	O	Test signal output terminal. Normally leave this terminal open.
12	TST1	I	Test signal input terminal. Normally connect this terminal GND.
13	TST2	I	Test signal input terminal. Normally connect this terminal GND.
14	IF	I	Interface select terminal. When it is "High" level, Digital audio data is inputted by each bit serially from the MSB first. When it is "Low" level, Digital audio data is inputted by each bit serially from the LSB first.
15	GND	-	Ground
16	VrefL2	I	Reference voltage "Low" input terminal 1.
17	GND	-	Ground.
18	VrefL2	I	Reference voltage "Low" input terminal 2.
19	NC	-	No connection.
20	CH2 OUT	O	Channel 2 output terminal (Right channel).

■ MN35501 (IC631) : D/A converter

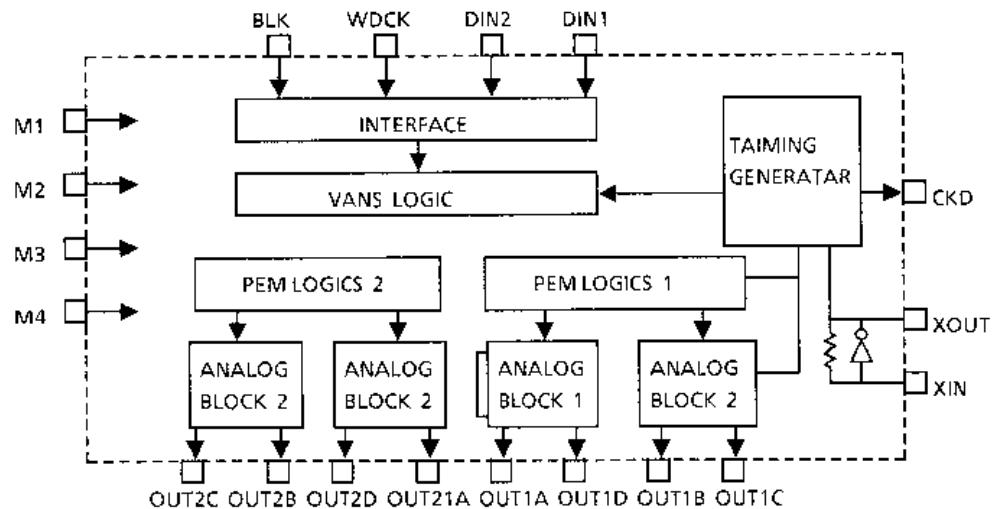
1. Terminal Layout

DIN1	1	28	RSTB
DIN2	2	27	M4
WDCK	3	26	M3
BCK	4	25	DVDD1
DVDD2	5	24	XIN
CKO	6	23	XOUT
DVSS2	7	22	DVSS1
M1	8	21	M2
OUT1C	9	20	OUT2C
OUT1B	10	19	OUT2B
AVDD1	11	18	AVDD2
OUT1D	12	17	OUT2D
OUT1A	13	16	OUT2A
AVSS1	14	15	AVSS2

2. Pin Functions

Pin No.	Symbol	I/O	Function
1,2	DIN1, DIN2	I	Serial data input
3	WDCK	I	Word clock input
4	BCK	I	Bit clock input
5	DVDD2	--	Power supply for digital circuit
6	CKO	O	Clock output
7	DVSS2	-	GND for digital circuit
8	M1	I	Input for mode select
9,10	OUT1C, OUT1B	O	PEM signal output (Channel 1)
11	AVDD1	-	Power supply for analog circuit (Channel 1)
12,13	OUT1D, OUT1A	O	PEM signal output (Channel 1)
14	AVSS1	-	GND for analog circuit (Channel 1)
15	AVSS2	-	GND for analog circuit (Channel 2)
16,17	OUT2A, OUT2D	O	PEM signal output (Channel 2)
18	AVDD2	-	Power supply for analog circuit (Channel 2)
19,20	OUT2B, OUT2C	O	PEM signal output (Channel 2)
21	M2	I	Input for mode select
22	DVSS1	-	GND for clock circuit
23,24	XOUT, XIN	-	Oscillation terminal
25	DVDD1	-	Power supply for clock circuit
26,27	M3, M4	I	Input for mode select
28	RSTB	I	Reset input (Low active)

3. Block Diagram

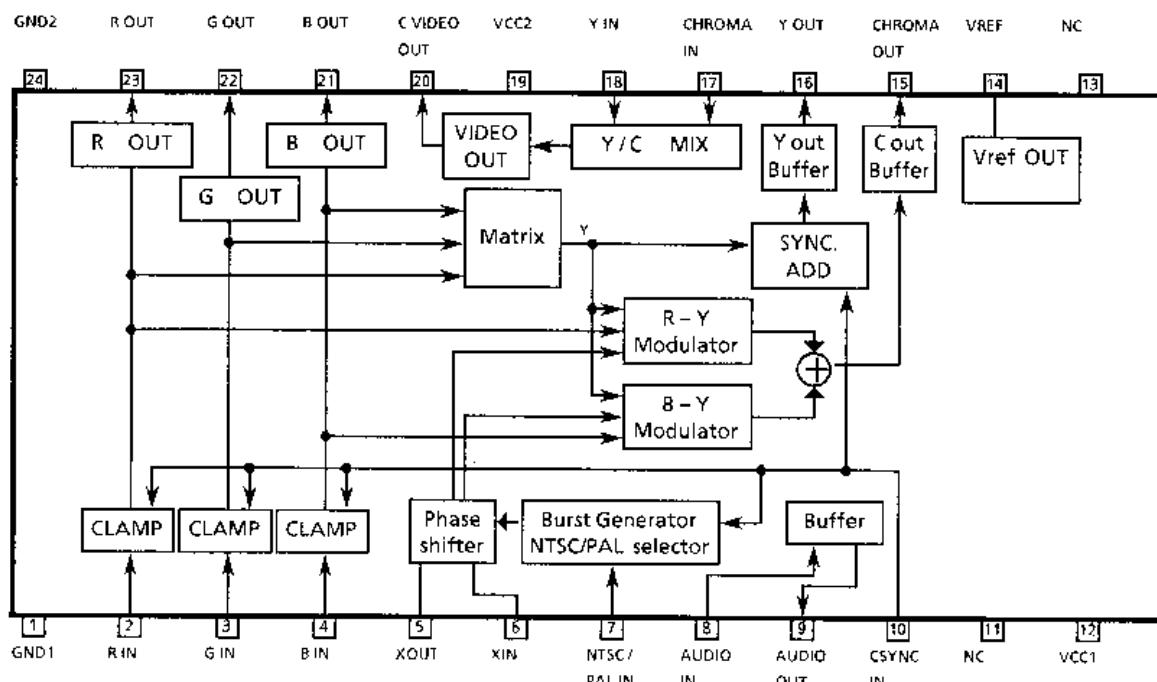


## ■ CXA1145M(IC221) : RGB Encoder

### 1. Outline

This LSI makes composite signal, chroma signal and Y-signal from Red, Green and Blue signal.

### 2. Block Diagram

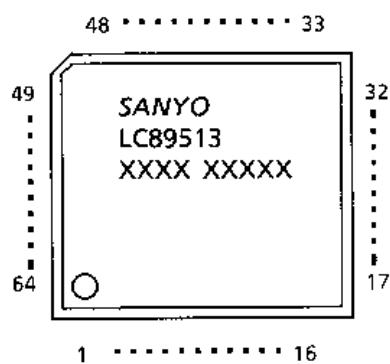


### 3. Pin Functions

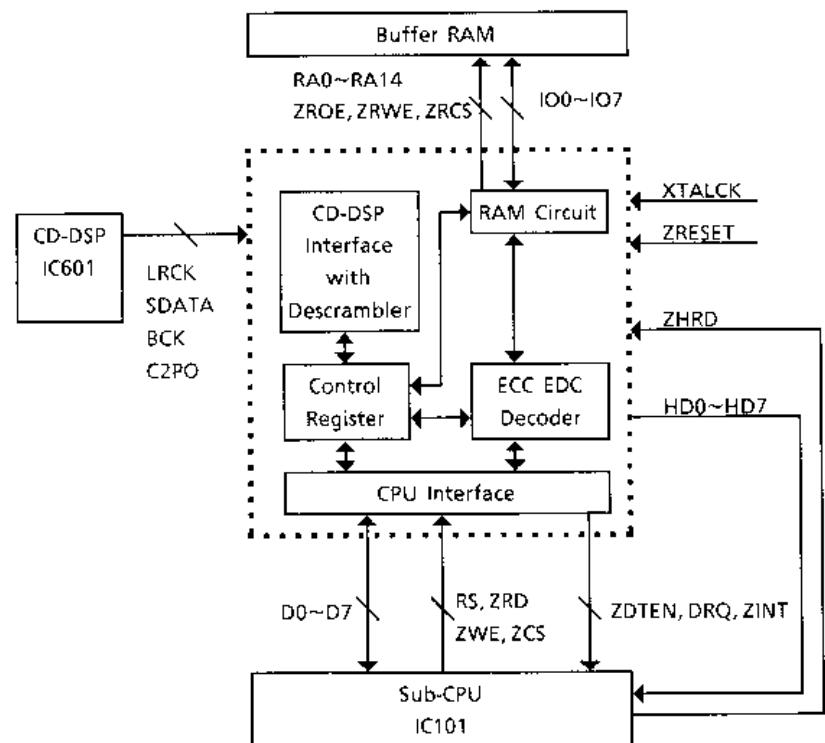
Pin No.	Symbol	I/O	Function
1	GND1	--	GND for the circuits except RGB out and composite out circuits. (Except for load driver)
2	R IN	I	Red signal input
3	G IN	I	Green signal input
4	B IN	I	Blue signal input
5	XOUT	--	A capacitor is connected to shift phase
6	XIN	I	Sub carrier input
7	NTSC/PAL IN	I	(Vcc:NTSC,GND:PAL)
8	AUDIO IN	I	Input terminal of internal audio buffer. (Non connection)
9	AUDIO OUT	O	Output terminal of internal audio buffer. (Non connection)
10	CSYNC IN	I	Composite synchronizing signal is inputted.
11	NC	--	Non connection
12	VCC1	--	Power supply (Except for load driver)
13	NC	--	Non connection
14	VREF	--	Reference voltage is applied.
15	CHROMA OUT	O	Chroma signal is outputted.
16	Y OUT	O	Y signal is outputted.
17	CHROMA IN	I	Chroma signal is inputted.
18	Y IN	I	Y signal is inputted.
19	VCC2	--	Power supply (For load driver)
20	VIDEO OUT	O	Composite signal out
21	B OUT	O	Analog blue signal out. (Non connection)
22	G OUT	O	Analog green signal out. (Non connection)
23	R OUT	O	Analog red signal out. (Non connection)
24	GND2	--	GND (For load driver)

## ■ LC89513 (IC161) : Data decoder for CD-ROM

### 1. Terminal Layout



### 2. Block Diagram



### 3. Pin Functions

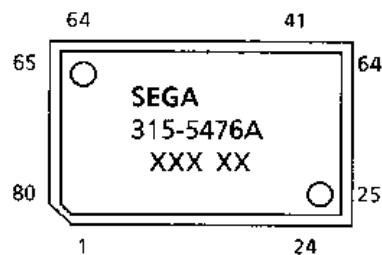
Pin No.	Symbol	I/O	Function
1, 9, 17, 33, 49	VSS	--	GND
24, 56	VDD	--	Power suply
2~8, 10~16 18	RA0~RA14	O	Address bus. These are used to select the specified address of the external memory (Data buffer RAM).
19	RCE	O	Chip select signal. This signal is asserted when using external RAM.
20	RWE	O	Write enable signal. This signal is outputted when writing data on the external RAM.
21	ROE	O	Output enable signal. This signal is outputted when reading data on the external RAM.
22	RESET	I	The RESET input pin is an active-low line.
23	XTALCK	I	Clock input terminal for internal clock.
25	C2PO	I	C2 error flag occurred on the CIRC decoding of digital data at CXD2500BQ is inputted. This data is latched with the timing signal made from BCK and LRCK.
26	BCK	1	Bit clock. This clock is used to input data.
27	SDATA	I	Serial data input terminal. The data is stored into the external RAM.
28	LRCK	I	This signal is used to distinguish that data is right or left.
29	RS	I	Register select signal. H : Register L : Address register
30	RD	I	This signal is inputted when data on a register is read by sub-CPU.
31	WR	I	This signal is inputted when data is written on a register by sub-CPU.
32	CS	I	Chip select signal. This IC is selected with this signal by sub-CPU.
34~41	D0~D7	I/O	Data bus. These are used to transfer data.
42	GSRAM	I	
43	INT	O	Interrupt request signal. This signal is outputted when LC89513 requests interrupt process to sub-CPU.
44	DRQ	O	Data request signal. This signal is asserted when reading data from sub-CPU.
45~48, 50~53	HD0~HD7	O	Data bus. Sub-CPU reads data from these terminals.
54	HRD	I	This signal is inputted when sub-CPU read data.
55	DTEN	O	Data enable. Sub-CPU can read data when this terminal is low level.
57~64	IO0~IO7	I/O	Data bus. These are used to transfer data between external RAM and LC89513.

## ■ 315-5476A (IC131) : PCM sound generator

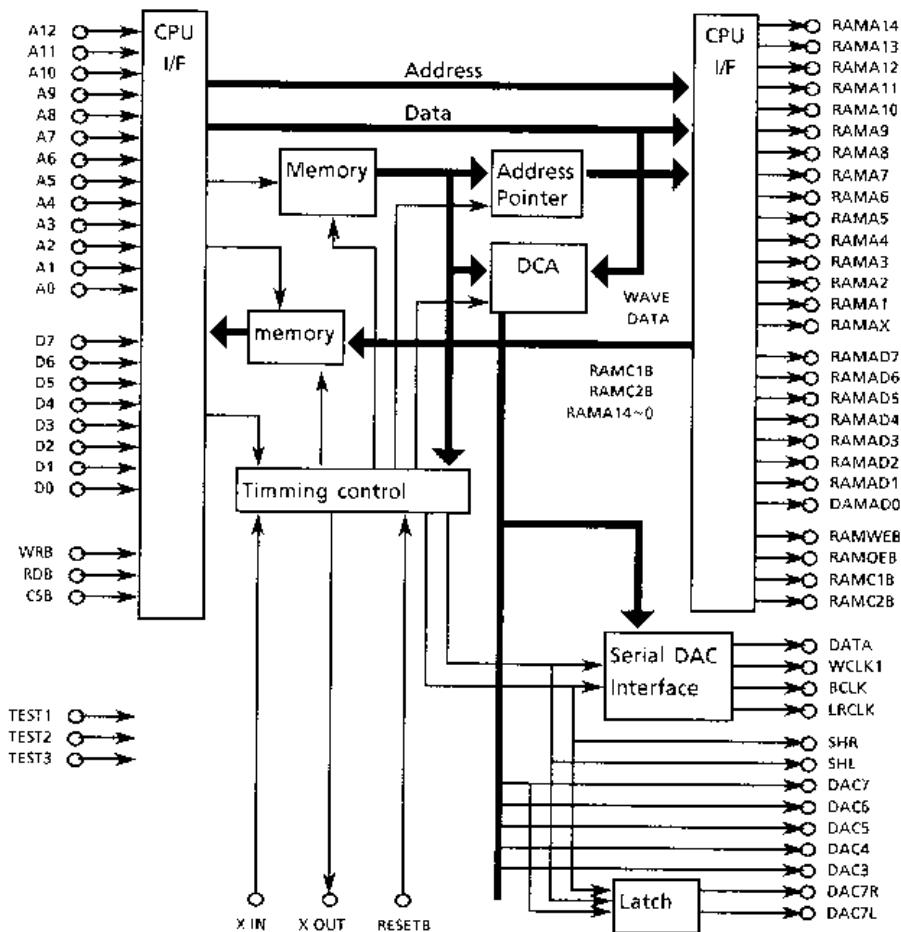
### 1. Outline

This IC is for PCM sound generator system, including DCO (Digital control oscillator) and DCAs (Digital control amplifier). PCM sound generator system can be composed by connecting external memory for wave data and D/A converter. This system is controlled by sub-CPU.

### 2. Terminal Layout



### 3. Block Diagram

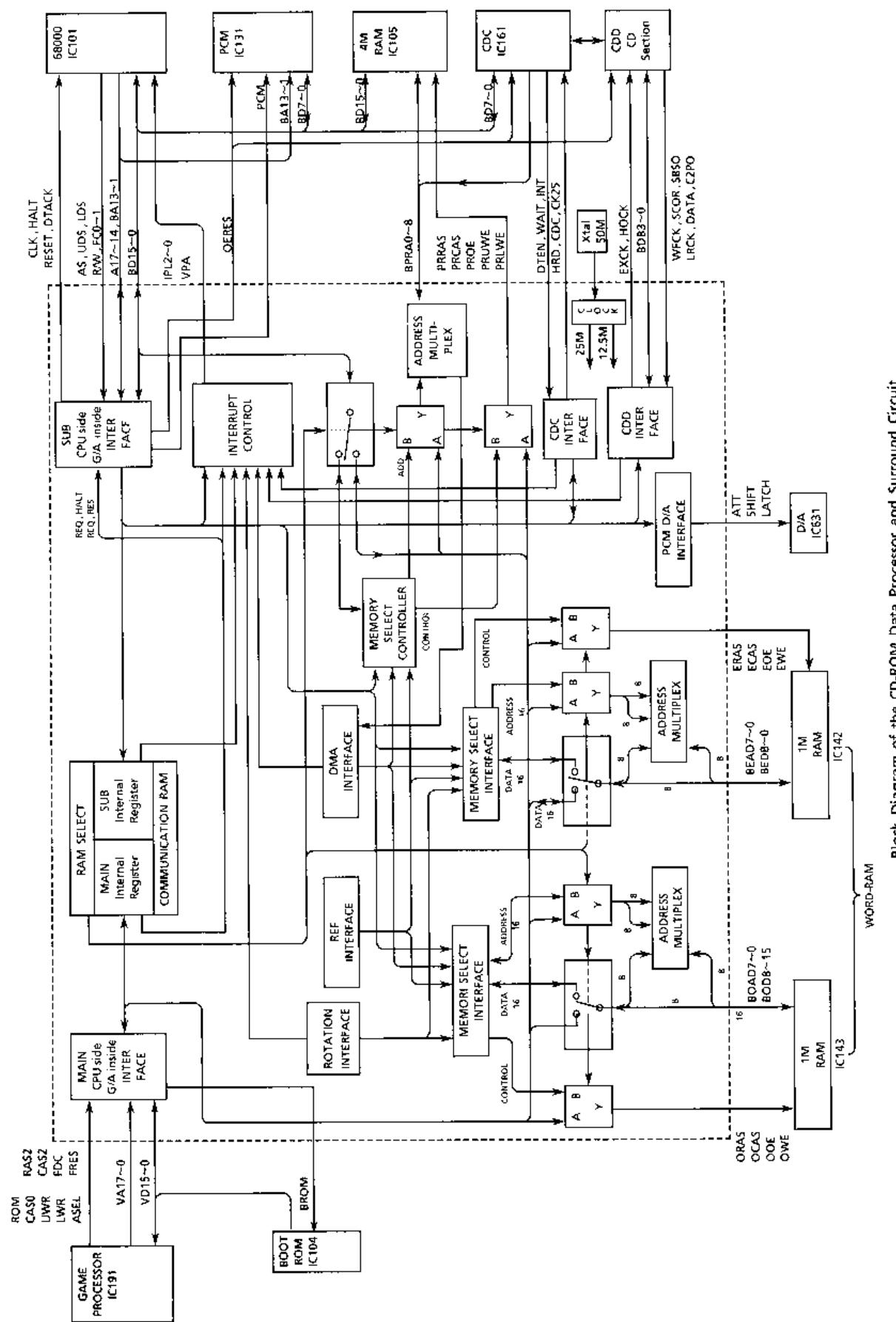


### 4. Pin Functions

Pin No.	Symbol	I/O	Function
1~10, 80~78	A0~A12	I	Address bus. These are used to specify the memory.
13	RD	I	This signal is used to be read data by an external device.
14	WR	I	This signal is used to be written data by an external device.
28~21	D0~D7	I/O	These are used to transfer data.
35	BCLK	O	Bit clock. This is used to transfer data to D/A converter.
36	DATA	O	Serial data to D/A converter.
40	LRCK	O	L/R clock. This is used to distinguish that DATA is left channel or right channel.
44~51	RAMAD7~RAMAD0	I/O	Data bus. These are used to transfer data between external RAMs and this IC.
53~59, 65~68 73~76	RAMA14~RAMA8 RAMA7~RAMA0	O	RAMA14~RAMA8 are used to address upper 8 bits of external memory. RAMA7~RAMA0 are used to address lower 8 bits of external memory.
60	RCS1	O	Chip select signal. This is used to select the external memory for lower data.
61	RCS2	O	Chip select signal. This is used to select the external memory for upper data.
62	ROE	O	This is outputted when reading data from the external memory.
63	RWE	O	This is outputted when writing data into the external memory.
64	RES	I	Reset signal input.
70	XIN	I	System clock input.
77	CS	I	Chip select signal.

■ 315-5632V (IC141) : Data Processor

This IC does the circuit role of the CPU in the surrounding and takes the data and sub-code and controls the memory in addition.



Block Diagram of the CD-ROM Data Processor and Surround Circuit

## Pin Functions

### Connect to the CD drive

Pin No.	Symbol	I/O	Function
70, 73	WFCK, SBSO	I	Signal input from CD drive (CXD2500BQ) when sub-code is received.
71	SCOR	I	Signal input from CXD2500BQ (IC601) through the mechanism controller when sub-code is received.
75, 76	LRCK, SDATA	I	Data input from CXD2500BQ
77	C2PO	--	Non connection
87 (L : VOICE H : ROM)	D/M	I	The input data is the voice data or ROM data is shown. When the input level is "High", C2PO input signal outputs to C2LR (pin98). When it is "Low", LRCK input signal outputs to C2LR.
86	IRQ	I	Interrupt request signal from IC691
88	CDCK	I	Clock in from communicate with IC691
83	HOCK	O	Clock out to communicate with IC691
82, 81 80, 78	DB0, DB1 DB2, DB3	I/O	Communication data with IC691
74	EXCK	O	Clock out to CXD2500BQ

### Connect to the Game Processor

Pin No.	Symbol	I/O	Function
5	ROM	I	When the main-CPU accesses the address \$0 to \$3FFFF, signal is input.
6	CAS0	I	When the main-CPU is read mode, signal is input.
8, 7	UWR, LWR	I	When the main-CPU is write mode, signal is input.
11, 9, 12	RAS2, ASEL, CAS2	I	When the MAIN-CPU accesses the D-RAM (IC172), signal is inputs. (RAS2→ASEL→CAS2)
13	FDC	I	When internal register has the access from the outside, signal is input.
14	FRES	I	Power on reset signal
171~190	VA1~17	I	Address bus from main - CPU (IC171)
191~208	VD0~15	I/O	Data bus to main - CPU (IC171)

### Connect to the D/A Converter

Pin No.	Symbol	I/O	Function
66	LATCH	O	Mode set latch enable
67	SHIFT	O	Mode set clock
68	ATT	O	Set up the digital attenuater and mode flag register
69	DTM	O	Audio data output

Pin No.	Symbol	I/O	Function
137~141, 143~146, 148~153, 155	D0~D15	I/O	Data bus for sub CPU, sub CPU (IC101), PROGRAM RAM (IC105) : D0~D15 Data decoder (IC161), PCM sound LSI (IC131), backup RAM (IC102) : D0~D7
99~106, 108~113, 115~118, 120	A19~A1	O	Address bus for sub - CPU (IC101) sub CPU (IC101) : A1~A19 backup RAM (IC102), PCM sound LSI (IC131) : A1~A13
45~49, 51~53 / 17~24 54~59, 62, 63 / 25, 28~34	OAD0~7 / EAD0~7 OD8~15 / ED8~15	I/O	Address / data bus for IC142, 143. Data bus to IC142, 143.
40 / 35	ORAS, ERAS	O	Row address strobe for IC142, 143.
41 / 36	OCAS, ECAS	O	Column address strobe for IC142, 143.
42 / 37	OOE, EOE	O	Output enable for IC142, 143.
44 / 39	OWE, EWE	O	Write enable for IC142, 143.
156~163, 166	PA0~PA8	O	Address bus for data decoder (IC161) and sub - CPU program RAM (IC105)

Pin No.	Symbol	I/O	Function
2	BRAM	O	Chip select signal for backup RAM (IC102 pin20)
4	BROM	O	Chip select signal for boot ROM (IC104 pin10)
167	PRAS	O	Row address strobe signal for program RAM (IC105 pin14)
168	PCAS	O	Column address strobe signal for program RAM (IC105 pin28)
89	PCM	O	Chip select signal for PCM sound controller (IC131 pin77)
94	CDC	O	Chip select signal for data decoder (IC161 pin32)
95	COE	O	Output enable signal for backup RAM (IC102 pin22), program RAM (IC105 pin27). This signal is outputted for PCM sound LSI (IC131 pin13) and data decoder (IC161 pin30) when data on a register is read.
169	CUWE	O	This signal is outputted for program RAM (IC105 pin13) when writing upper bits of data.
170	CLWE	O	This signal is outputted for backup RAM (IC102 pin27).
93	INT	O	Interrupt request signal for data decoder (IC161 pin43).
92	HRD	O	Sub CPU read data signal for data decoder (IC161 pin54).
91	WAIT	O	Data request signal for data decoder (IC161 pin44).
90	DTEN	O	Data enable signal for data decoder (IC161 pin55).
98	C2LR	O	For data decoder (IC161 pin25).
16	ERES	O	Reset signal for data decoder (IC161 pin22), mechanism controller (IC691 pin14) and PCM sound controller (IC131 pin64).
1	25M	O	Clock signal for data decoder (IC161 pin23).
136	AS	I	Address strobe signal from sub CPU (IC101 pin6).
133	R/W	I	Read/write signal from sub CPU (IC101 pin9).
135	UDS	I	Upper data strobe signal from sub CPU (IC101 pin7).
134	LDS	I	Lower data strobe signal from sub CPU (IC101 pin8).
132	DTAK	O	Data transfer acknowledge signal for sub CPU (IC101 pin10).
123	IPL0	O	Interrupt control signal for sub CPU (IC101 pin 27).
124	IPL1	O	Interrupt control signal for sub CPU (IC101 pin 26).
125	IPL2	O	Interrupt control signal for sub CPU (IC101 pin 25).
126	VPA	O	Valid peripheral address signal for sub CPU (IC101 pin23).
121	FC0	I	Processor status signal from sub CPU (IC101 pin30).
122	FC1	I	Processor status signal from sub CPU (IC101 pin29).
128	HALT	O	Halt signal for sub CPU (IC101 pin19).
127	RESET	O	Reset signal for sub CPU (IC101 pin20).
129	12M	O	Clock signal for sub CPU (IC101 pin 15) and PCM sound controller (IC131 pin70).
84	50M	I	Master clock input.
64	LEDR	O	LED indication signal.
65	LEDG	O	LED indication signal.

## ■ TC511664BJ-10 (IC142,143) : D RAM (Word RAM for Data Processor)

Terminal Layout

VCC	1	40
I/O1	2	39
I/O2	3	38
I/O3	4	37
I/O4	5	36
I/O5	6	35
I/O6	7	34
I/O7	8	33
I/O8	9	32
NC	10	31
VCC	11	30
UW	12	29
LW	13	28
RAS	14	27
A0	15	26
A1	16	25
A2	17	24
A3	18	23
A4	19	22
VCC	20	21

Pin Functions

Pin No.	Symbol	I/O	Function
1, 11, 20	VCC	-	Power supply
21, 30, 40	VSS	-	GND
2~9	I/O1~I/O8	I/O	Data input/output bus.
32~39	I/O9~I/O16		
15~19	A0~A4	I	Address bus input.
22~24	A5~A7		
12	UW	I	This signal is inputted when writing upper bytes of data.
13	LW	I	This signal is inputted when writing lower bytes of data.
14	RAS	I	Row address strobe signal input.
28	OE	I	Output enable signal input
29	CAS	I	Column address strobe signal input.

## ■ TC531024F (IC104) : Mask ROM (BOOT ROM for main-CPU)

Terminal Layout

NC	1	40
CE	2	39
D15	3	38
D14	4	37
D13	5	36
D12	6	35
D11	7	34
D10	8	33
D9	9	32
D8	10	31
GND	11	30
D7	12	29
D6	13	28
D5	14	27
D4	15	26
D3	16	25
D2	17	24
D1	18	23
D0	19	22
OE	20	21

Pin Functions

Pin No.	Symbol	I/O	Function
40	VDD	-	Power supply
11, 30	GND	-	GND
3~10	D15~D8	O	Data output
12~19	D7~D0		
37~31	A15~A9	I	Address bus input.
29~21	A8~A0		
2	CE	I	Chip enable signal input.
20	OE	I	Output enable signal input.
1, 38, 39	NC	--	Non connection

## ■ LC33832M-70X (IC162) : Pseudo static RAM (Cache RAM for CD-ROM Data Decoder)

Terminal Layout

A14	1	28
A12	2	27
A7	3	26
A6	4	25
A5	5	24
A4	6	23
A3	7	22
A2	8	21
A1	9	20
A0	10	19
I/O1	11	18
I/O2	12	17
I/O3	13	16
GND	14	15

Pin Functions

Pin No.	Symbol	I/O	Function
28	VDD	-	Power supply
14	GND	-	GND
11~13,	I/O1~I/O3,	I/O	Data input/output
15~19	I/O4~I/O8		
1~10, 21,	A0~A14	I	Address bus input.
23~26			
20	CE	I	Chip enable signal input.
22	OE/RFSH	I	Output enable/refresh input.
27	R/W	I	Read/write signal input.

■ MN414270SJ-08 (IC105) : D RAM ( Program RAM for sub-CPU )

Terminal Layout

	Pin No.	Symbol	Function
VCC	1	40	VSS
DQ0	2	39	DQ15
DQ1	3	38	DQ14
DQ2	4	37	DQ13
DQ3	5	36	DQ12
VCC	6	35	VSS
DQ4	7	34	DQ11
DQ5	8	33	DQ10
DQ6	9	32	DQ9
DQ7	10	31	DQ8
NC	11	30	NC
LWE	12	29	NC
UWE	13	28	CAS
RAS	14	27	OE
NC	15	26	A8
A0	16	25	A7
A1	17	24	A6
A2	18	23	A5
A3	19	22	A4
VCC	20	21	VSS

Pin Functions

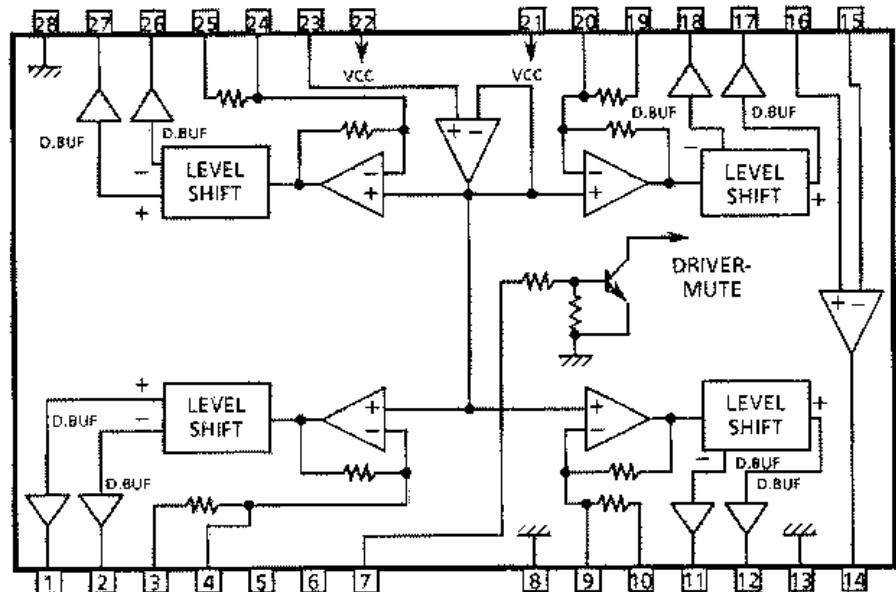
Pin No.	Symbol	I/O	Function
1, 6, 20	VCC	-	Power supply
21, 35, 40	VSS	-	GND
2~5, 7~10, 31~34, 36~39	DQ0 ~DQ15	I/O	Data input/output bus.
16~19 22~26	A0 ~A8	I	Address bus input
12	LWE	I	This signal is inputted when writing lower bytes of data.
13	UWE	I	This signal is inputted when writing upper bytes of data.
14	RAS	I	Row address strobe signal input.
27	OE	I	Output enable signal input.
28	CAS	I	Column address strobe signal input.

■ BA6393FP(IC503) : BTL DRiver

1. Terminal Layout

CH1-OUT A	1	28	GND
CH1-OUT B	2	27	CH4-OUT A
CH1-IN A	3	26	CH4-OUT B
CH1-IN B	4	25	CH4-IN A
NC	5	24	CH4-IN B
NC	6	23	BIAS IN
MUTE	7	22	VCC
GND	8	21	VCC
CH2-IN B	9	20	CH3-IN B
CH2-IN A	10	19	CH3-IN A
CH2-OUT B	11	18	CH3-OUT B
CH2-OUT A	12	17	CH3-OUT A
GND	13	16	OP IN +
OP OUT	14	15	OP IN -

2. Block Diagram



3. Description

Pin No.	Symbol	I/O	Description
1	CH1-OUTA	O	Focus drive output
2	CH1-OUTB	O	Focus drive output
3	CH1-IN A	I	Focus drive input
4	CH1-IN B	-	
5,6	NC	-	
10	CH2-IN A	-	Non connection
19	CH3-IN A	-	
24	CH4-IN B	-	
7	MUTE	I	Mute signal input pin
9	CH2-IN B	I	Spindle motor drive input
20	CH3-IN B	I	Feed motor drive input
25	CH4-IN A	I	Tracking drive input

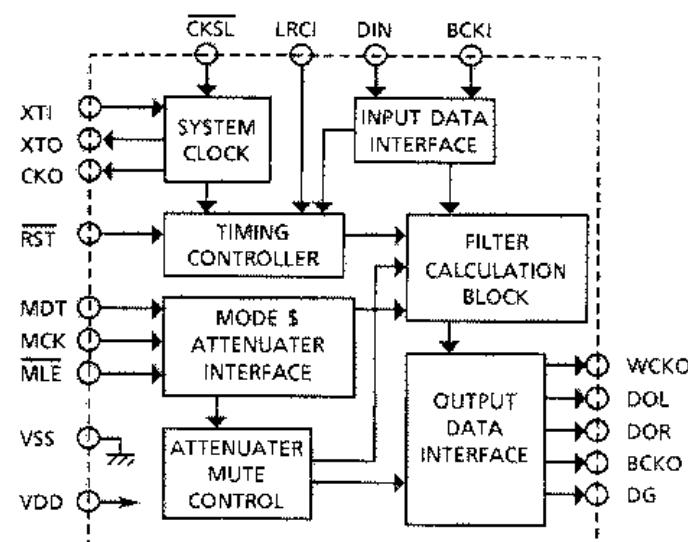
Pin No.	Symbol	I/O	Description
8,13,28	GND	-	GND
11	CH2-OUT B	O	Spindle motor drive output
12	CH2-OUT A	O	Spindle motor drive output
14	OP OUT	O	OP amp output
15,16	OP IN	I	OP amp input
17	CH3-OUT A	O	Feed motor drive output
18	CH3-OUT B	O	Feed motor drive output
21,22	Vcc	-	Power supply
23	BIAS IN	I	Input pin of Bias
26	CH4-OUT B	O	
27	CH4-OUT A	O	Tracking drive output

## ■ SM5841AS-ET (IC661) : Digital Filter

## 1. Terminal Layout

CKSL	1	
XTI	2	
XTO	3	
CKO	4	
VSS	5	
NC	6	
NC	7	
MDT	8	
MCK	9	
MLE	10	
RST	11	

## 2. Block Diagram



## 3. Pin Functions

Pin No.	Symbol	IO	Function
1	CKSL	I	Oscillation and input frequency select terminal CKSL = High ... > 384fs CKSL = Low ... > 256fs
2	XTI	-	Oscillator input
3	XTO	-	Oscillator output
4	CKO	O	Oscillator clock
5	VSS	-	GND
6	NC	-	Non connection
7	NC	-	Non connection
8	MDT	I	Mode set data (The digital attenuator and the mode flag register are set.)
9	MCK	I	Mode set clock
10	MLE	I	Mode set latch enable
11	RST	I	System clock (Initialize)
12	DG	O	When the 8fsLR parallel output mode, this signal is deglitch output. When the 4fsLR alternate output mode, this signal is deglitch output.
13	DOR	O	When the 8fsLR parallel output mode, this signal is right channel data output. When the 4fsLR alternate output mode, this signal is LR clock signal output.
14	DOL	O	When the 8fsLR parallel output mode, this signal is left channel data output. When the 4fsLR alternate output mode, this signal is left / right channel data output.
15	WCKO	O	Output word clock
16	VDD	--	Power supply
17	NC	--	Non connection
18	NC	--	Non connection
19	BCKO	O	Output bit clock
20	LRCI	I	Sample rate (fs) clock for input data
21	BCKI	I	Output bit clock
22	DIN	I	Input data

■ TC51864FL-10 (IC132) : Psevdo Static RAM ( 65,536word × 8bit ) ( PCM wave-form RAM )

Terminal Layout

RFSH	1	32
NC	2	31
A14	3	30
A12	4	29
A7	5	28
A6	6	27
A5	7	26
A4	8	25
A3	9	24
A2	10	23
A1	11	22
A0	12	21
D0	13	20
D1	14	19
D2	15	18
GND	16	17

Pin Functions

Pin No.	Symbol	I/O	Function
32	VCC	--	Power Supply
16	GND	--	GND
13~15, 17~21	D0~D2, D3~D7	I/O	Data Input/Output
3~12, 23, 25~28,31	A0~A15	I	Address Input
22	CE	I	Chip Enable
24	OE	I	Output Enable
1	RFSH	I	Refresh Input
29	R/W	I	Read/write Signal Input

## Disassembly Procedures

### ■ Top cover

1. Take off 6 screws Ⓐ on the bottom. (See fig.1)
2. Remove the top cover.

### ■ Holder L (Fig.3)

1. The spring is hung to part Ⓛ.
2. Take off 2 screws Ⓜ.
3. Open the CD door.
4. Remove the Holder L.

### ■ CD door

1. Remove the Holder L and Holder R.
2. Open the CD door.
3. One of the arm is removed pushing the part shown by the arrow Ⓝ.
4. The other arm is removed.

### ■ Main P.C.Board

1. Remove each connector from J801, J802 and J803.
2. Take off 5 screws Ⓞ securing the main PCB.
3. Remove the main PCB.

### ■ CD mechanism assembly

1. Take off a screw Ⓟ securing the CD mechanism assembly.
2. Remove each wire from J501 and J502.
3. Remove the CD mechanism assembly from the insulator.

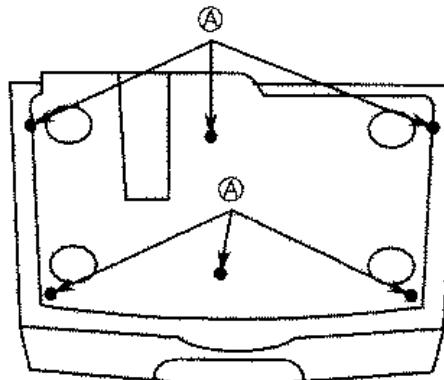


Fig.1 Bottom view

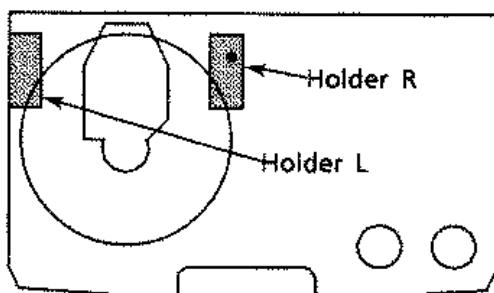


Fig.2 Top cover back view

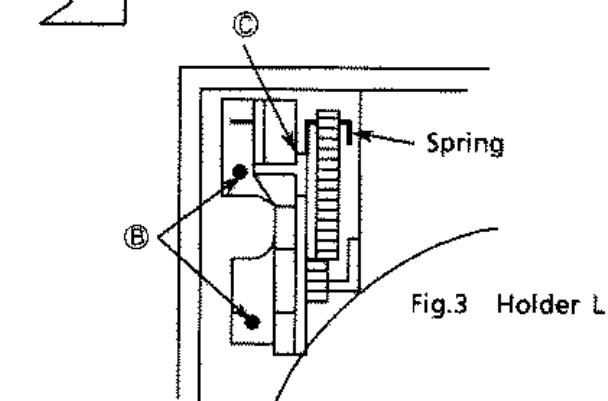


Fig.3 Holder L

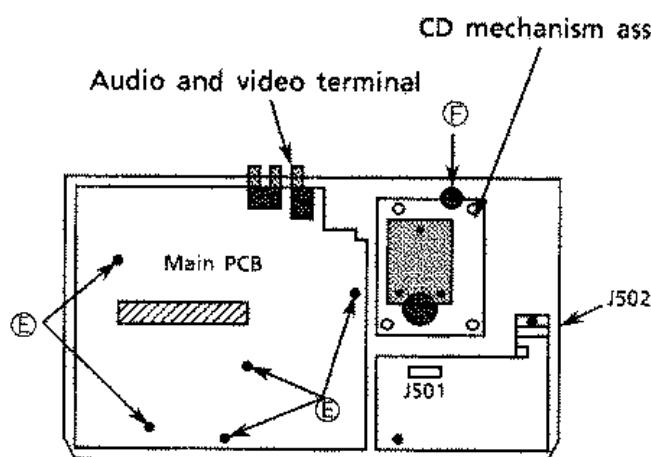


Fig.5 RG-M10BU inside view

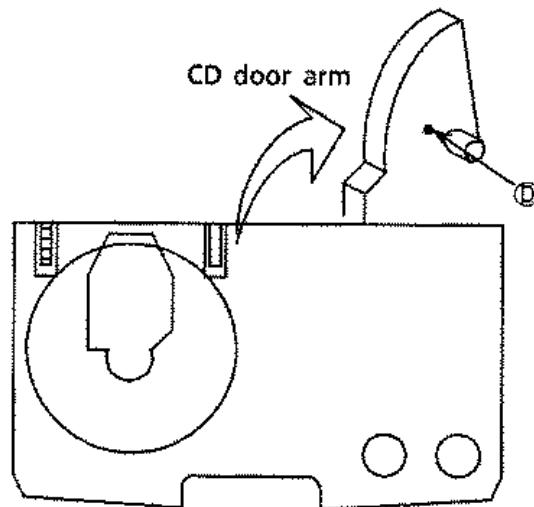


Fig.4 Top cover back view

## ■ Clamp ass'y

- The clamp is drawn in the direction of A as shown in figure 6 and the clamp removes from the lower side. (Power is somewhat necessary.)

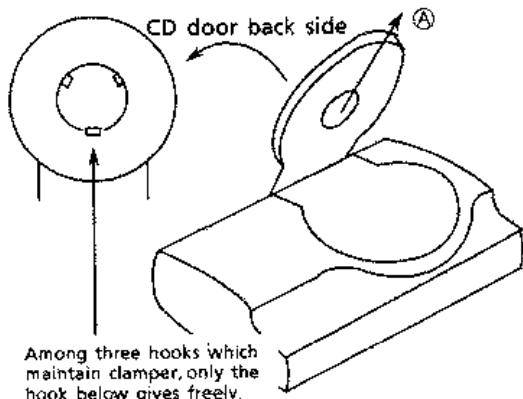


Fig.6

## ■ Pickup

- Remove the top cover.
- Remove the cover on the pickup (Fig.7).
- Release the shaft to remove the pickup.
- Remove the wire on the pickup.

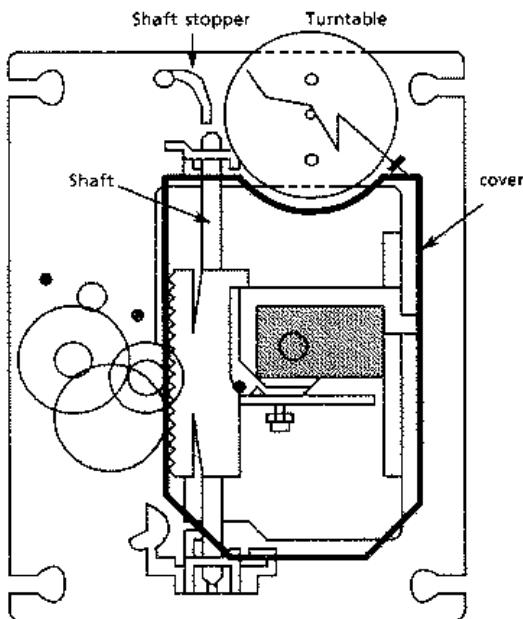


Fig.7 CD mechanism assembly

## ■ Spindle motor

- Remove the CD mechanism assembly.
- Remove the turntable, and remove the two screws retaining the spindle motor.
- Remove the screws retaining the spindle and feed motor P.C. Board and unsolder it.

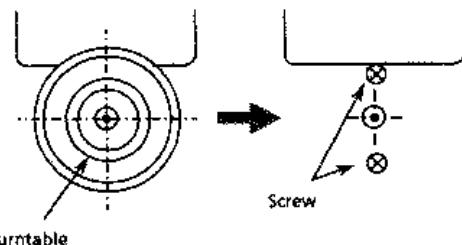


Fig.8

## ■ Spindle motor installation

- Tighten the 2 screws to the same torque.
- Fasten the spindle and feed motor P.C. board with the screw and solder.
- Install the turntable. When installing, press straight down at the center of the turntable until the distance from the surface of the mechanism base to the turntable is exactly  $19.4 \pm 0.1\text{mm}$ .

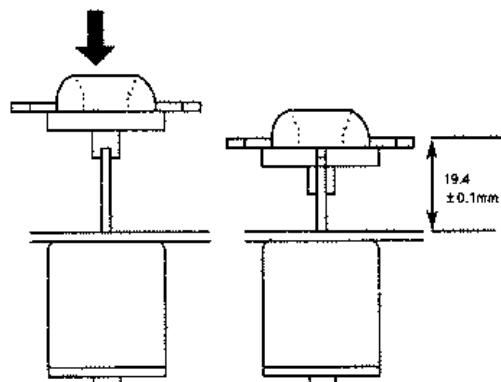


Fig.9

- After inserting the turntable, bond the motor shaft and turntable together (at the section marked by an arrow in fig. 10 on the left below).

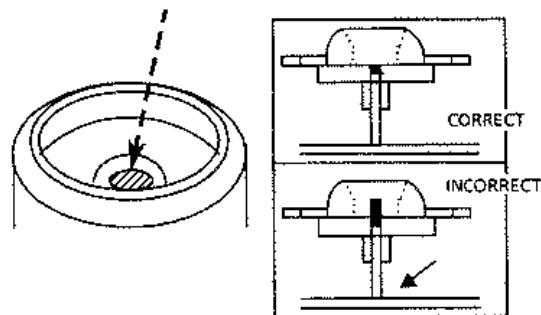


Fig.10

- Use "LOCKTITE" #460 bonding agent, and apply as little as possible. Take care not to allow any excess bonding agent to get onto the turntable. Be extremely careful not to allow bonding agent to adhere to the motor bearings (the section marked by an arrow in fig. 10 on the right).

## Adjustment Procedures

### ■ Before the adjustment

The initial screen (that is a comment "Put a disc on the turntable") is displayed when the power supply is turned on without a disc.

The screen shifts to the control screen after reading a disc if a disc is set and the door close detection switch is pressed. The disc keeps rotating for approximately 1 minute after shifting to the control screen. Press the playback and then the stop button if you want to stop the rotation.

With a disc on the turntable, the screen shifts to the control screen quickly after reading a TOC when the power supply is turned on. (The initial screen is displayed while TOC is being read.)

### ■ Adjustment measure

Oscilloscope , Test disc(CRG-1117)

### ■ Procedures

#### 1) FE ( focus error ) bias ( CD stop mode )

- ① Connect an oscilloscope between TP501 pin2 (FE) and TP501 pin9 (GND).
- ② Adjust R508 so that the DC voltage of the focus error signal becomes  $0 \pm 10\text{mV}$ .

#### 2) EF balance

- ① Connect TP501 pin6 (TEST) with TP501pin7 (GND).
- ② Connect a oscilloscope between TP501 pin4 (TE) and TP501 pin8 (VC) and play the test disc.
- ③ Adjust R510 so that the center voltage of the waveform becomes  $0 \pm 0.05\text{V}$ .

#### 3) Gain adjustment

If the gain is out of adjustment, the symptoms below will appear.

##### ● Gain too low

Focus gain : Focus is not obtained and disc does not rotate.

Tracking gain : Mechanical shock occurs easily and sound is interrupted. Or time counter display stops counting.

##### ● Gain too high

Focus gain : Scratches (on the disc) easily interrupt play, and noise is increased during play.

Tracking gain : Since the follow-up ability of the pickup is too high, the pickup may oscillate and oscillating sound may output.

As described above, the focus and tracking gain adjustment are performed to satisfy mutually contradictory characteristics.

A simplified adjustment procedure is described below. However, since exact adjustment can not be performed prior to adjustments, note(or mark) the positions of the semi-fixed resistors.

If the positions after the adjustment are only different, return the VRs to their original position.

#### Focus gain adjustment

1. Connect an oscilloscope to TP 501 pin(FE) and TP 501 pin8 ( VC ).
2. Load the test disc and press the PLAY button.
3. Adjust R522 (F.GAIN ADJ.) so that the correct waveform as shown in figure 1 is obtain.

Focus Gain Adjustment

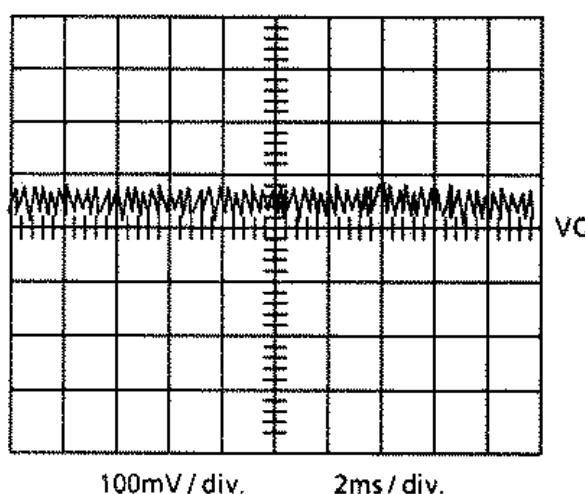


Fig. 1

**Tracking gain adjustment**

1. Connect an oscilloscope to TP 501 pin4(TE) and TP 501 pin8 (VC).
2. Load the test disc and press the PLAY button.
3. Adjust R524 (T.GAIN ADJ.) so that the correct waveform as shown in figure 2 is obtain.

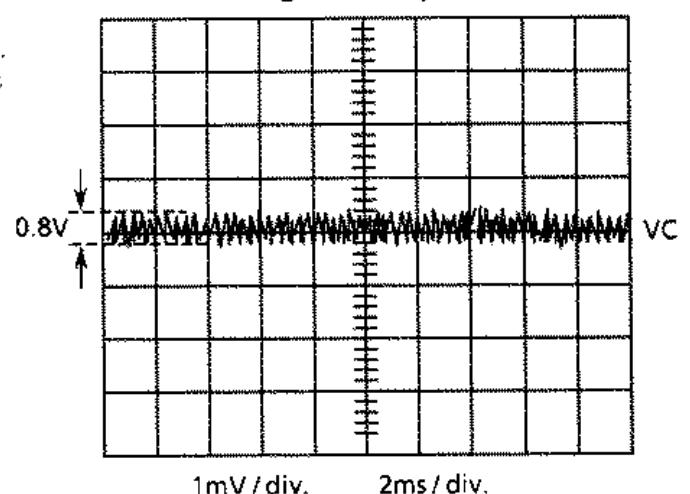
**Tracking Gain Adjustment**

Fig. 2

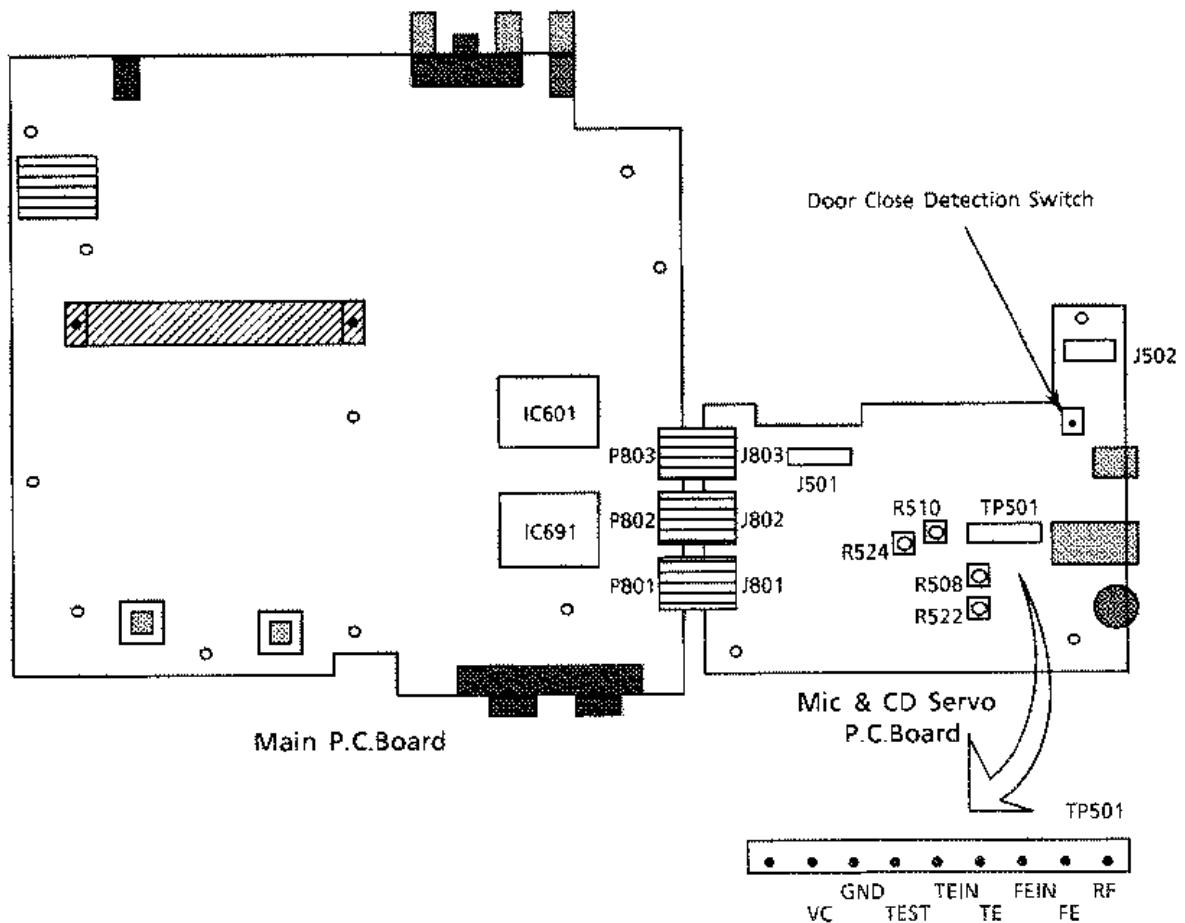
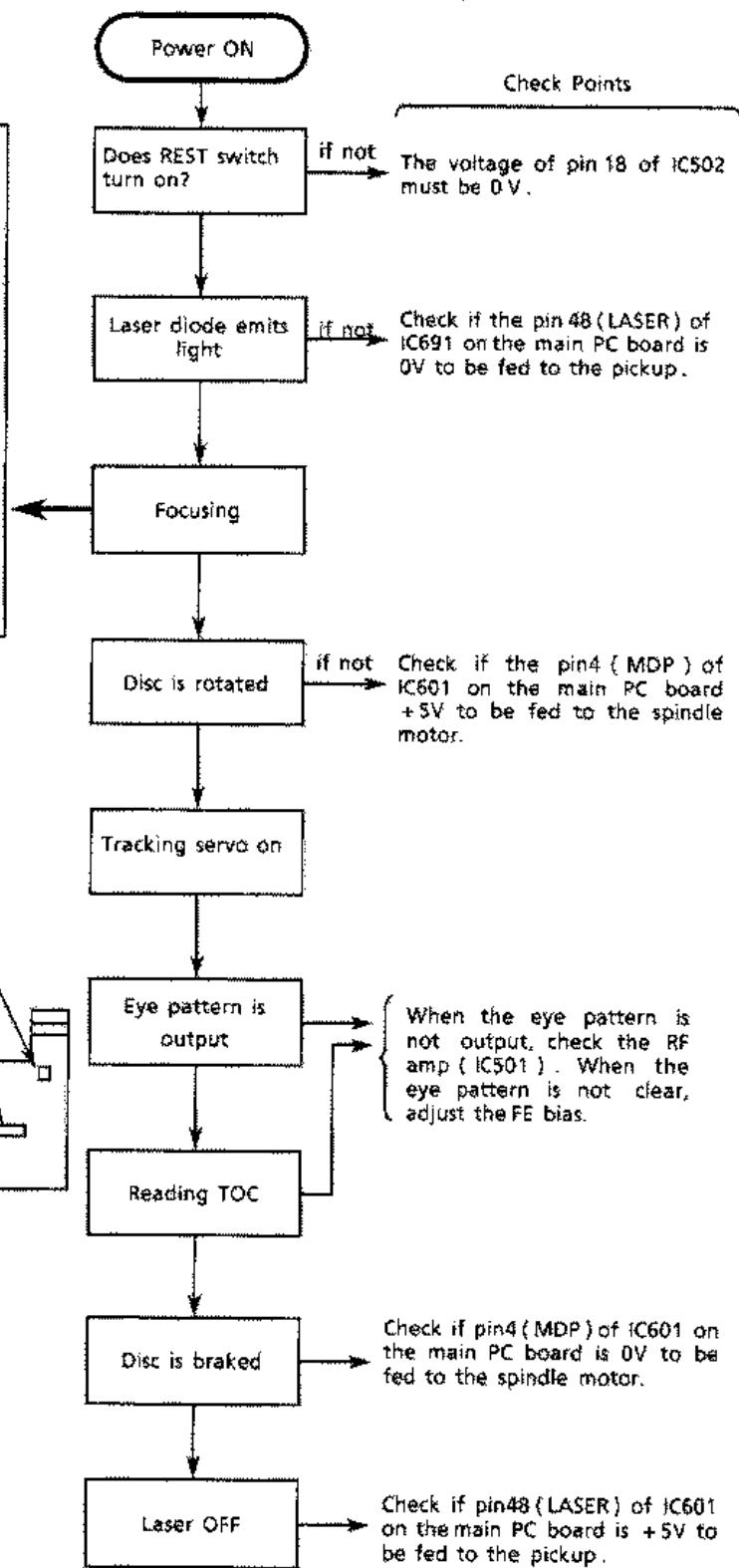
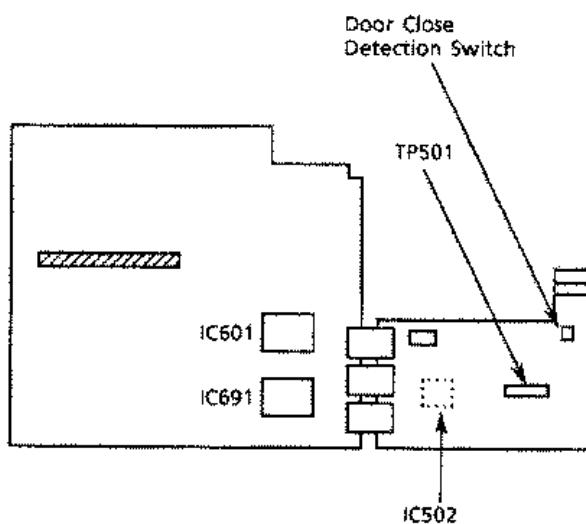
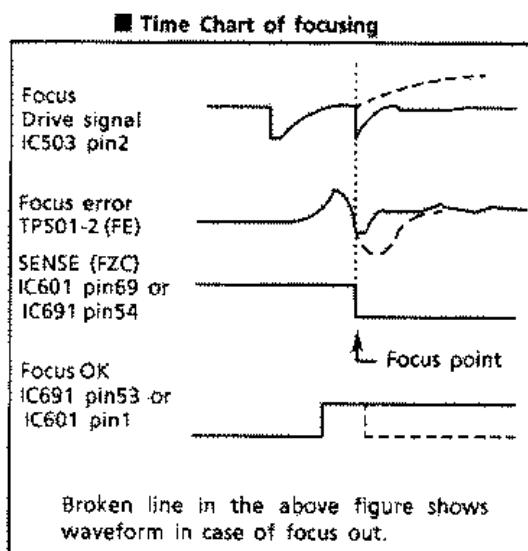


Fig.3

## Flow of Functional Operation Until TOC is Read



## Maintenance of Laser Pickup

### (1) Life of the laser diode

RF level (amplitude of eye pattern) is decreased when the life of laser diode is run out.

Check that the RF level is over 0.7Vp-p and under 1.2V.

The pickup should be exchanged with new one for run out of its life if the value is 0.7Vp-p below.

### (2) Semi-fixed resistor on the APC PC board

The semi-fixed resistor on the APC printed circuit board which is attached to the pickup is used to adjust the laser power. Since this adjustment should be performed to match the characteristics of the whole optical block, do not touch the semi-fixed resistor.

If the laser power is lower than the specified value, the laser diode is almost worn out, and the laser pickup should be replaced.

If the semi-fixed resistor is adjusted while the pickup is functioning normally, the laser pickup may be damaged due to excessive current.

## Replacement of Laser Pickup

Turn off the power switch, and disconnect the DC plug.

Replace the pickup with a normal one. (Refer to "Disassembly Procedures" on the previous page)

Plug the power supply adaptor. Set the power switch on while turning on the door close detection switch forcefully. Check that the laser diode emits for approx. 3sec. and the objective lens moves up and down.

Check FE bias.

Adjust EF balance.

Play a disc.

Adjust focus gain.

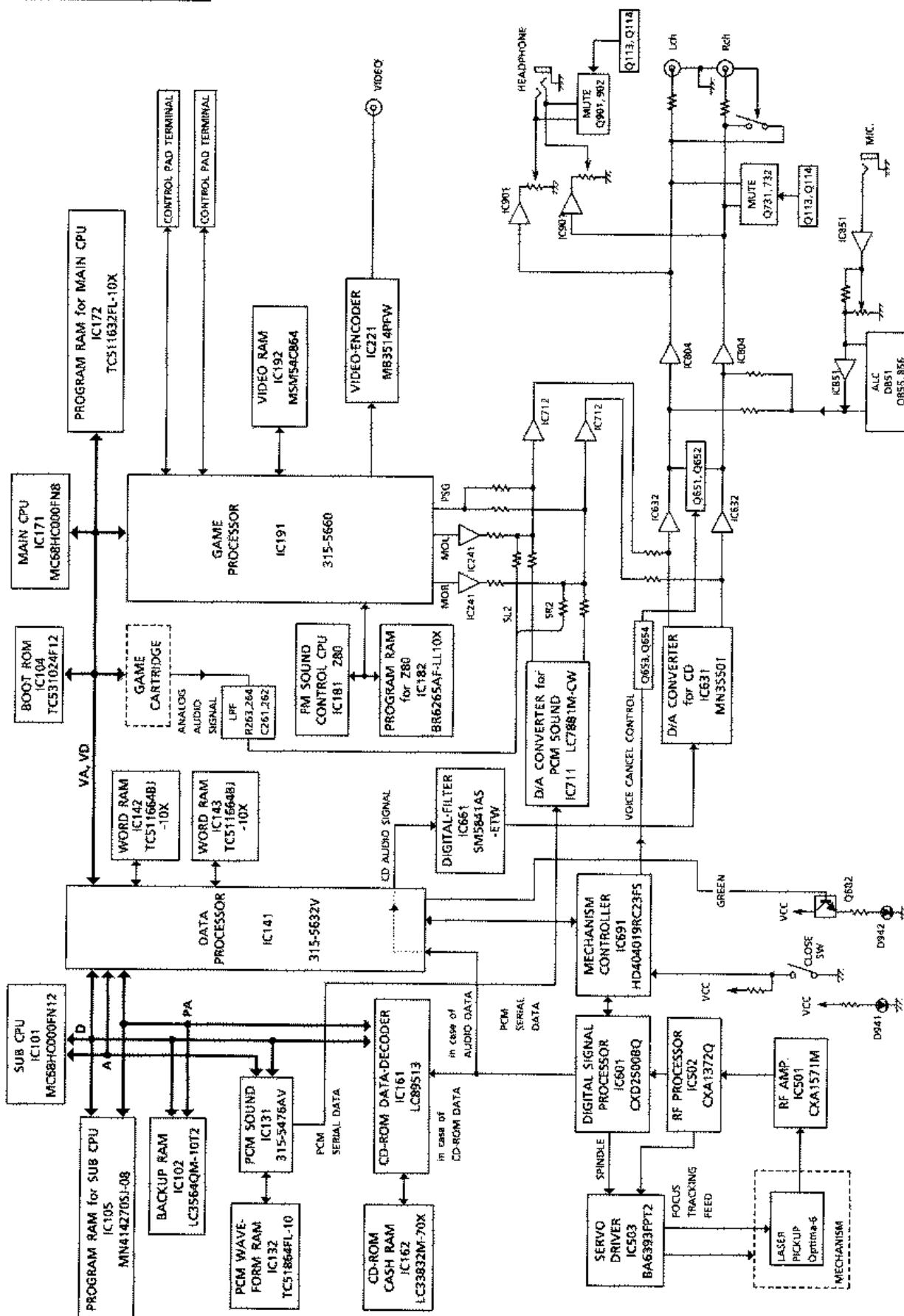
Adjust tracking gain.

Check the eye-pattern at TP501  
pin1(RF)

Finish.

Note: Since one adjustment may affect other settings, repeat these adjustments a few times.

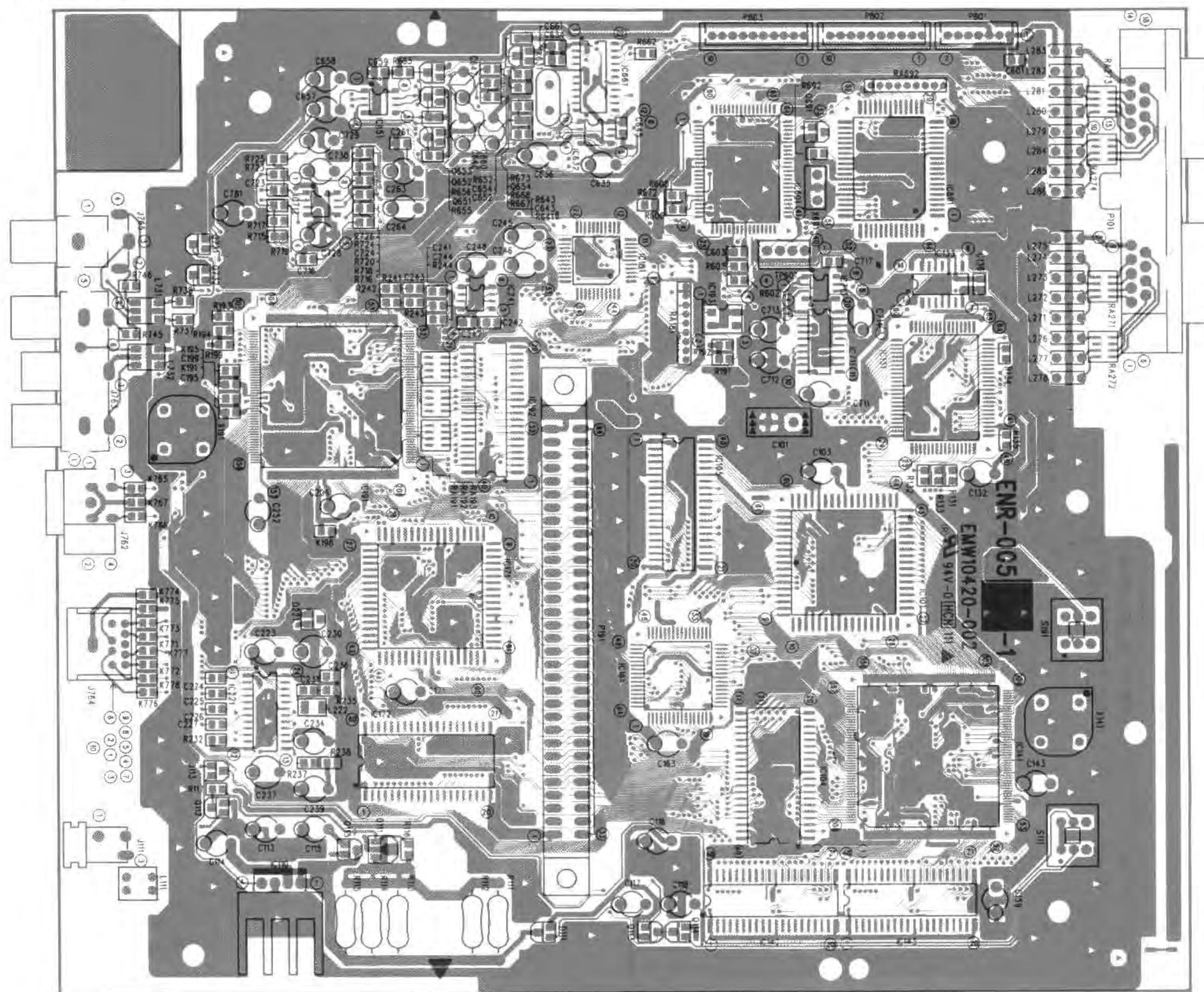
## Block Diagrams



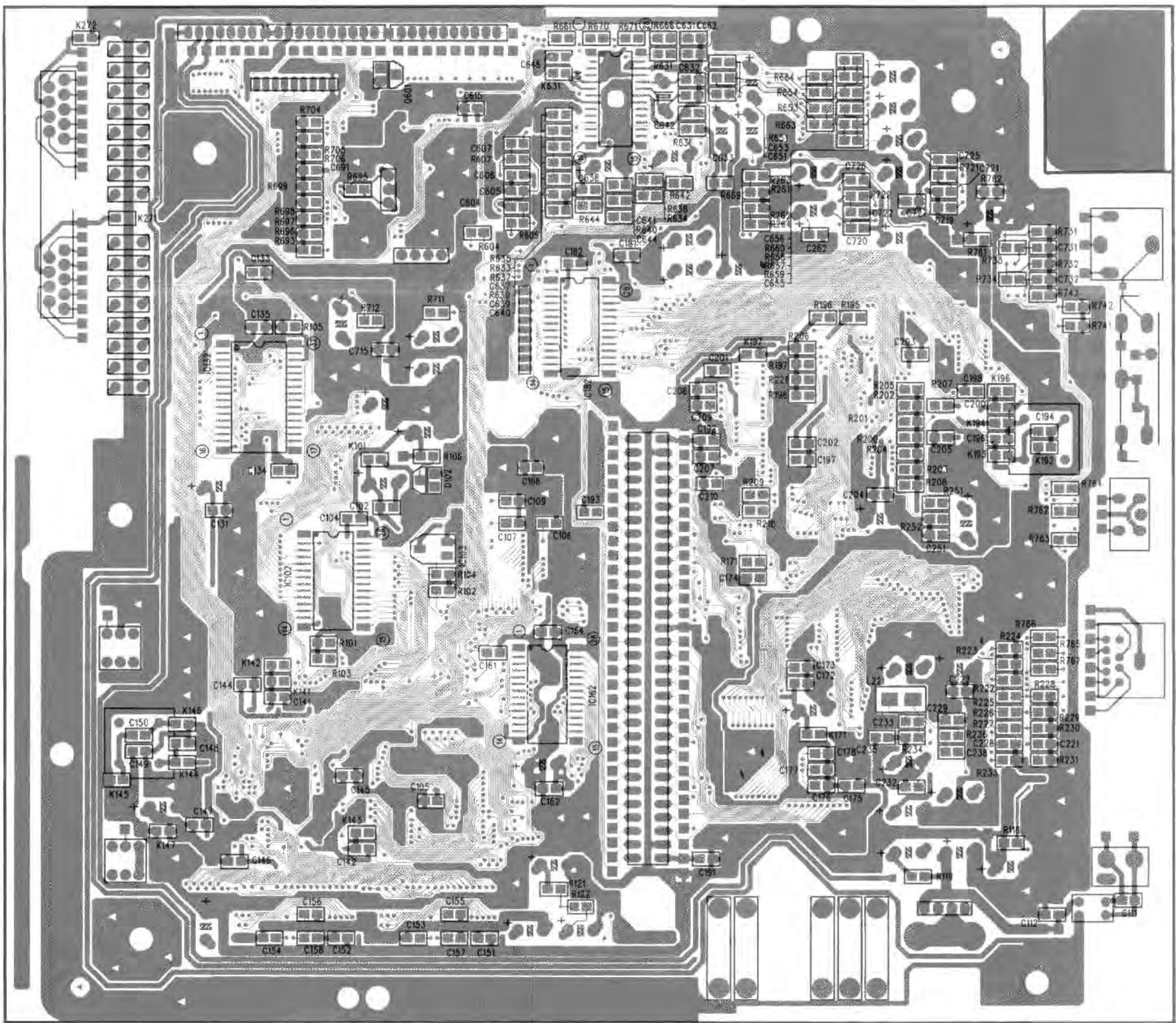
**Printed Circuit Boards**

■ Main &amp; DSP P.C.Board (ENR-005)

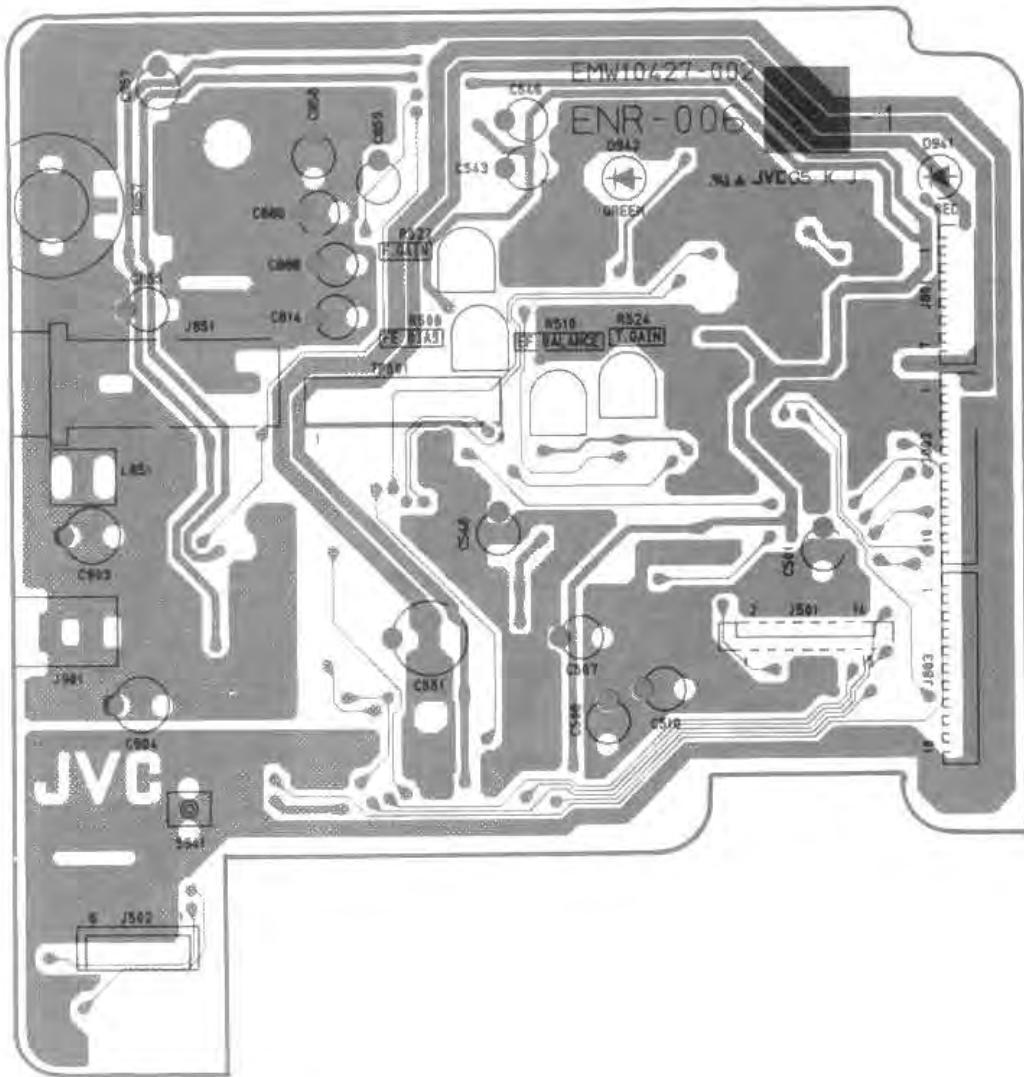
Front side



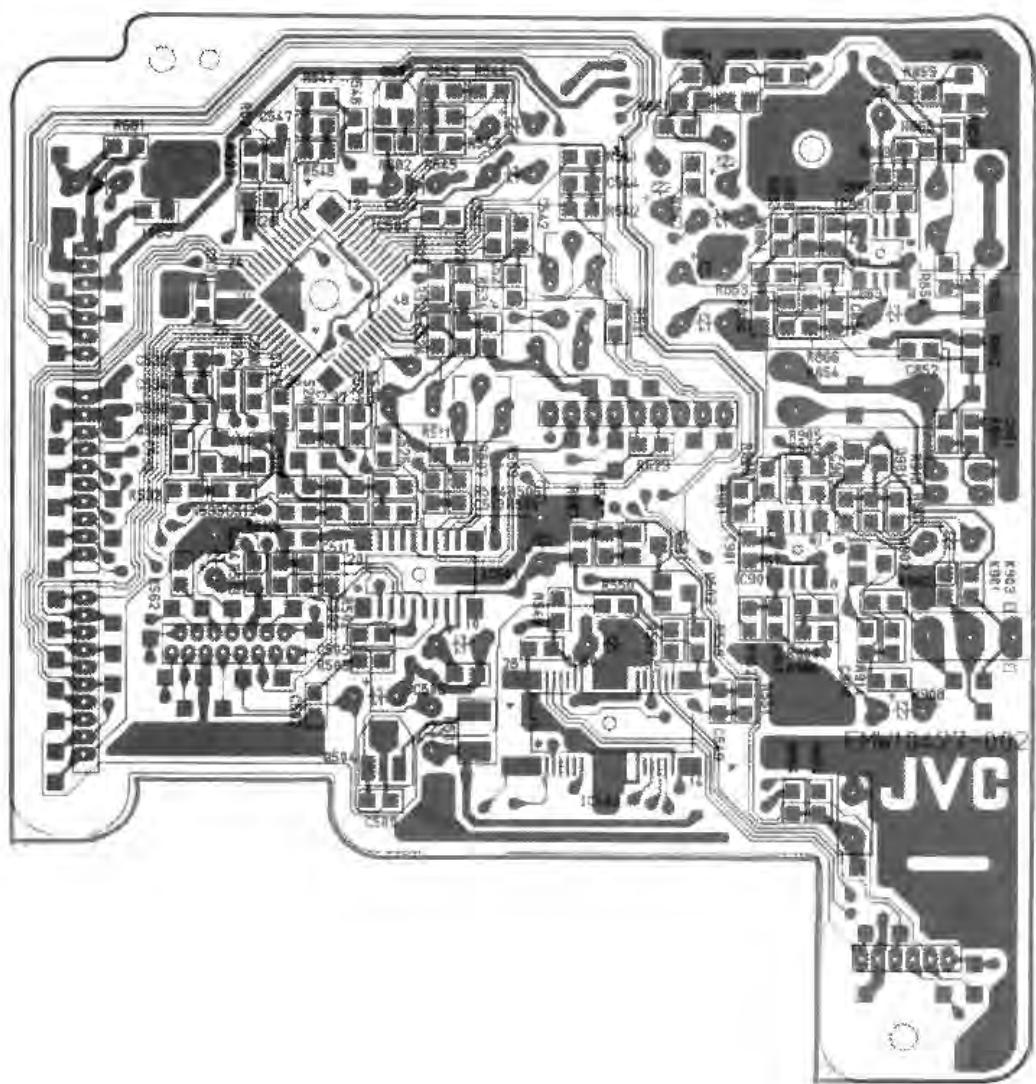
■ Main & DSP P.C.Board (ENR-005)  
Back side



■ Mic, Headphone & CD Servo P.C.Board (ENR-006)  
Front side

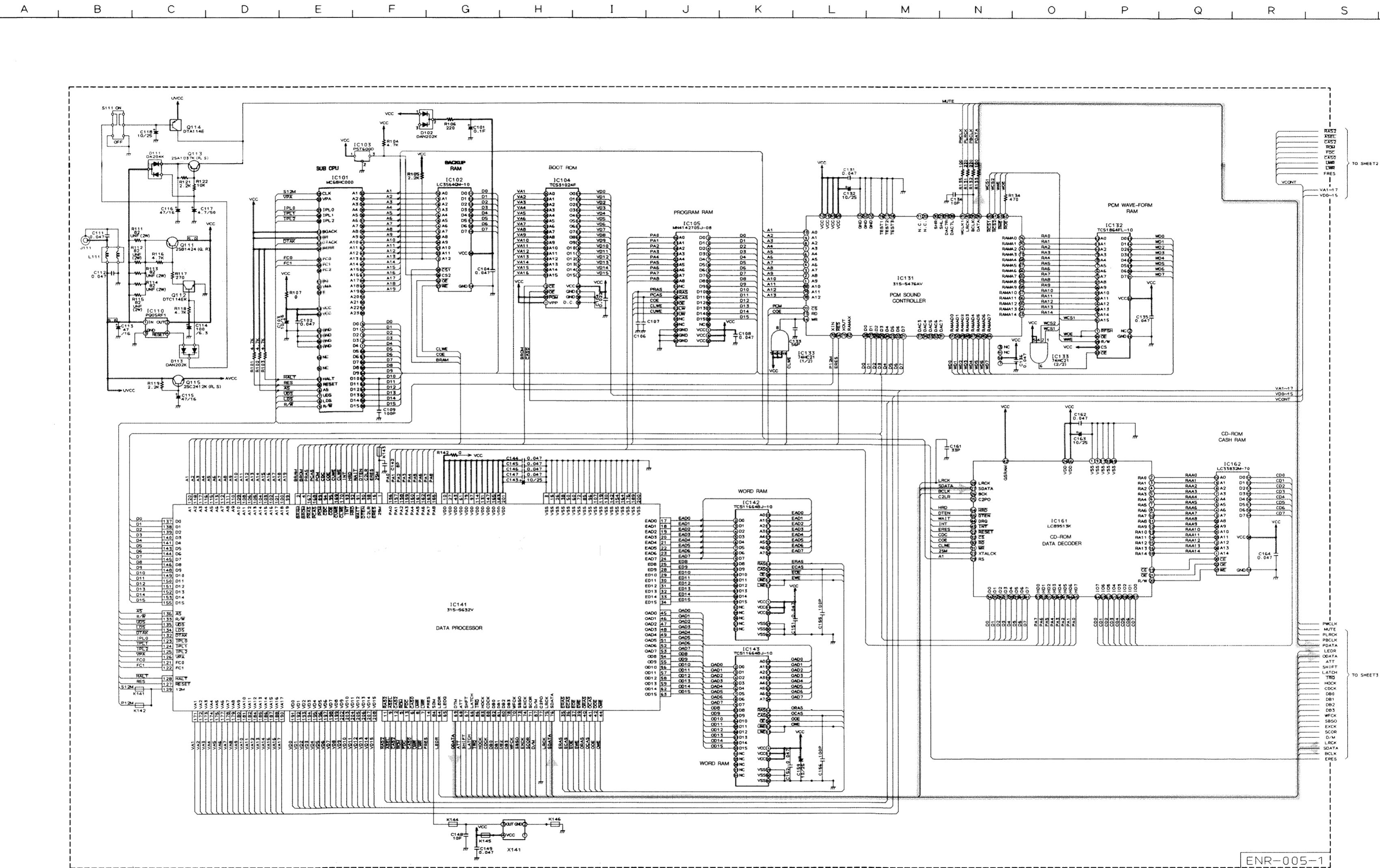


■ Mic, Headphone & CD Servo P.C.Board (ENR-006)  
Back side



## Schematic Diagrams

### (1) Sub CPU & Data Processor Section

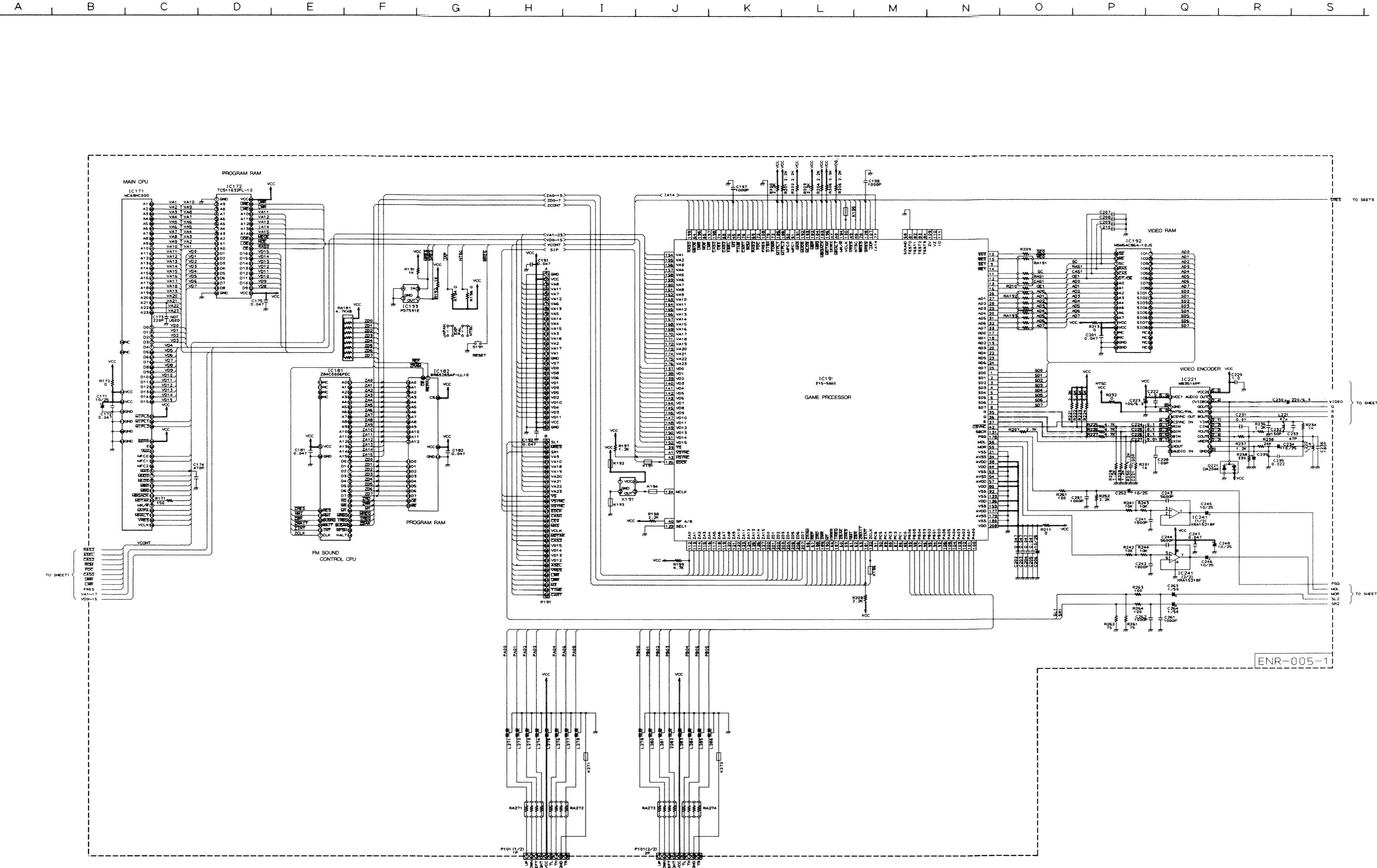


#### Notes:

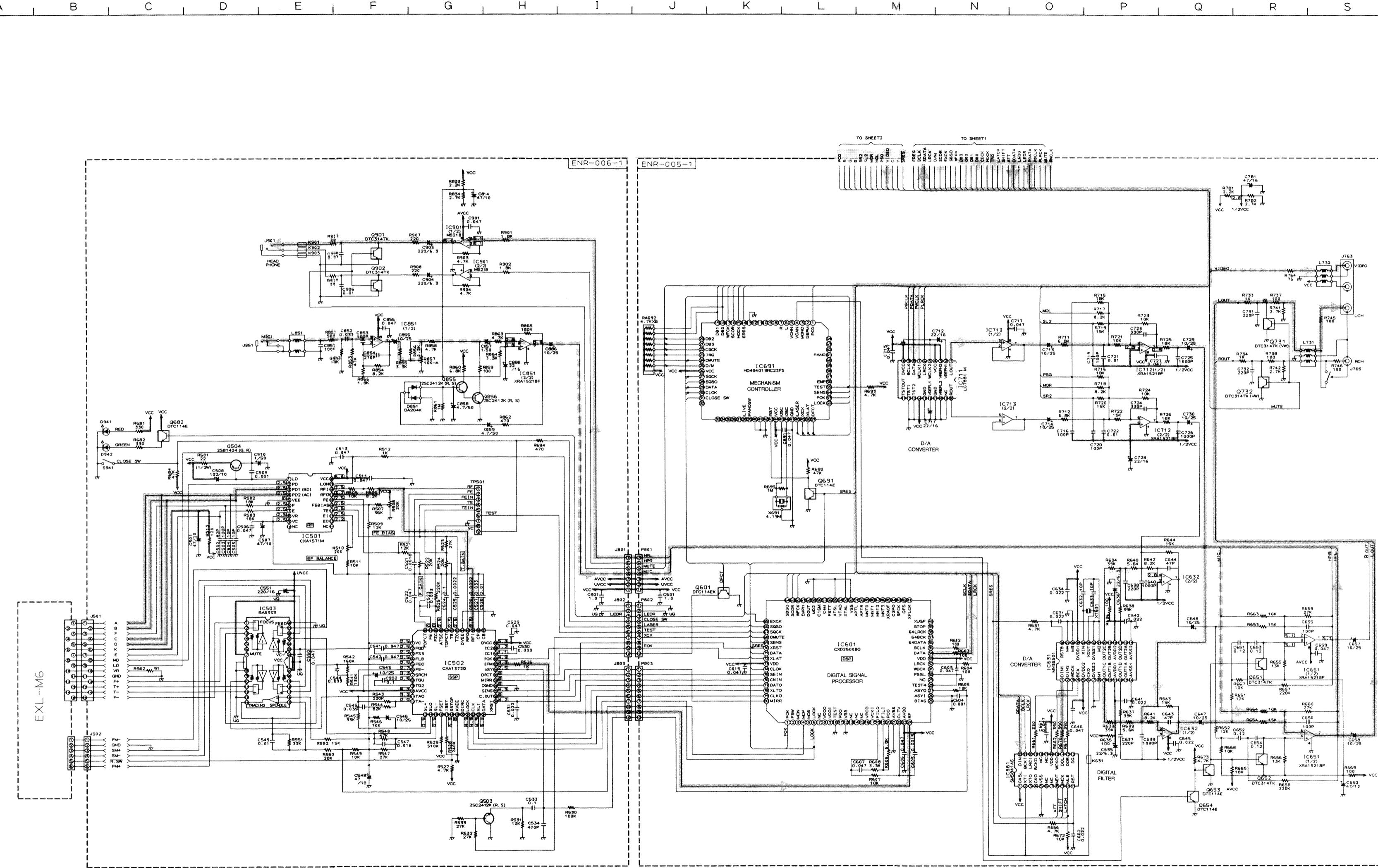
1. — indicates +B power supply.
2. ■■■ indicates CD PLAY signal path.
3. ■■■ indicates Mic signal path.
4. ■■■ indicates PCM sound signal path.
5. ■■■ indicates VIDEO signal path.
6. This is the standard circuit diagram.

The design and contents are subject to change without notice.

## (2) Main CPU &amp; Game Processor Section



## (3) CD &amp; Digital Signal Processor Section



# PARTS LIST

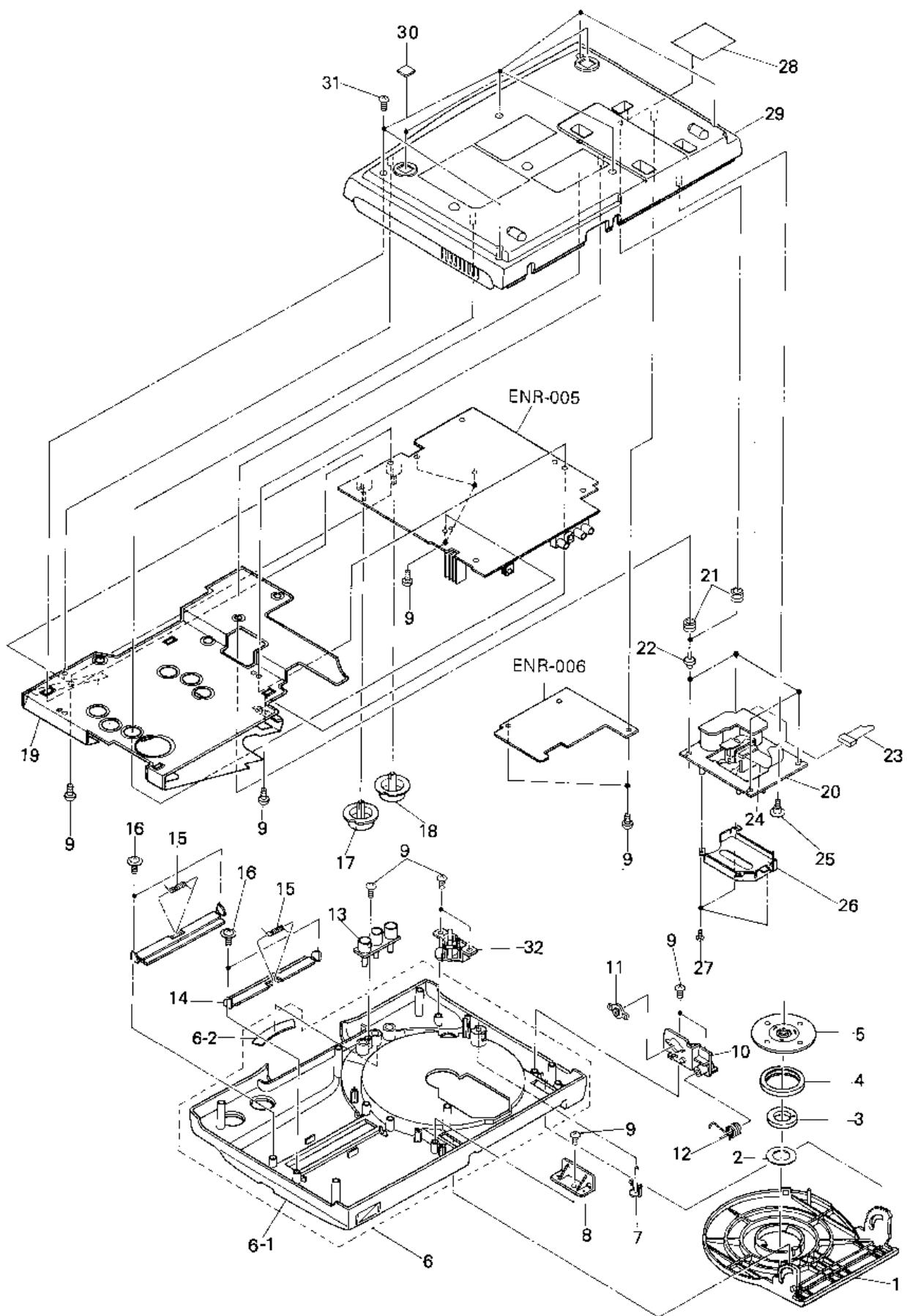
Note : All printed circuit boards and its assemblies are not available as service parts.

## Contents

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● Foil .....	2-10
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Packing Materials and Part Numbers .....	2-12

## General Exploded View and Parts List

Symbol No. M 1 M M



Symbol No. M 1 M M

## ■ Parts List

Item	Part Number	Part Name	Q'ty	Description	Area
1	E207839-001	CD DOOR	1		
2	VYH7314-001	YOKE PLATE	1		
3	VYH7313-003	MAGNET	1		
4	E407872-001	CLAMPER CUSHION	1		
5	E308761-002	CD CLAMPER	1		
6	E102708-003SA	CD CABINET ASSY	1		
6-1	E102708-003	CD CABINET	1		
6-2	E308512-003	C.D W. SCREEN	1		
7	E407590-001	PUSH BUTTON	1		
8	E308514-001	HOLDER	1	RIGHT	
9	SBSF3008Z	TAPPING SCREW	13		
10	E308515-001	HOLDER	1	LEFT	
11	E304434-005	DAMPER ASSY	1		
12	E407625-001	SPRING	1		
13	E308657-001	INDICATOR LENS	1		
14	E308509-001	SHUTTER	2		
15	E406960-001	SPRING	2		
16	E65923-003	TAPPING SCREW	4		
17	E407550-001	PUSH BUTTON	1		
18	E407550-002	PUSH BUTTON	1		
19	E208126-003	SHIELD PLATE	1		
20	-----	CD MECHANISM ASSY	1	SEE PAGE 2-4	
21	E406871-001	SPRING	2		
22	E406294-002	INSULATOR	4		
23	EWS266-B408	SOCKET WIRE ASSY	1		
24	EWR115M-19BB	FLAT WIRE ASSY	1		
25	E65923-003	TAPPING SCREW	1	BOTTOM MECHA	
26	VJD5410-004	PICK UP COVER	1		
27	SDSF2005M	TAPPING SCREW	3		
28	E406507-001	CAUTION LABEL	1		C
29	E102840-001	BOTTOM COVER	1		
30	E406855-010	SPACER	2		
31	SBSF3010M	TAPPING SCREW	6		
32	E308516-001	PUSH BUTTON ASSY	1		
-	E309118-001	RATING LABEL	1		C
-	E309005-003	RATING LABEL	1		J
-	E307570-001	NUMBER LABEL	1		J
-	E408140-001	FCC LABEL	1		J

⚠ : Safety Parts

## The Marks for Designated Areas

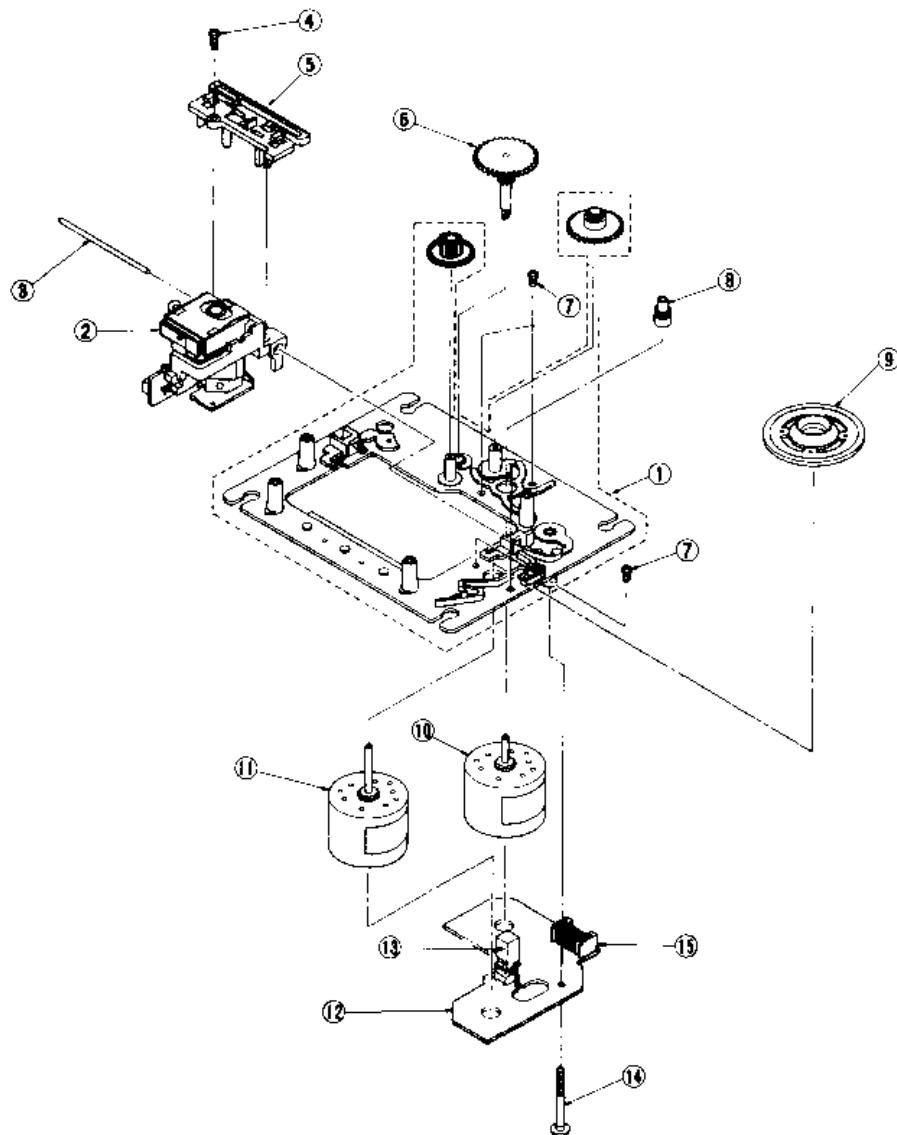
J ..... the U.S.A.

C ..... Canada

No mark indicates all area.

## CD Mechanism Ass'y and Parts List

Symbol No. M 2 M M



Symbol No. M 2 M M

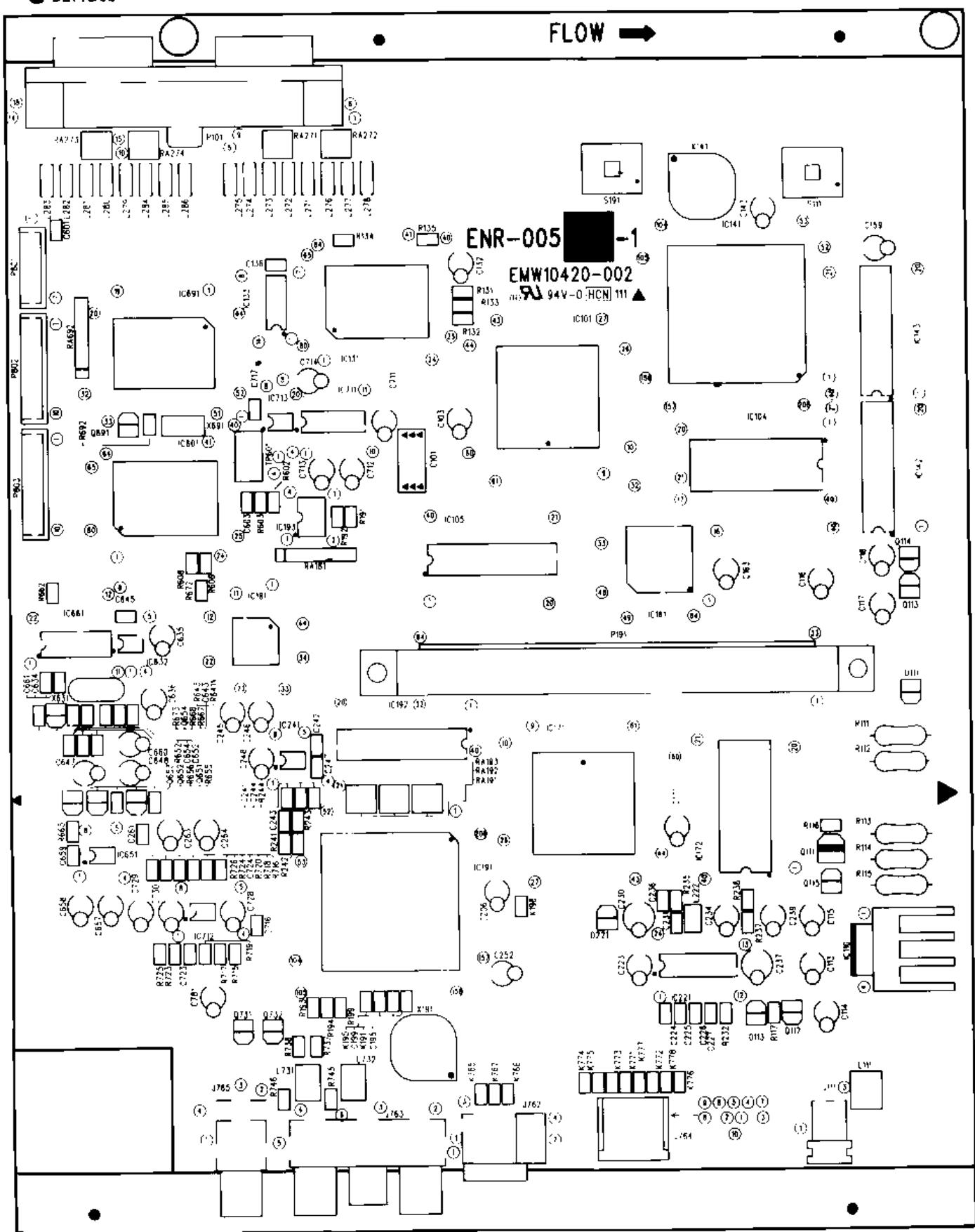
## Parts List (CD Mechanism Ass'y)

Item	Part Number	Part Name	Q'ty	Description	Area
1	EPB-002A	MECHANISM BASE ASSY	1		
2	OPTIMA-6S	PICK UP ASSY	1		
3	E406777-001	SHAFT	1		
4	SDSF2006Z	SCREW	1		
5	E307746-001	CD RACK	1		
6	EPB-003A	MECHANISM BASE ASSY	1		
7	SDSP2003N	SCREW	4		
8	E406750-001	PINION GEAR	1		
9	EPB-001C	TURN TABLE	1		
10	E406784-001	DC MOTOR	1		
11	E406783-001	DC MOTOR	1		
12	EW10190-001(S)	CIRCUIT BOARD	1		
13	ESB1100-005	LEAF SWITCH	1		
14	E75832-001	SPECIAL SCREW	1		
15	EMV5109-006B	PLUG ASSY	1	6PIN	

# Printed Circuit Board Ass'y and Parts List

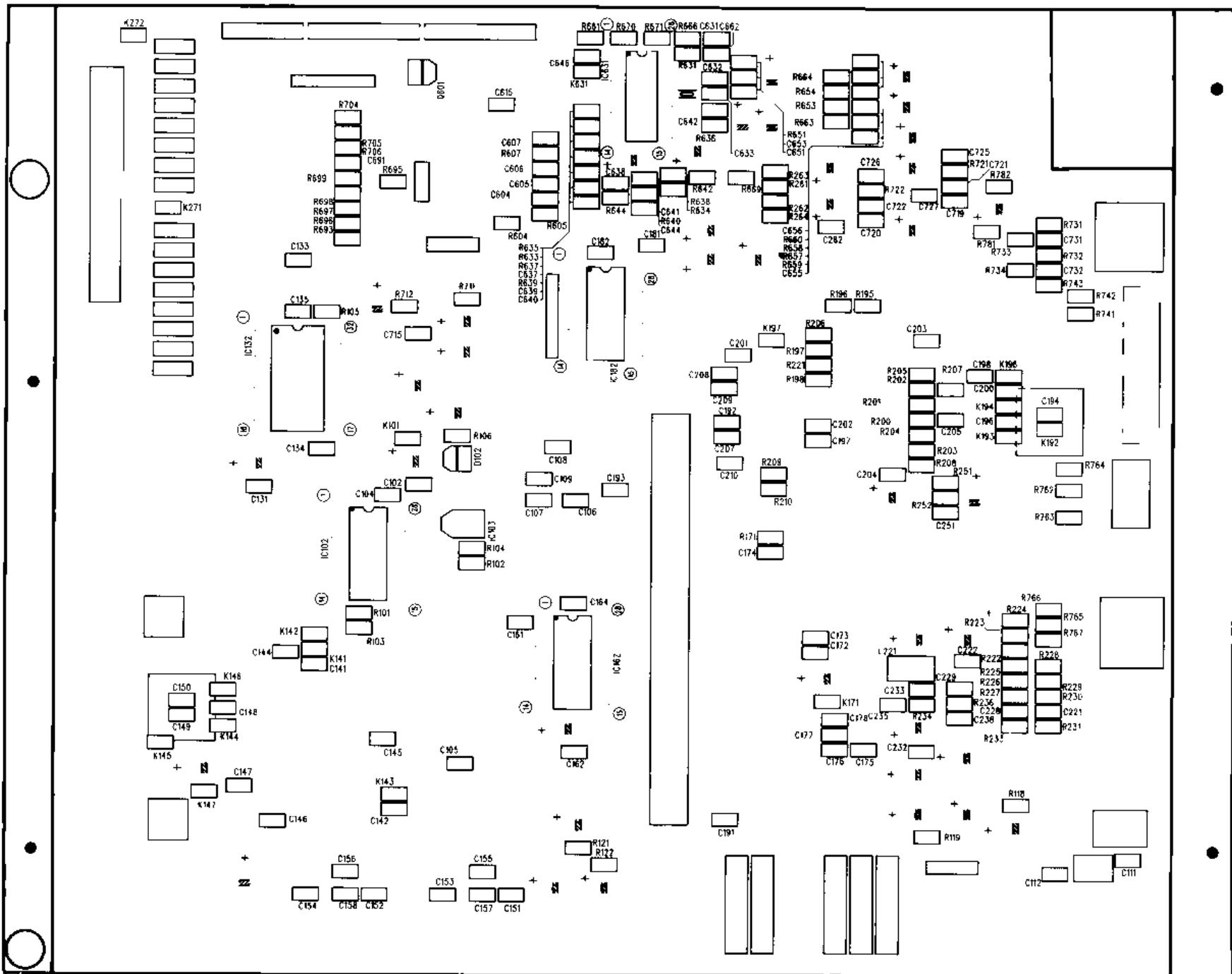
■ ENR-005 A Main & DSP P.C Board Ass'y

● Surface



● Foil

2-6 (No. 20478)





## Capacitors

Δ	ITEM	PART NUMBER	DESCRIPTION	AREA
C644		NCS21HJ-47CAY	47PF 50V CER.CAPACI	
C645		NCF21E2-473AYU	0.047MF 25V CER.CAPACI	
C646		NCF21E2-473AYU	0.047MF 25V CER.CAPACI	
C647		QETB1EM-106	10MF 25V AL E.CAPAC	
C648		QETB1EM-106	10MF 25V AL E.CAPAC	
C651		NLB21CK-124AYU	0.12MF 16V CER.CAPACI	
C652		NCB21CK-124AYU	0.12MF 16V CER.CAPACI	
C653		NCB21CK-124AYU	0.12MF 16V CER.CAPACI	
C654		NCB21CK-124AYU	0.12MF 16V CER.CAPACI	
C655		NCS21HJ-101AY	100PF 50V CER.CAPACI	
C656		NCS21HJ-101AY	100PF 50V CER.CAPACI	
C657		QETB2EM-106	10MF 25V AL E.CAPAC	
C658		QETB1EM-106	10MF 25V AL E.CAPAC	
C659		NCF21E2-473AYU	0.047MF 25V CER.CAPACI	
C660		QETB1AH-476	47MF 10V E.CAPACITO	
C661		NCF21E2-473AYU	0.047MF 25V CER.CAPACI	
C662		NCB21HK-223AY	0.022MF 50V CER.CAPACI	
C663		QETB0JM-1072M	100MF 6.3V AL E.CAPAC	
C691		NCF21EZ-473AYU	0.047MF 25V CER.CAPACI	
C711		QETB1CM-226	22MF 16V E.CAPACITO	
C712		QETB1CM-226	22MF 16V E.CAPACITO	
C713		QETB1EM-106	10MF 25V AL E.CAPAC	
C714		QETB1EM-106	10MF 25V AL E.CAPAC	
C715		NCF21EZ-473AYU	0.047MF 25V CER.CAPACI	
C716		NCS21HJ-101AYU	100PF 50V CER.CAPACI	
C717		NCF21EZ-473AYU	0.047MF 25V CER.CAPACI	
C719		NCS21HJ-101AY	100PF 50V CER.CAPACI	
C720		NCS21HJ-101AY	100PF 50V CER.CAPACI	
C721		NCB21HK-103AY	0.01MF 50V CER.CAPACI	
C722		NCB21HK-103AY	0.01MF 50V CER.CAPACI	
C723		NCS21HJ-331AY	330PF 50V CER.CAPACI	
C724		NCS21HJ-331AY	330PF 50V CER.CAPACI	
C725		NCS21HJ-102AY	1000PF 50V CER.CAPACI	
C726		NCS21HJ-102AY	1000PF 50V CER.CAPACI	
C727		NCF21EZ-473AYU	0.047MF 25V CER.CAPACI	
C728		QETB1CM-226	22MF 16V E.CAPACITO	
C729		QETB1EM-106	10MF 25V AL E.CAPAC	
C730		QETB1EM-106	10MF 25V AL E.CAPAC	
C731		NCS21HJ-221AY	220PF 50V CER.CAPACI	
C732		NCS21HJ-221AY	220PF 50V CER.CAPACI	
C781		QETB1CM-476	47MF 16V AL E.CAPAC	

Δ IS A SAFETY PARTS

## Resistors

Δ	ITEM	PART NUMBER	DESCRIPTION	AREA
R213		NRSA02J-0R0AY	METAL GLAZ	
R221		NRSA02J-222NY	METAL GLAZ	
R222		NRSA02J-562NY	METAL GLAZ	
R223		NRSA02J-562NY	METAL GLAZ	
R224		NRSA02J-562NY	METAL GLAZ	
R225		NRSA02J-572NY	METAL GLAZ	
R226		NRSA02J-472NY	METAL GLAZ	
R227		NRSA02J-472NY	METAL GLAZ	
R228		NRSA02J-122NY	METAL GLAZ	
R229		NRSA02J-122NY	METAL GLAZ	
R230		NRSA02J-122NY	METAL GLAZ	
R231		NRSA02J-102NY	METAL GLAZ	
R232		NRSA02J-0R0AY	METAL GLAZ	
R234		NRSA02J-102NY	METAL GLAZ	
R235		NRSA02J-531NY	METAL GLAZ	
R236		NRSA02J-122NY	METAL GLAZ	
R237		NRSA02J-122NY	METAL GLAZ	
R238		NRSA02J-243NY	METAL GLAZ	
R241		NRSA02J-103NY	METAL GLAZ	
R242		NRSA02J-103NY	METAL GLAZ	
R243		NRSA02J-103NY	METAL GLAZ	
R244		NRSA02J-103NY	METAL GLAZ	
R251		NRSA02J-101NY	METAL GLAZ	
R252		NRSA02J-222NY	METAL GLAZ	
R261		NRSA02J-750NY	METAL GLAZ	
R262		NRSA02J-750NY	METAL GLAZ	
R263		NRSA02J-101NY	METAL GLAZ	
R264		NRSA02J-101NY	METAL GLAZ	
R602		NRSA02J-101NY	METAL GLAZ	
R603		NRSA02J-101NY	METAL GLAZ	
R604		NRSA02J-101NY	METAL GLAZ	
R605		NRSA02J-103NY	METAL GLAZ	
R606		NRSA02J-692NY	METAL GLAZ	
R607		NRSA02J-103NY	METAL GLAZ	
R608		NRSA02J-333NY	METAL GLAZ	
R631		NRSA02J-0R0AY	METAL GLAZ	
R633		NRSA02J-393NY	METAL GLAZ	
R634		NRSA02J-393NY	METAL GLAZ	
R635		NRSA02J-101NY	METAL GLAZ	
R636		NRSA02J-101NY	METAL GLAZ	
R637		NRSA02J-393NY	METAL GLAZ	
R638		NRSA02J-393NY	METAL GLAZ	
R639		NRSA02J-562NY	METAL GLAZ	
R640		NRSA02J-562NY	METAL GLAZ	
R641		NRSA02J-822NY	METAL GLAZ	
R642		NRSA02J-822NY	METAL GLAZ	
R643		NRSA02J-153NY	METAL GLAZ	
R644		NRSA02J-153NY	METAL GLAZ	
R651		NRSA02J-123NY	METAL GLAZ	
R652		NRSA02J-123NY	METAL GLAZ	
R653		NRSA02J-153NY	METAL GLAZ	
R654		NRSA02J-273NY	METAL GLAZ	
R655		NRSA02J-153NY	METAL GLAZ	
R656		NRSA02J-133NY	METAL GLAZ	
R657		NRSA02J-224NY	METAL GLAZ	
R658		NRSA02J-224NY	METAL GLAZ	
R659		NRSA02J-273NY	METAL GLAZ	
R660		NRSA02J-273NY	METAL GLAZ	
R661		NRSA02J-331NY	METAL GLAZ	
R662		NRSA02J-391NY	METAL GLAZ	
R662		NRSA02J-682NY	METAL GLAZ	
R663		NRSA02J-103NY	METAL GLAZ	
R664		NRSA02J-103NY	METAL GLAZ	
R665		NRSA02J-183NY	METAL GLAZ	
R666		NRSA02J-0R0AY	METAL GLAZ	
R667		NRSA02J-103NY	METAL GLAZ	
R668		NRSA02J-103NY	METAL GLAZ	
R669		NRSA02J-101NY	METAL GLAZ	
R669	1K	QRD167J-102	1/6W CARBON RES	
R670		NRSA02J-391NY	METAL GLAZ	
R671		NRSA02J-391NY	METAL GLAZ	
R672		NRSA02J-103NY	METAL GLAZ	
R673		NRSA02J-472NY	METAL GLAZ	
R692		NRSA02J-473NY	METAL GLAZ	
R693		NRSA02J-472NY	METAL GLAZ	
R695		NRSA02J-105NY	METAL GLAZ	
R696		NRSA02J-472NY	METAL GLAZ	
R697		NRSA02J-472NY	METAL GLAZ	
R698		NRSA02J-472NY	METAL GLAZ	
R699		NRSA02J-472NY	METAL GLAZ	
R704		NRSA02J-472NY	METAL GLAZ	
R705		NRSA02J-472NY	METAL GLAZ	
R706		NRSA02J-472NY	METAL GLAZ	
R711		NRSA02J-682NY	METAL GLAZ	
R712		NRSA02J-682NY	METAL GLAZ	
R715		NRSA02J-183NY	METAL GLAZ	
R716		NRSA02J-183NY	METAL GLAZ	
R717		NRSA02J-822NY	METAL GLAZ	
R718		NRSA02J-822NY	METAL GLAZ	
R719		NRSA02J-153NY	METAL GLAZ	
R720		NRSA02J-153NY	METAL GLAZ	
R721		NRSA02J-103NY	METAL GLAZ	
R722		NRSA02J-103NY	METAL GLAZ	

Δ IS A SAFETY PARTS

**Resistors**

REF	PART NUMBER	DESCRIPTION	AREA
R723	NRSA02J-103NY	METAL GLAZ	
R724	NRSA02J-103NY	METAL GLAZ	
R725	NRSA02J-183NY	METAL GLAZ	
R726	NRSA02J-183NY	METAL GLAZ	
R731	NRSA02J-103NY	METAL GLAZ	
R732	NRSA02J-103NY	METAL GLAZ	
R733	NRSA02J-103NY	METAL GLAZ	
R734	NRSA02J-102NY	METAL GLAZ	
R737	NRSA02J-101NY	METAL GLAZ	
R738	NRSA02J-101NY	METAL GLAZ	
R741	NRSA02J-272NY	METAL GLAZ	
R742	NRSA02J-272NY	METAL GLAZ	
R745	NRSA02J-101NY	METAL GLAZ	
R746	NRSA02J-101NY	METAL GLAZ	
R747	QRD161J-474Y	100 1/8W CARBON RES	
R754	NRSA02J-750NY	METAL GLAZ	
R781	NRSA02J-222NY	METAL GLAZ	
R782	NRSA02J-272NY	METAL GLAZ	
RA181	GRB089J-472	4.7K 1/10W NETWORK RE	
RA191	NRB042J-471NZ	RESISTOR A	
RA192	NRB042J-471NZ	RESISTOR A	
RA193	NRB042J-471NZ	RESISTOR A	
RA271	NRB042J-101NZ	RESISTOR A	
RA272	NRB042J-101NZ	RESISTOR A	
RA273	NRB042J-101NZ	RESISTOR A	
RA274	NRB042J-101NZ	RESISTOR A	
RA692	GRB089J-472	4.7K 1/10W NETWORK RE	

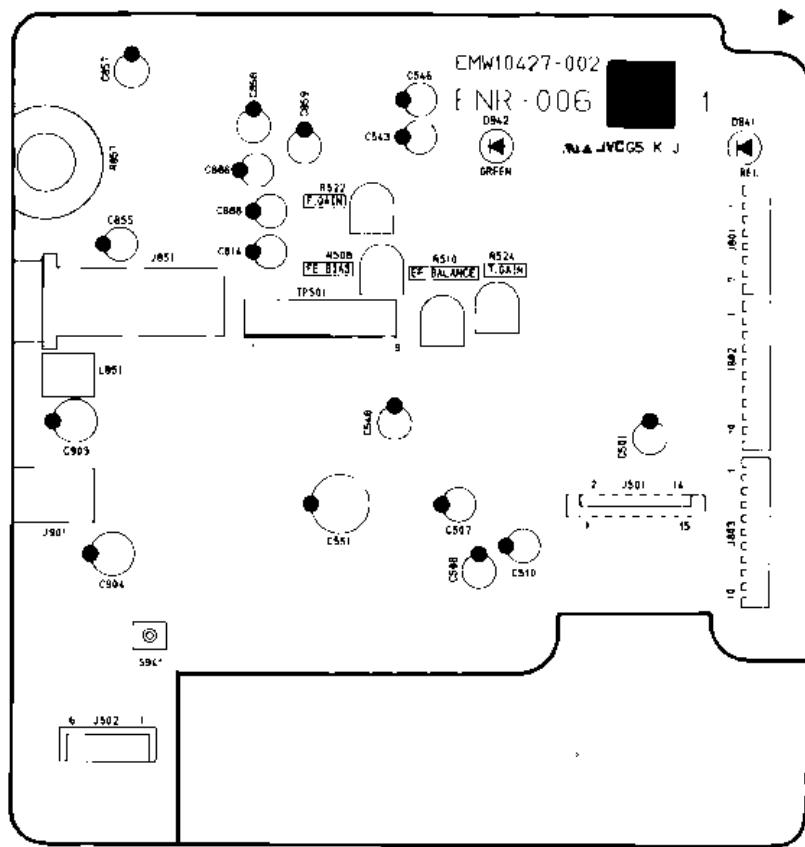
▲: ISAPENNY PARTS

**Others**

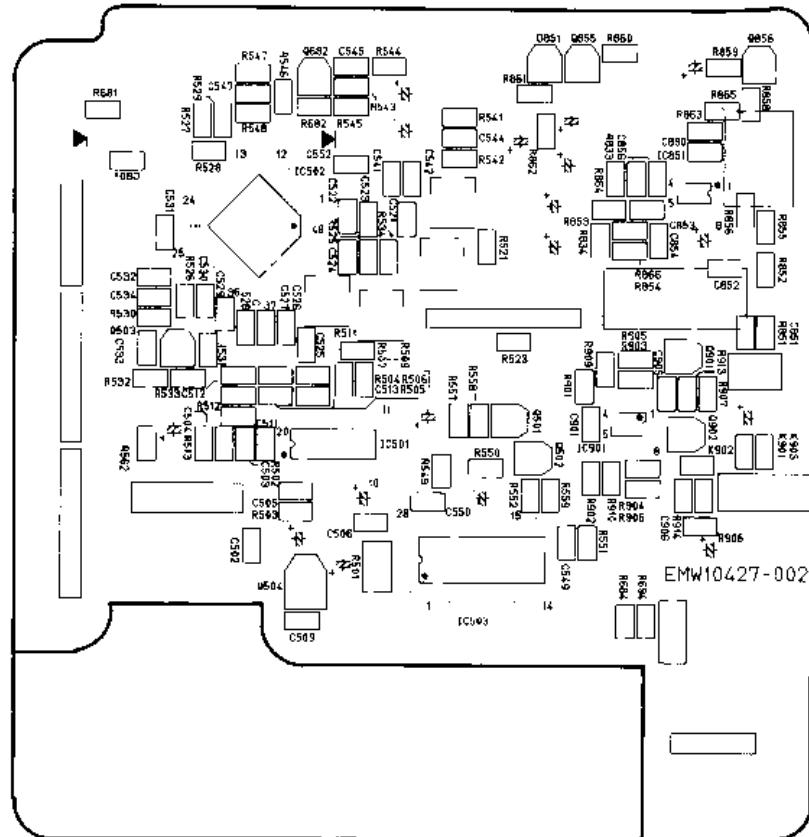
REF	PART NUMBER	DESCRIPTION	AREA
	E70945-H35B	HEAT SINK	
	SBS53008Z	WOOD SCREW	
	SBS53008M	TAPPING SCR	
	C3400-431	FELT SPACER	
	EW270-08DB	WIRE	
J111	GMA3001-E02S	DC JACK	
J763	EMN10YY-301A	PIN JACK VIDEO/AUDIO Lch/VCC	
J765	EMN01TV-101A	PIN JACK AUDIO Rch	
K1D1	ENZ8102-K6C1AY	FERRITE BEA	
K141	ENZ8102-K601AY	FERRITE BEA	
K142	ENZ8102-N601AY	FERRITE BEA	
K143	ENZ8102-N801AY	FERRITE BEA	
K144	ENZ8102-N6D1AY	FERRITE BEA	
K145	ENZ8102-N601AY	FERRITE BEA	
K146	ENZ8102-N601AY	FERRITE BEA	
K147	ENZ8102-N601AY	FERRITE BEA	
K171	ENZ8102-N601AY	FERRITE BEA	
K191	ENZ8102-N601AY	FERRITE BEA	
K192	ENZ8102-N601AY	FERRITE BEA	
K193	ENZ8102-N601AY	FERRITE BEA	
K194	ENZ8102-N601AY	FERRITE BEA	
K195	ENZ8102-N601AY	FERRITE BEA	
K196	ENZ8102-N601AY	FERRITE BEA	
K197	ENZ8102-N601AY	FERRITE BEA	
K2/1	LNZ8102-N601AY	FERRITE BEA	
K272	ENZ8102-N601AY	FERRITE BEA	
K631	ENZ8102-N121AY	FERRITE BEA	
K768	ENZ8102-N121AY	FERRITE BEA	
X769	ENZ8102-N121AY	FERRITE BEA	
X770	ENZ8102-N601AY	FERRITE BEA	
K779	ENZ8102-N601AY	FERRITE BEA	
L111	EGL1003-400	INDUCTOR	
L221	EQL5002-470T	INDUCTOR	
L222	EQL5002-120T	INDUCTOR	
L271	EQF0601-222	CERAMIC FIL	
L272	EQF0601-222	CERAMIC FIL	
L273	EQF0601-222	CERAMIC FIL	
L274	EQF0601-222	CERAMIC FIL	
L275	EQF0601-222	CERAMIC FIL	
L276	EQF0601-222	CERAMIC FIL	
L277	EQF0601-222	CERAMIC FIL	
L278	EQF0601-222	CERAMIC FIL	
L279	EGF0601-222	CERAMIC FIL	
L280	EQF0601-222	CERAMIC FIL	
L281	EQF0601-222	CERAMIC FIL	
L282	EQF0601-222	CERAMIC FIL	
L283	EQF0601-222	CERAMIC FIL	
L284	EQF0601-222	CERAMIC FIL	
L285	EQF0601-222	CERAMIC FIL	
L286	EQF0601-222	CERAMIC FIL	
L731	EQF0808-N01ZS	INDUCTOR	
L732	EQF0808-N01ZS	INDUCTOR	
P101	EMZ1008-006	CONNECT TER9PIN	
P191	EMZ1C07-002	CONNECT TER6PIN	
P801	VMC0194-S07	CONNECT TER7PIN	
P502	VMC0194-S10	CONNECT TER10PIN	
P803	VMC0194-S10	CONNECT TER10PIN	
S111	QSP2006-E02	PUSH SWITCH POWER SW	
S191	QSP2005-E01	PUSH SWITCH RESET SW	
X141	CXO-826(50MHZ)	CRYSTAL	
X191	1338M-53693	CRYSTAL	
X631	ECX0169-344EF	CRYSTAL	
X691	ECX0004-194KM	CERAMIC RES	

▲: ISAPENNY PARTS

■ ENR-006[A] Mic Headphone & CD Servo P.C Board Ass'y  
 ● Surface



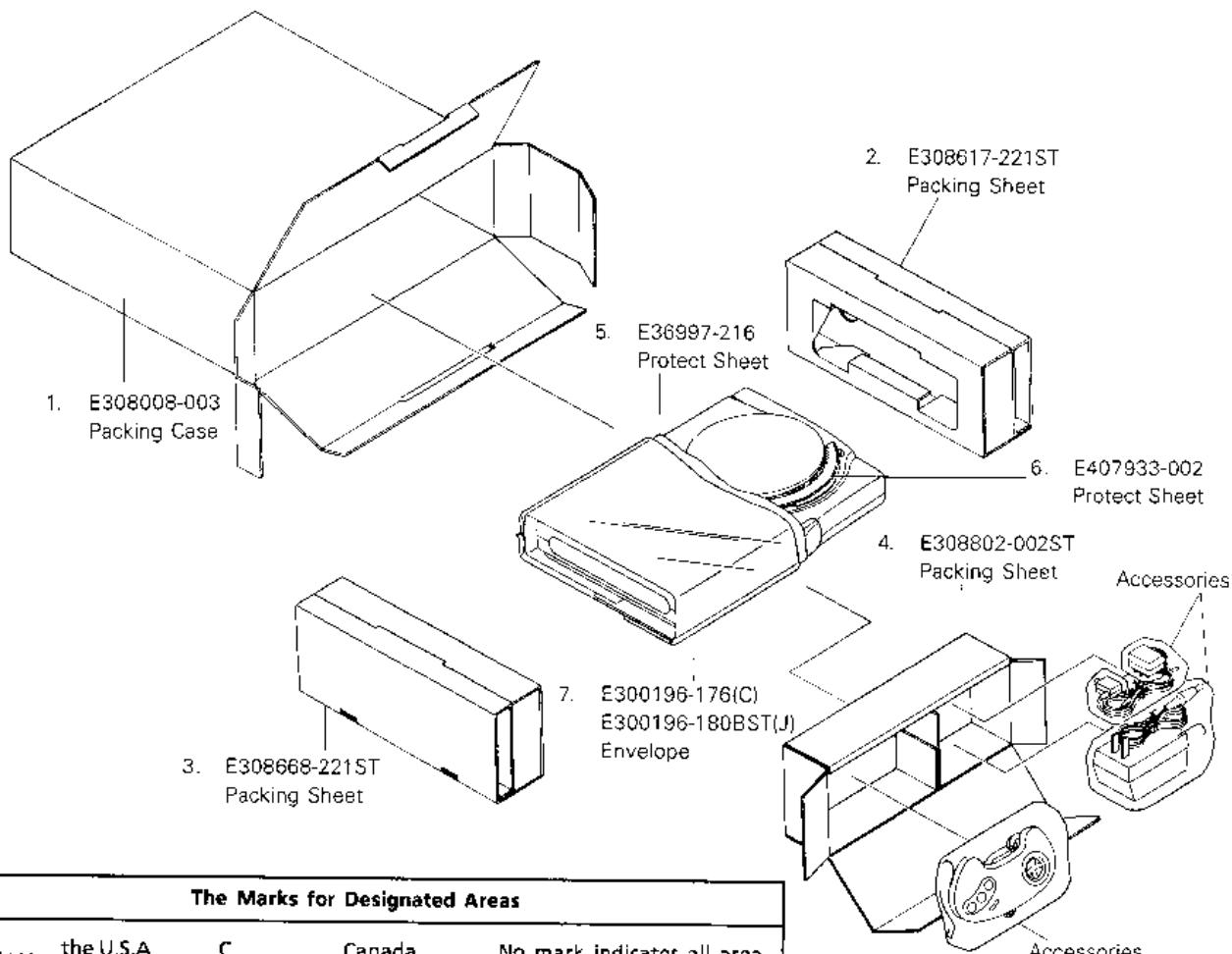
● Foil





# Packing Materials and Part Numbers

Symbol No. M 3 M M



## Accessories List

Symbol No. M 4 M M

Item	Part Number	Part Name	Q'ty	Description	Area
1	E30580-2159A	INSTRUCTION BOOK	1		C
	E30580-2119A	INSTRUCTION BOOK	1		J
2	E300196-010	POLY BAG	1		C
	E300196-010B	ENVELOPE	1		J
3	EGGCIE SEGA V200	C.ENCYCLOPEDIA	1		
4	EGG19945	CIE COUPON	1		
5	EGGMK 4206	PRIZE FIGHTER	1		
6	EGGACDGGP1	TOP HIT SAMPLER	1		
7	EGGSBD0001	SONG BOOK	1		
8	EGG1014206	P.FIGHTER INST	1		
9	EGGCIE SEGA MNL 1	CIE SEGA MANUAL	1		
10	BT-51006-1	REGISTER CARD	1		J
11	E43486-603A	RG-M10 C.SHEET	1		J
12	BT-20071B	SERVICE NETWORK	1		C
13	BT-20025L	WARRANTY CARD	1		C
14	E43486-604A	RG-M10 C.SHEET	1		C
15	6105606	JOY PAD	1		
16	AA-S95J	ACADAPTOR	1		
17	RF-S10J	RF UNIT	1		

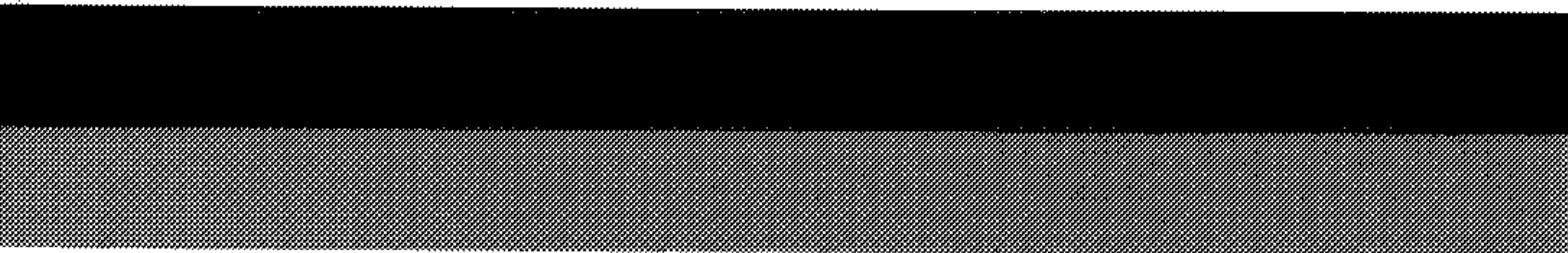
△ : Safety Parts

The Marks for Designated Areas

J .....

the U.S.A. C ... Canada

No mark indicates all area.



**JVC**

VICTOR COMPANY OF JAPAN, LIMITED

AUDIO DIVISION, YAMATO PLANT, 1644, SHIMOTSURUMA, YAMATO-SHI, KANAGAWA-KEN, 242, JAPAN